SUNSTAR 商斯达实业集团是集研发、生产、工程、销售、代理经销 、技术咨询、信息服务等为一体的高科技企业,是专业高科技电子产品生产厂家,是具有10 多年历史的专业电子元器件供应商,是中国最早和最大的仓储式连锁规模经营大型综合电子零部件代理分销商之一,是一家专业代理和分銷世界各大品牌IC 芯片和電子元器件的连锁经营綜合性国际公司,专业经营进口、国产名厂名牌电子元件,型号、种类齐全。在香港、北京、深圳、上海、西安、成都等全国主要电子市场设有直属分公司和产品展示展销窗口门市部专卖店及代理分销商,已在全国范围内建成强大统一的供货和代理分销网络。 我们专业代理经销、开发生产电子元器件、集成电路、传感器、微波光电元器件、工控机/DOC/DOM 电子盘、专用电路、单片机开发、MCU/DSP/ARM/FPGA 软件硬件、二极管、三极管、模块等,是您可靠的一站式现货配套供应商、方案提供商、部件功能模块开发配套商。商斯达实业公司拥有庞大的资料库,有数位毕业于著名高校——有中国电子工业摇篮之称的西安电子科技大学(西军电)并长期从事国防尖端科技研究的高级工程师为您精挑细选、量身订做各种高科技电子元器件,并解决各种技术问题。

微波光电部专业研制、代理经销高频、微波、光纤、光电元器件、组件、部件、模块、整机;电磁兼容元器件、材料、设备;微波CAD、EDA 软件、开发测试仿真工具;微波、光纤仪器仪表。欢迎国外高科技微波、光纤厂商将优秀产品介绍到中国、共同开拓市场。长期大量现货专业批发高频、微波、卫星、光纤、电视、CATV器件:晶振、VCO、连接器、PIN开关、变容二极管、开关二极管、低噪晶体管、功率电阻及电容、放大器、功率管、MMIC、混频器、耦合器、功分器、振荡器、合成器、衰减器、滤波器、隔离器、环行器、移相器、调制解调器;光电子元器件和组件:红外发射管、红外接收管、光电开关、光敏管、发光二极管和发光二极管组件、半导体激光二极管和激光器组件、光电探测器和光接收组件、光发射接收模块、光纤激光器和光放大器、光调制器、光开关、DWDM用光发射和接收器件、用户接入系统光光收发器件与模块、光纤连接器、光纤跳线/尾纤、光衰减器、光纤适配器、光隔离器、光耦合器、光环行器、光复用器/转换器;无线收发芯片和模组、蓝牙芯片和模组。

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地址:深圳市福田区福华路福庆街鸿图大厦1602 室

电话: 0755-82884100 83397033 83396822 83398585

传真: 0755-83376182 (0) 13823648918 MSN: SUNS8888@hotmail.com

邮编: 518033 E-mail:szss20@163.com QQ: 195847376

深圳赛格展销部: 深圳华强北路赛格电子市场2583 号 电话: 0755-83665529

技术支持: 0755-83394033 13501568376



SEMICONDUCTOR GENERAL CATALOG

Transistors

Bipolar Small-Signal Transistors

Junction FETs

Combination Products of Different Type Devices

MOSFETs

Bipolar Power Transistors

Radio-Frequency Bipolar Small-Signal Transistors

Radio-Frequency Small-Signal FETs

Radio-Frequency Power MOSFETs

Radio-Frequency Bipolar Power Transistors

IGBTs

Phototransistors (for Optical Sensors)

Bipolar Small-Signal Transistors

General-Purpose Transistors (Leaded Type)

	` ` ` ` ` ` ` ` ` ` ` ` ` ` ` ` ` ` `	icu Type)			D-	akaga
					TO-9.	ckage 2 (SC-43)
Classification	Vceo (V) Max	Ic (A) Max	hfE	VCE(sat) (V) Max	XON CA. HON CA.	S1 MAX
					2	(mm) ≰∐UU
					NPN	PNP
	50	0.15	70 to 700	0.25	2SC1815	
General-purpose	-50	-0.15	70 to 400	-0.3		2SA1015
General-purpose	120	0.1	200 to 700	0.3	2SC2240	
	-120	-0.1	200 to 700	-0.3		2SA970
	50	0.15	70 to 700	0.25	2SC1815(L)	
	-50	-0.15	70 to 400	-0.3		2SA1015(L)
Low noise	50	0.15	200 to 700	0.3	2SC732TM	_
	30	0.5	70 to 400	0.25	2SC1959	
	-30	-0.5	70 to 240	-0.25	1	2SA562TM
A P. 11	80	0.3	70 to 240	0.5	2SC1627	
Audio drivers	-80	-0.3	70 to 240	-0.4	T	2SA817
	30	0.8	100 to 320	0.5	2SC2120	
	-30	-0.8	100 to 320	-0.7	[2SA950
	20	2	120 to 700	0.5	2SC3266	
	-20	-2	120 to 400	-0.5	T	2SA1296
	10	2	140 to 600	0.5	2SC3279	
	-10	-2	140 to 600	-0.5	[2SA1300
High current	10	5	700 to 2000	0.25	2SC5853	_
	10	5	450 to 700	0.27	2SC5854	_
	10	5	450 to 700	0.3	_	_
	80	1.2	100 to 200	0.09	2SC6132 *	_
Darlington	40	0.3	10000 min	1.3	2SC982TM	_
Muting	20	0.3	200 to 1200	0.1	2SC2878	_
	300	0.1	30 to 150	0.5	2SC2551	
High breakdown voltage	-300	-0.1	30 to 150	-0.5	[2SA1091
riigii breakuowii voitaye	250 -250	0.05 -0.05	50 min 50 min	1.5 -1.5	2SC3333	2SA1320
High-speed switching	15	0.2	40 to 240	0.3	2SC752(G)TM	_
High hre	50	0.15	600 to 3600	0.25	2SC3112	_

The products shown in bold are also manufactured in offshore fabs.

*: New product

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

General-Purpose Transistors (Single)

General-P	uipos	se III	ansisions (Single)								
									(Surface-M		1	
			CS	T3	fS	SM	VE	SM	ES	SM	SS	SM
Classification	VCEO (V) Max	Ic (mA) Max	Ø1 Ø1	2.6	1.0	0.6	12	1.2	980	1.6	9,00	1.6
				(mm)		(mm)		(mm)		(mm)		(mm)
			NPN	PNP	NPN	PNP	NPN	PNP	NPN	PNP	NPN	PNP
		100		2SA2154CT		2SA2154						
	50	150	200002001	20/12/0101	2000020	20/12/01	2SC6026MFV	2SA2154MFV	2SC4738F	2SA1832F	2SC4738	2SA1832
General-purpose	30	500										
	50	500										
Low noise	120	100										
	12	400	2SC5376CT	2SA1955CT			2SC5376FV	2SA1955FV	2SC5376F	2SA1955F	2SC5376	2SA1955
	12	500										
	15	800										
	25	800										
	30	800										
	10	2000										
High current	20	2000										
	20	1500										
	20	2500										
	30	3000										
	50	1000										
	50	1700										
-	50	2500										
Strobe	10	5000										
		(3000)										
High breakdown voltage	80	300										
High hre	50	150										
Muting	20	300										
High-speed switching	15	200										
High-voltage switching	200	50										
High breakdown	250	50										
voltage	300	100										
Darlington	40	300										
			uo olan () indicat					•				

- For the PNP transistors, the minus sign (–) indicating a negative voltage is omitted.
 The products shown in bold are also manufactured in offshore fabs.
- Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

								Leaded	Туре
-	USM	U	IFM	Т	SM	9	S-MINI	TO-	92
2.1	20	21	2.0	100	2.9	25	29	XANAS HINZG	MAX
	(mm)		(mm)		(mm)		(mm)		1)
NPN	PNP	NPN	PNP	NPN	PNP	NPN	PNP	NPN	PNP
2SC4116	2SA1586					2SC2712	2SA1162	2SC1815	2SA1015
2SC4118	2SA1588					2SC2859	2SA1182	2SC1959	2SA562TM
						2SC3325	2SA1313		
2SC4117	2SA1587					2SC2713	2SA1163	2SC2240	2SA970
						2SC3324	2SA1312		
2SC5233	2SA1954					2SC5232	2SA1953		
							2SA1362		
						2SC3265	2SA1298		
						2SC4210	2SA1621	2SC2120	2SA950
								2SC3279	2SA1300
								2SC3266	2SA1296
		2SC6133 *	2SA2214 *						1
			2SA2215 *						
		2SC6134 *							
		2SC6135 *							
			2SA2195 *						
		2SC6100 *							
				(2SC5766)				2SC5853	
								2SC5471	
								2SC5854	
								2SC6067 *	
						2SC4209	2SA1620	2SC1627	2SA817
2SC4666						2SC3295		2SC3112	
2SC4213						2SC3326		2SC2878	
2SC4667						2SC3437		2SC752(G)TM	
						2SC3138	2SA1255		
			1					2SC3333	2SA1320
						2SC4497	2SA1721	2SC2551	2SA1091
						2SC2532		2SC982TM	

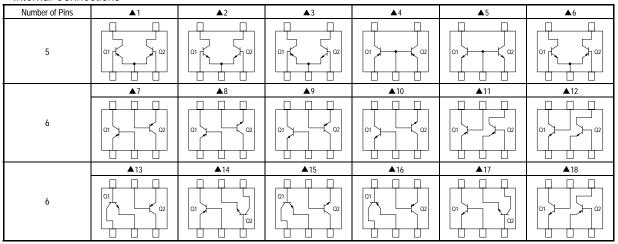
^{*:} New product

General-Purpose Transistors (Dual)

	u.pc		ansisiors (i	Duui,								
							,		Dual Type	,		
			CST6		fS6		ESV		SV		SMV	
Classification	VCEO (V) Max	Ic (mA) Max	1.0		0.0		16	2.1	20	0	2.9	
			(mm)			(mm)	(mm)		(mm)			(mm)
			NPN + PNP	NPN	PNP	NPN + PNP	PNP + NPN	NPN	PNP	NPN	PNP	PNP + NPN
General -purpose	50	150 (100)	(HN2B26CT) (▲18) **		(HN2A26FS)	(HN1B26FS) (▲9)		2SC4944	2SA1873 (▲1) HN4A56JU (▲4)	(▲2)	2SA1618 (▲1)	
F. F. F. S. S.	30	500										HN4B04J (▲3) *
	50	500										
Low noise	120	100								(▲2)	HN4A51J	HN4B06J (▲3)
	12	400						HN4C05JU (▲2)		,	, ,	
	12	500										
	15	800										
High current	25	800								HN4C08J (▲2)	HN4A08J (▲1)	
	30	800										
	10	2000										
	20	2000										
Strobe	10	5000										
High breakdown voltage	80	300										
High hFE	50	150										
Muting	20	300										
High-speed switching	15	200										
High-voltage switching	200	50										
High breakdown	250	50										
voltage	300	100										
Darlington	40	300										

- For the PNP transistors, the minus sign (–) indicating a negative voltage is omitted.
 The ratings enclosed in parenthesis are for those devices whose part numbers are enclosed in parentheses.
 The products shown in bold are also manufactured in offshore fabs.
 Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

♦Internal Connections



	ES6			US6			SM6			
:	1.6		2.1	20						
		(mm)			(mm)			(m		
NPN	PNP	PNP + NPN	NPN	PNP	PNP + NPN	NPN	PNP	PNP + NP		
HN1C01FE (▲10) HN2C01FE	HN1A01FE	HN1B04FE		HN1A01FU	HN1B01FU (▲8) HN1B04FU	UN1CO1E	HN1A01F (▲7)	HN1B01F		
	HN2A01FE (▲11)	(▲9)		HN2A01FU			, ,	HN3B01F		
(▲17)			(▲15)		(▲14)			HN1B04F		
						HN1C07F (▲10)	HN1A07F (▲7)			
						HN3C51F (▲15)				
HN1C05FE (▲10)										
							HN1A02F (▲7)			
							(-1)			
			HN1C03FU			HN1C03F				
			(▲ 10) HN3C61FU			(▲10)				
			(▲15)							

^{*:} New product

^{**:} Under development

Bias Resistor Built-in Transistors (Single, General-Purpose)

gs	VCEO(V)) 20 50										
Ratings	Ic(mA)				50					10	00	
		fS	SM	CS	ST3		CST6		CS	ST3	VE	SM
Re (ternal sistors kΩ)	NPN PNP		(mm)			60	1.0 (mm)	0.6	(mm)	7 2 8 8 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9 9	(mm)
R1	R2	NPN	PNP	NPN	PNP	NPN	PNP	NPN + PNP	NPN	PNP	NPN	PNP
4.7	4.7	RN1101FS	RN2101FS	RN1101CT	RN2101CT	RN1961CT	RN2961CT		RN1101ACT	RN2101ACT	RN1101MFV	RN2101MFV
10	10	RN1102FS	RN2102FS	RN1102CT	RN2102CT	RN1962CT	RN2962CT		RN1102ACT	RN2102ACT	RN1102MFV	RN2102MFV
22	22	RN1103FS	RN2103FS	RN1103CT	RN2103CT	RN1963CT	RN2963CT		RN1103ACT	RN2103ACT	RN1103MFV	RN2103MFV
47	47	RN1104FS	RN2104FS			RN1964CT	RN2964CT		RN1104ACT RN2104ACT		RN1104MFV	RN2104MFV
2.2	47	RN1105FS			RN1965CT	RN2965CT		RN1105ACT	RN2105ACT	RN1105MFV	RN2105MFV	
4.7	47	RN1106FS	RN2106FS	RN1106CT	RN2106CT	RN1966CT	RN2966CT	RN49P2ACT	RN1106ACT	RN2106ACT	RN1106MFV	RN2106MFV
10	47	RN1107FS	RN2107FS	RN1107CT	RN2107CT	RN1967CT	RN2967CT		RN1107ACT	RN2107ACT	RN1107MFV	RN2107MFV
22	47	RN1108FS	RN2108FS	RN1108CT	RN2108CT	RN1968CT	RN2968CT		RN1108ACT	RN2108ACT	RN1108MFV	RN2108MFV
47	22	RN1109FS	RN2109FS	RN1109CT	RN2109CT	RN1969CT	RN2969CT		RN1109ACT	RN2109ACT	RN1109MFV	RN2109MFV
4.7	œ	RN1110FS	RN2110FS	RN1110CT	RN2110CT	RN1970CT	RN2970CT		RN1110ACT	RN2110ACT	RN1110MFV	RN2110MFV
10	œ	RN1111FS	RN2111FS	RN1111CT	RN2111CT	RN1971CT	RN2971CT		RN1111ACT	RN2111ACT	RN1111MFV	RN2111MFV
22	œ	RN1112FS	RN2112FS	RN1112CT	RN2112CT	RN1972CT	RN2972CT		RN1112ACT	RN2112ACT	RN1112MFV	RN2112MFV
47	oc	RN1113FS	RN2113FS	RN1113CT	RN2113CT	RN1973CT	RN2973CT		RN1113ACT	RN2113ACT	RN1113MFV	RN2113MFV
1	10										RN1114MFV	RN2114MFV
2.2	10										RN1115MFV	RN2115MFV
4.7	10										RN1116MFV	RN2116MFV
10	4.7										RN1117MFV	RN2117MFV
47	10										RN1118MFV	RN2118MFV
1	_										RN1119MFV	RN2119MFV
100	100										RN1130MFV	RN2130MFV
100	× ×									RN1131MFV	RN2131MFV	
200		+ + + + + + + + + + + + + + + + + + + +							RN1132MFV	RN2132MFV		

- For the PNP transistors, the minus sign (–) indicating a negative voltage is omitted.
- The products shown in bold are also manufactured in offshore fabs.
- Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(Single, High-Current/Muting Switch)

			High (Current		Muting
ngs	VCEO(V)	1	2	5	50	20
Rati	Ic(mA)	50	00	8	00	300
		US	SM	S-N	⁄INI	S-MINI
Res	ernal sistors kΩ)	12 N		25 2 1 2 2 2		2.9 N 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
R1	R2	NPN	PNP	NPN	PNP	NPN
1	1	RN1321A	RN2321A	RN1421	RN2421	
2.2	2.2	RN1322A	RN2322A	RN1422	RN2422	
4.7	4.7	RN1323A	RN2323A	RN1423	RN2423	
10	10	RN1324A	RN2324A	RN1424	RN2424	
0.47	10	RN1325A	RN2325A	RN1425	RN2425	
1	10	RN1326A	RN2326A	RN1426	RN2426	
2.2	10	RN1327A	RN2327A	RN1427	RN2427	
5.6	œ					RN1441
10	œ					RN1442
22	œ					RN1443
2.2	oo					RN1444

- For the PNP transistors, the minus sign (–) indicating a negative voltage is omitted.
- Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

				50					
				100)				
ES	SM	SS	SM	U:	SM	S-N	IINI	TO	-92
1.6 (mm		2 g (mm)		2.1	(mm)	25	2.9 (mm)	2. AMX 47 MAX	(mr
NPN	PNP	NPN	PNP	NPN	PNP	NPN	PNP	NPN	PNP
RN1101F	RN2101F	RN1101	RN2101	RN1301	RN2301	RN1401	RN2401	RN1001	RN200
RN1102F	RN2102F	RN1102	RN2102	RN1302	RN2302	RN1402	RN2402	RN1002	RN2002
RN1103F	RN2103F	RN1103	RN2103	RN1303	RN2303	RN1403	RN2403	RN1003	RN2003
RN1103F RN2103F				RN1304	RN2304	RN1404 RN2404		RN1004	RN2004
RN1105F	RN2105F	RN1105	RN2105	RN1305	RN2305	RN1405	RN2405	RN1005	RN200
RN1106F	RN2106F	RN1106	RN2106	RN1306	RN2306	RN1406	RN2406	RN1006	RN200
RN1107F	RN2107F	RN1107	RN2107	RN1307	RN2307	RN1407	RN2407	RN1007	RN200
RN1108F	RN2108F	RN1108	RN2108	RN1308	RN2308	RN1408	RN2408	RN1008	RN2008
RN1109F	RN2109F	RN1109	RN2109	RN1309	RN2309	RN1409	RN2409	RN1009	RN200
RN1110F	RN2110F	RN1110	RN2110	RN1310	RN2310	RN1410	RN2410	RN1010	RN2010
RN1111F	RN2111F	RN1111	RN2111	RN1311	RN2311	RN1411	RN2411	RN1011	RN201
RN1112F	RN2112F	RN1112	RN2112	RN1312	RN2312	RN1412	RN2412		
RN1113F	RN2113F	RN1113	RN2113	RN1313	RN2313	RN1413	RN2413		
RN1114F	RN2114F	RN1114	RN2114	RN1314	RN2314	RN1414	RN2414		
RN1115F	RN2115F	RN1115	RN2115	RN1315	RN2315	RN1415	RN2415		
RN1116F	RN2116F	RN1116	RN2116	RN1316	RN2316	RN1416	RN2416		
RN1117F	RN2117F	RN1117	RN2117	RN1317	RN2317	RN1417	RN2417		
RN1118F	RN2118F	RN1118	RN2118	RN1318	RN2318	RN1418	RN2418		
RN1130F	RN2130F								
RN1131F	RN2131F								
RN1132F	RN2132F								

Bias Resistor Built-in Transistors (Dual, General-Purpose (5 Pin))

DIAS KESISII			iaiisi	31013	נטענ	ıı, Gel	ierai-Purpose (5	1 111))		T		
	Max	solute kimum ktings	ı	Internal I	Resistors	S		ESV			USV	
	VCEO	Ic	C	Ω1	Q	2		91	(mm)		20	(mm)
Classification							NPN x 2	PNP x 2	NPN + PNP	NPN x 2	PNP x 2	NPN + PNP
			R1	(kΩ) R2	R1	(kΩ) R2	01 02 R2 R2 R2	01 02 R2 R2 R2 R1 R1	RI Q2	01 02 02 R2 R2 R2 R1 R1 R1	01 02 R2 R2 R1 R1 R1	R1 02 02 01 R2 R1
	(V)	(mA)					Common emitter	Common emitter	Collector-base connection	Common emitter	Common emitter	Collector-base connection
	. ,	` /	4.7	4.7	4.7	4.7	RN1701JE	RN2701JE		RN1701	RN2701	
			10	10	10	10	RN1702JE	RN2702JE	RN47A3JE	RN1702	RN2702	RN47A3
			22	22	22	22	RN1703JE	RN2703JE	RN47A2JE	RN1703	RN2703	RN47A2
			47	47	47	47	RN1704JE	RN2704JE		RN1704	RN2704	
			2.2	47	2.2	47	RN1705JE	RN2705JE		RN1705	RN2705	
			4.7	47	4.7	47	RN1706JE	RN2706JE		RN1706	RN2706	
			10	47	10	47	RN1707JE	RN2707JE		RN1707	RN2707	
			22	47	22	47	RN1708JE	RN2708JE		RN1708	RN2708	
			47	22	47	22	RN1709JE	RN2709JE		RN1709	RN2709	
			4.7	_	4.7		RN1710JE	RN2710JE	RN47A1JE	RN1710	RN2710	RN47A1
	50	100	10		10		RN1711JE	RN2711JE		RN1711	RN2711	
	30	100	22	_	22	_		RN2712JE				
			47	_	47	_		RN2713JE				
General-purpose			1	10	1	10					RN2714	
			2.2	10	2.2	10						
			4.7	10	4.7	10						
			10	4.7	10	4.7						
			47	10	47	10						
			47	47	10	47			RN47A4JE			RN47A4
			47	47	4.7	10			RN47A5JE			RN47A5
			100	100	100	100						RN47A6
			10	10	47	10						RN47A7
	Q1: 50 Q2: 12	Q1: 100 Q2: 100 (Lowsat)	10	10	4.7	10			RN47A7JE			
	Q1: 50	Q1: 100										
	Q2: 30	Q2: 100 (High hfe)	10	10	10	47			RN47A8JE			
Muting	20	300	2.2	_	2.2	_						
•			/) : 1				•	•		•		

[•] For the PNP transistors, the minus sign (–) indicating a negative voltage is omitted.

[•] The products shown in bold are also manufactured in offshore fabs.

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

ı		
	SMV	
	29	(mi
NPN x 2	PNP x 2	NPN + PNP
01 02 02 02 02 03 03 03 03 03 03 03 03 03 03 03 03 03	13 S S S S S S S S S S S S S S S S S S S	RI COLOR DE
Common emitter	Common emitter	Collector-base connection
RN1501	RN2501	
RN1502	RN2502	
RN1503	RN2503	
RN1504	RN2504	
RN1505	RN2505	
RN1506	RN2506	
RN1507	RN2507	
RN1508	RN2508	
RN1509	RN2509	
RN1510	RN2510	
RN1511	RN2511	
RN1544		

The internal connection diagrams only show the general configurations of the circuits.

(Dual, Gei	neral-	Purpo	se (6	6 Pir	1))												
										fS6	1						
									9	880	1.0						
Classification	Abso	olute								Abso	olute						
	Maxi	mum	Inte	ernal I	Resist	ors	NPN	PNP	PNP + NPN	Maxi	mum	Inte	ernal F	Resisto	ors	NPN x 2	PNP x 2
	Rati										ings						
	VCEO	Ic	Q	:1 (kΩ))2 (kΩ)	R1 R2 Q2	R1 \$ R2	R1 \$ R2	VCEO	Ic	Q	1 (kΩ)	C	2 (kΩ)	01 R1 02	01 R1 02
			R1	R2	R1	R2	R2 ≰R1	R2 ≸ R1	R2 ≨ R1			R1	R2	R1	R2	R2 R2 R1	R2 R2 ≨R1
	(V)	(mA)								(V)	(mA)						
			4.7	4.7	4.7	4.7	RN1901AFS	RN2901AFS	RN4981AFS			4.7	4.7	4.7	4.7	RN1961FS	RN2961FS
			10	10	10	10	RN1902AFS	RN2902AFS	RN4982AFS			10	10	10	10	RN1962FS	RN2962FS
			22	22	22	22	RN1903AFS	RN2903AFS	RN4983AFS			22	22	22	22	RN1963FS	RN2963FS
			47	47	47	47	RN1904AFS	RN2904AFS	RN4984AFS	<u> </u>		47	47	47	47	RN1964FS	RN2964FS
			2.2	47	2.2	47	RN1905AFS	RN2905AFS	RN4985AFS	<u> </u>		2.2	47	2.2	47	RN1965FS	RN2965FS
			4.7	47	4.7	47	RN1906AFS	RN2906AFS	RN4986AFS			4.7	47	4.7	47	RN1966FS	RN2966FS
			10	47	10	47	RN1907AFS	RN2907AFS	RN4987AFS	<u> </u>		10	47	10	47	RN1967FS	RN2967FS
			22	47	22	47	RN1908AFS	RN2908AFS	RN4988AFS	<u> </u>		22	47	22	47	RN1968FS	RN2968FS
			47	22	47	22	RN1909AFS	RN2909AFS	RN4989AFS			47	22	47	22	RN1969FS	RN2969FS
			4.7	_	4.7	_	RN1910AFS	RN2910AFS	RN4990AFS			4.7	_	4.7	_	RN1970FS	RN2970FS
General			10	_	10	_	RN1911AFS	RN2911AFS	RN4991AFS			10	_	10	—	RN1971FS	RN2971FS
-purpose	50	80	22	—	22	_	RN1912AFS	RN2912AFS	RN4992AFS	20	50	22	_	22	—	RN1972FS	RN2972FS
p=-p			47	—	47	_	RN1913AFS	RN2913AFS	RN4993AFS			47	_	47	—	RN1973FS	RN2973FS
			1	10	1	10						1	10	1	10		
			2.2	10	2.2	10						2.2	10	2.2	10		
			4.7	10	4.7	10						4.7	10	4.7	10		
			10	4.7	10	4.7						10	4.7	10	4.7		
			47	10	47	10						47	10	47	10		
			2.2	47	22	47				4		2.2	47	22	47		
			2.2	47	47	47						2.2	47	47	47		
			22	22	10	10				4		22	22	10	10		
			10	10	10	_				4		10	10	10	_		
			47	47	4.7	47						47	47	4.7	47		
General	40		4.7	_	4.7	_				40		4.7	_	4.7	_		
-purpose	(-30)	100	10	_	10	_				(-30)	100	10	_	10	_		
(Hiβ)			22	_	22	_						22	_	22	_		
Power SW	50 (-12)	100 (-500)	10	47	2.0	10				50 (-12)	100 (-500)	10	47	2.0	10		

[•] For the PNP transistors, the minus sign (–) indicating a negative voltage is omitted.

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(mm)

NPN x 2	PNP x 2	NPN + PNP	NPN + PNP	NPN + PNP	NPN + PNP	Abso Maxi Rati	mum	Int	ernal F	Resist	ors	NPN + PNP
RI \$ R2	R1 & R2	01 R1 R2 02 R2	01 R1 02 R2 R1	O2 Ris R2 Ris R2	01 R1 02 02 R2 R1 R2 R2	VCEO	lc	C	(kΩ))2 (kΩ)	01 02 02 RI\$ R2 R\$ R2
R2 \$R1	R2 & R1			RIŞ *** RIŞ KZ	RIS KZ	(V)	(mA)	R1	R2	R1	R2	RI\$ RZ RI\$ RZ
RN1901FS	RN2901FS	RN4981FS						4.7	4.7	4.7	4.7	
RN1902FS	RN2902FS	RN4982FS						10	10	10	10	
RN1903FS	RN2903FS	RN4983FS						22	22	22	22	
RN1904FS	RN2904FS	RN4984FS		RN49J2FS	RN49J7FS			47	47	47	47	RN49J2AFS
RN1905FS	RN2905FS	RN4985FS						2.2	47	2.2	47	
RN1906FS	RN2906FS	RN4986FS						4.7	47	4.7	47	
RN1907FS	RN2907FS	RN4987FS						10	47	10	47	
RN1908FS	RN2908FS	RN4988FS						22	47	22	47	
RN1909FS	RN2909FS	RN4989FS						47	22	47	22	
RN1910FS	RN2910FS	RN4990FS						4.7	_	4.7	_	
RN1911FS	RN2911FS	RN4991FS						10	_	10	_	
RN1912FS	RN2912FS	RN4992FS				50	50	22	_	22	_	
RN1913FS	RN2913FS	RN4993FS						47	_	47	_	
								1	10	1	10	
								2.2	10	2.2	10	
								4.7	10	4.7	10	
								10	4.7	10	4.7	
								47	10	47	10	
								2.2	47	22	47	
								2.2	47	47	47	
								22	22	10	10	
			RN49P1FS					10	10	10		
		RN49A6FS						47	47	4.7	47	
						40		4.7	_	4.7	_	
						40 (–30)	100	10	_	10	_	
						(-30)		22	_	22	_	
						50 (–12)	100 (-500)	10	47	2.0	10	

The internal connection diagrams only show the general configurations of the circuits.

(Dual, General-Purpose (6 Pin)) (Continued)

(Dual, Gel	iorai	· u.pc	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	0 1 111	771	Join	naca)						
	Abso	olute											
	Maxi	mum	Int	ernal F	Resist	ors				ES6			
	Rati	ings											
	VCEO	Ic	Q	1	()2							
										← 1.6			
										*			
										9 2 2			
Classification										↓ ¥			
Ciassilication													(mm)
							NPN x 2	PNP x 2	NPN x 2	PNP x 2	PNP + NPN	NPN + PNP	NPN + PNP
							R1 ≸ R2	R1 R2 R2 Q2	Q1 R1 Q2	Q1 R1 Q2			Q1 R1 Q2
				(kΩ)		(kΩ)	R1 R2 R2 O2	01	01 R1 02 02 R2 R1	02	01 R1 W 2 02	01 R2 02	
			R1	R2	R1	R2	R2 R1 02	R2 ≨ R1	R2 R2 R1	01 R1 02 02 R2 R1	01 R1 R2 R1 V 02	R2 R1	Q1
	(V)	(mA)											
			4.7	4.7	4.7	4.7	RN1901FE	RN2901FE	RN1961FE	RN2961FE	RN4901FE	RN4981FE	
			10	10	10	10	RN1902FE	RN2902FE	RN1962FE	RN2962FE	RN4902FE	RN4982FE	RN4962FE
			22	22	22	22	RN1903FE	RN2903FE	RN1963FE	RN2963FE	RN4903FE	RN4983FE	
			47	47	47	47	RN1904FE	RN2904FE	RN1964FE	RN2964FE	RN4904FE	RN4984FE	
			2.2	47	2.2	47	RN1905FE	RN2905FE	RN1965FE	RN2965FE	RN4905FE	RN4985FE	
			4.7	47	4.7	47	RN1906FE	RN2906FE	RN1966FE	RN2966FE	RN4906FE	RN4986FE	
			10	47	10	47	RN1907FE	RN2907FE	RN1967FE	RN2967FE	RN4907FE	RN4987FE	
			22	47	22	47	RN1908FE	RN2908FE	RN1968FE	RN2968FE	RN4908FE	RN4988FE	
			47	22	47	22	RN1909FE	RN2909FE	RN1969FE	RN2969FE	RN4909FE	RN4989FE	
			4.7	_	4.7	_	RN1910FE	RN2910FE	RN1970FE	RN2970FE	RN4910FE	RN4990FE	
General			10		10		RN1911FE	RN2911FE	RN1971FE	RN2971FE	RN4911FE	RN4991FE	
-purpose	50	100	22		22	_	INVITATI E	TANZ/THE	100177112	144277112	TOTAL E	TATT / / II E	
parpose			47		47								
			1	10	1	10							
			2.2	10	2.2	10							
			_	_									
			4.7	10	4.7	10							
			10	4.7	10	4.7							
			47	10	47	10					DNIAGATEE		
			2.2	47	22	47					RN49A1FE		
			2.2	47	47	47							
			22	22	10	10							
			10	10	10	_			DAMAGRALIEE	DAIGOZGUEE		DALLOGGUEE	
General	40		4.7	_	4.7	_			RN1970HFE	RN2970HFE		RN4990HFE	
-purpose	(-30)	100	10	_	10	_			RN1971HFE	RN2971HFE		RN4991HFE	
(Hiβ)	`/		22	_	22	_			RN1972HFE	RN2972HFE		RN4992HFE	
Power SW	50	100	10	47	2.0	10							
. 551 517	(-12)	(-500)	.0	.,	2.0								

The internal connection diagrams only show the general configurations of the circuits.

For the PNP transistors, the minus sign (–) indicating a negative voltage is omitted.
 Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

	Abso Maxii Rati	mum	Inte	rnal R	Resist	ors			U	S6		
Classification	VCEO	lc	Q1		C	02			12	20 H H		(mm)
							NPN x 2	PNP x 2	NPN x 2	PNP x 2	PNP + NPN	NPN + PNP
	(V)	(mA)		(kΩ) R2	R1	(kΩ) R2	R1 \$ R2	RI & R2	01 R1 \$ 02 02 R2 \$R1	01 R1 \$ 02	01 81 82 02	
				4.7	4.7	4.7	RN1901	RN2901	RN1961	RN2961	RN4901	RN4981
			10	10	10	10	RN1902	RN2902	RN1962	RN2962	RN4902	RN4982
			22 47	22 47	22 47	22 47	RN1903 RN1904	RN2903 RN2904	RN1963 RN1964	RN2963 RN2964	RN4903 RN4904	RN4983 RN4984
			2.2	47	2.2	47	RN1905	RN2905	RN1965	RN2965	RN4905	RN4985
			4.7	47	4.7	47	RN1906	RN2906	RN1966	RN2966	RN4906	RN4986
			10	47	10	47	RN1907	RN2907	RN1967	RN2967	RN4907	RN4987
			22	47	22	47	RN1908	RN2908	RN1968	RN2968	RN4908	RN4988
			47	22	47	22	RN1909	RN2909	RN1969	RN2969	RN4909	RN4989
			4.7	_	4.7	_	RN1910	RN2910	RN1970	RN2970	RN4910	RN4990
General	50	100	10	_	10	_	RN1911	RN2911	RN1971	RN2971	RN4911	RN4991
-purpose	50	100	22	—	22	_						
			47	—	47	_			RN1973			
			1	10	1	10						
			2.2	10	2.2	10				RN2975		
			4.7	10	4.7	10						
			_	4.7	10	4.7						
			47	10	47	10					RN49A1	
			2.2	47 47	22 47	47					RN49A1 RN49A2	
			2.2	22	10	47 10					KIN49AZ	
			10	10	10	10						
General			4.7	_	4.7							
-purpose	40	100	10	_	10	_						
(Ніβ)	(-30)		22	_	22	_						
Power SW	50 (–12)	100 (–500)	10	47	2.0	10						RN49A5

The internal connection diagrams only show the general configurations of the circuits.

<sup>For the PNP transistors, the minus sign (–) indicating a negative voltage is omitted.
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(Dual, General-Purpose (6 Pin)) (Continued)

(Dual, Gei	neral-	Purpo	se (6 Pin))((Conti	nued)			
	Abso									
	Maxi		Int	ernal F	Resist	ors		SI	M6	
	Rati		_	_	_					
	VCEO	Ic	Q	11	C	!2		★	2.9	
								<u>↑</u>		
								1.6		
								2 -		
Classification								↓		(mm)
							NIDNI O	DND 0	NIDNI O	` '
							NPN x 2	PNP x 2	NPN x 2	PNP + NPN
				(1.0)		(1.0)	R1 \$ R2	R1 \$ R2	01 R1 02	R1 R2 3 02
				(kΩ)		(kΩ)		~ ~~ ¬~°	W → W → R2 ≥R1	Q1 N R1 C2
	0.0	,	R1	R2	R1	R2	K2 \$R1	R2 ≸R1		
	(V)	(mA)					D114404	Duo(of		Divini
			4.7	4.7	4.7	4.7	RN1601	RN2601		RN4601
			10	10	10	10	RN1602	RN2602		RN4602
			22	22	22	22	RN1603	RN2603		RN4603
			47	47	47	47	RN1604	RN2604		RN4604
			2.2	47	2.2	47	RN1605	RN2605		RN4605
			4.7	47	4.7	47	RN1606	RN2606		RN4606
			10	47	10	47	RN1607	RN2607		RN4607
			22	47	22	47	RN1608	RN2608		RN4608
			47	22	47	22	RN1609	RN2609		RN4609
			4.7	_	4.7	_	RN1610	RN2610		RN4610
General	50	100	10	_	10	_	RN1611	RN2611		RN4611
-purpose			22	_	22	_			DN1/70	RN4612
			47	_	47	_			RN1673	
			1	10	1	10				
			2.2	10	2.2 4.7	10				
			4.7	10		10				
			10	4.7	10	4.7				
			47	10	47	10				
			2.2	47	22	47				
			2.2	47	47	47				DNA/A1
			22	22	10	10				RN46A1
			10	10	10	_				
General	40	100	4.7	_	4.7	_				
-purpose	(-30)	100	10	_	10	_				
(Hiβ)			22	_	22	_				
Power SW	50 (–12)	100 (-500)	10	47	2.0	10				
	(-12)	(-500)								

For the PNP transistors, the minus sign (—) indicating a negative voltage is omitted.
 The products shown in bold are also manufactured in offshore fabs.

The internal connection diagrams only show the general configurations of the circuits.

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Junction FETs

Junction FETs (Leaded Type)

					Pacl TO-92	(SC-43)
Classification	VGDS (V) Max	IG (mA) Max	Idss (mA)	Yfs (mS) Min		(mm)
					Nch	Pch
		<u>10</u> 	1.2 to 14 -1.2 to -14	1.5 1	2SK246	2SJ103
	-50	10	1.2 to 14	4	2SK117	_
General-purpose	-50	10	1.2 to 14	5	2SK362	_
	-40	10	5 to 30	25	2SK363	_
	-40	10	2.6 to 20	12	2SK364	
	-50	10	0.3 to 6.5	1.2	2SK30ATM	_
Low noise	-40	10	2.6 to 20	_	2SK170	
	-40	10	2.6 to 20	25	2SK369	_

The products shown in bold are also manufactured in offshore fabs.

(Surface-Mount Type)

(Surface Mount Type)									
						Pacl	kage		
					S-MINI	(SC-59)	USM (SC-70)	
Classification	VGDS (V) Max	IG (mA) Max	loss (mA)	Yfs (mS) Min	25		21	2.0 H (mm)	
					Nch	Pch	Nch	Pch	
	-50	10	0.3 to 6.5	1.2	2SK208		2SK879		
General-purpose	50	-10	−1.2 to −14	1		2SJ106		2SJ144	
Generar-purpose	-50	10	1.2 to 14	4	2SK209	2SK880		_	

The products shown in bold are also manufactured in offshore fabs.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(Surface-Mount Type) (Electret Condense Microphone)

	11.07						Pac	kage	
					·	VESM	TESM3	VESM2	CST3
Characteristics	V _{GDS} (V) Max	IG (mA) Max	IDSS Rank (μΑ)	Yfs (mS) Min	Ciss (pF) Typ.	1.2 2 00 0.5	2 2 2 0 0 395	12 2 03 (max)	0.6
						(mm)	(mm)	(mm)	(mm)
High gain Low THD	-20	10	A = 80 to 200	0.55	3.6	2SK3582MFV	2SK3582TK	2SK3582TV	2SK3582CT
Low Noise Small Ciss	20		B = 170 to 300	0.00	0.0	ZOROGOZIII V	20110002111	2011000211	2011000201
High gain Low THD	-20	10	A = 140 to 240	0.9	3.5	2SK3857MFV	2SK3857TK	2SK3857TV	2SK3857CT
Small Ciss	20	10	B = 210 to 350	0.7	3.3	20100071111	201000711	201000714	201000701
			A = 140 to 240						
High gain	-20	10	B = 210 to 350	1.35	4.0	2SK4059MFV	2SK4059TK	2SK4059TV	2SK4059CT
Small Ciss	20		BK = 210 to 400	1.55	1.0	201(10071111 V	201(100)11(201(10071)	201(100701
			C = 320 to 500						
Very Low Noise	-20	10	A = 140 to 240	0.65	1.8	TTK101MFV	_	_	_
Very Small Ciss			B = 210 to 350						

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Junction FETs (Dual) (Surface-Mount Type)

Junction 1 E 13 (Duai) (Surface	5-IVIOUITE TYP	٠٠,						
						Pacl	cage		
					SM	VN	US	SV	
Classification	Vgds (V)	IG (mA)	Idss (mA)	Yfs (mS) Min	28 Z J J J J J J J J J J J J J J J J J J	2.9 (mm)	2.1	20 (mm)	◆Internal Connections
					Nch x 2	Pch x 2	Nch x 2	Pch x 2	
General-purpose	-50	10	1.2 to 14	4	2SK2145		2SK3320	_	01 02

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

 $[\]bullet \text{The internal connection diagrams only show the general configurations of the circuits}. \\$

Combination Products of Different Type Devices

Combination Products of Different Type Devices (5-Pin Packages (UFV, SMV), 6-Pin Packages (ES6, US6, SM6))

Combination P	roducts of Dif	ferent Type De		Packages (UFV, S	SMV), 6-Pin Pacl	kag	es (ES6,	US6,				T
	ES6 Package	UFV Package	Part Number US6 Package	SMV Package	SM6 Package				Rati	ings		
Internal Connections	16 1 detage	(mm)	20 (mm)	(mm)	Sivo i ackage		Component Devices	Break Volt (\			rent nA)	Features
		_	HN7G01FU		_	Q1	2SA1955	VCEO	-12	lc	-400	PNP Low Vce(sat), suitable for power supply switches
						Q2	2SK1829	Vds	20	lo	50	2.5-V gate drive (Vth = 1.5 V max), Ron = 20Ω typ.
PNP + Nch	HN7G01FE	_	_	_	_	Q1	2SA1955	VCEO	-12	lc	-400	PNP Low Vce(sat), suitable for power supply switches 2.5-V gate drive
01 02						Q2 Q1	SSM3K03FE		20	ID In	50	$ (Vth = 1.3 \text{ V max}), \\ Ron = 4 \Omega \text{ typ}. \\ PNP \text{ Low VCE(SAT)}, $
	_	_	HN7G03FU	_	_	QI	2SA1955	VCEO	-12	Ic	-400	suitable for power supply switches Internal 1-MΩ resistor (RGS)
						Q2	SSM3K04FU	VDS	20	ID	100	2.5-V gate drive (Vth = 1.3 V max), Ron = 4 Ω typ.
PNP (BRT) + Nch	_	_	HN7G02FU	_	_	Q1 Q2	RN2310 2SK1829	Vceo Vds	-50 20	Ic ID	-100 50	PNP (Internal resisters), $R = 4.7 \text{ k}\Omega$ 2.5-V gate drive (Vth = 1.5 V max),
Q1 R Q2						Q1	RN2310	VCEO	-50	Ic	-100	Ron = 20Ω typ. PNP (Internal resisters), R = $4.7 \text{ k}\Omega$
	HN7G02FE		_			Q2	SSM3K03FE	VDS	20	lo	50	2.5-V gate drive (Vth = 1.3 V max), Ron = 4 Ω typ.
PNP + NPN (BRT)			HN7G04FU			Q1	2SA1955	VCEO	-12	lc	-400	PNP Low Vce(sat), suitable for power supply switches
02						Q2	RN1307	V CEO	50	Ic	100	NPN (Internal resisters), R1 = 10 k Ω , R2 = 47 k Ω
PNP (BRT) + Nch	_	_	HN7G05FU	_	_	Q1	RN2101	VCEO	-50	lc	-100	PNP (Internal resisters), $R1 = 4.7 \text{ k}\Omega,$ $R2 = 4.7 \text{ k}\Omega$
01						Q2	2SK1830	VDS	20	ID	50	2.5-V gate drive (Vth = 1.5 V max), Ron = 20 Ω typ.
PNP + NPN (BRT)	HN7G06FE		HN7G06FU	1		Q1	2SA1955	V CEO	-12	Ic	-400	supply switches
R1 & R2						Q2	RN1104	VCEO	50	lc	100	NPN (Internal resisters), R1 = 47 k Ω , R2 = 47 k Ω PNP Low VCE(SAT),
	HN7G08FE	_	_	_	_	Q1	2SA1955	V CEO	-12	Ic	-400	
						Q2	RN1306	VCEO	50	lc	100	$R1 = 4.7 \text{ k}\Omega,$ $R2 = 47 \text{ k}\Omega$
NPN + NPN (BRT)	_	_	HN7G07FU	_	_	Q1	2SC5376	VCEO	12	lc	400	NPN Low Vce(sat), suitable for power supply switches
						Q2	RN1115	VCEO	50	lc	100	NPN (Internal resisters), $R1 = 2.2 \text{ k}\Omega,$ $R2 = 10 \text{ k}\Omega$

The products shown in bold are also manufactured in offshore fabs.

The internal connection diagrams only show the general configurations of the circuits.

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Combination Products of Different Type Devices (5-Pin Packages (UFV, SMV), 6-Pin Packages (ES6, US6, SM6)) (Continued)

Combination I	Products of	Dillerent Ty	/pe Devices	(5-Pin Packaç	jes (UFV, SMV),	6-Pin Packages	3 (E	.S6, US6,	SM	6))	(Cc	ontinu	ied)
	FOUR I	FC/ D		rt Number	CMM/D	CM/ P. I				Rat	ings	;	
Internal Connections	ESV Package	ES6 Package	UFV Package	USV Package	SMV Package	SM6 Package	C	Component Devices	Break Volt (\	age		urrent mA)	Features
	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)							
NPN (BRT) + Nch	_	HN7G09FE	_	_	_	_	Q1	RN1104F	VCEO	50	lc	100	NPN (Internal resisters), R1 = 47 k Ω , R2 = 47 k Ω 2.5-V gate drive
NPN + Nch							Q2	SSM3K15FS	VDS	30	lD	100	$\label{eq:continuous} \begin{split} & \text{(Vth} = 1.5 \text{ V max),} \\ & \text{Ron} = 4 \ \Omega \text{ typ} \\ & \text{NPN Low Vce(SAT),} \end{split}$
01 02	_	HN7G10FE	_	_	_	_	Q1	2SC5376F	V CEO	12	IC	400	suitable for power supply switches 2.5-V gate drive
							Q2	SSM3K03FE	VDS	20	lo	50	(Vth = 1.3 V max), Ron = 4 Ω typ.
PNP + NPN (BRT)						HN7G11F *	Q1	2SA2214	VCEO	20	lc	1500	PNP, high-current
01 02	_	_	_	_	_	HN7G11F *	Q2	RN1102	Vceo	100	Ic	100	NPN (Internal resisters), R1 = 10 k Ω , R2 = 10 k Ω
Common emitter NPN + NPN (BRT)					HN4G01J		Q1	2SC4116	V CEO	50	lc	150	General-purpose NPN transistor
R2 R1							Q2	RN1303	V CEO	50	lc	100	NPN (Internal resisters), $R1 = 22 \text{ k}\Omega,$ $R2 = 22 \text{ k}\Omega$
Independent small-signal diode						HN2E01F	Q1	1SS352	VR	80	lo	100	Standard high-speed switching
+ NPN							Q2	2SC4666	Vceo	50	lc	150	High-hfe-type NPN
02		_	_	_		HN2E02F	Q1 Q2	1SS352 2SC4116	VR VCEO		lo Ic	100	Standard high-speed switching General-purpose
Independent PNP + small-signal													NPN transistor High breakdown
diode	_	_	_	_	_	HN2E04F	Q1	2SA1587	VCEO	-120	I C	-100	voltage PNP
01 \$\Bar{\Pi}_{02}\$							Q2	1SS352	VR	80	lo	100	Standard high-speed switching
Independent BRT (PNP) + small-signal diode	_	_	_	_	HN2E05J	_	Q1	RN2304	V CEO	-50	lc	-100	PNP (Internal resisters), R1 = 47 k Ω , R2 = 47 k Ω
01							Q2	1SS352	VR	80	lo	100	Standard high-speed switching
SBD + PNP (BRT)	UNIO507:-						Q1	1SS417	VR	40	lo	100	Schottky barrier diodes
01 Q1 Q2 R1 \$\frac{1}{2} \text{R2}	HN2E07JE		_	_	_	_	Q2	RN2104MFV	V CEO	-50	Ic	100	PNP (Internal resisters), $R1 = 47 \text{ k}\Omega,$ $R2 = 47 \text{ k}\Omega$

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

^{*:} New product

MOSFETs

Standard Family (Small-Signal MOSFETs) (Single-Type)

	I	Absolut		,					
	Maxir	num R	atings			Ра	ckage		
				CST3	VESM	SSM	USM (SC-70)	UFM	S-MINI (SC-59)
Polarity	VDS (V)	VGSS (V)	ID (mA)	0.6	7 2 2 2	9 8 9	20	2.0	29
				(mm)	(mm)	(mm)	(mm)	(mm)	(mm)
	20	10	100		SSM3K03FV				
	20	10	100		SSM3K04FV ★	SSM3K04FS ★	SSM3K04FU ★		
	20	±10	100	SSM3K16CT	SSM3K16FV	SSM3K16FS	SSM3K16FU		
	20	±10	180	SSM3K35CT	SSM3K35MFV	SSM3K35FS			
	20	±10	500		SSM3K36MFV	SSM3K36FS		SSM3K36TU	
	20	±10	500			SSM3K43FS # *			
	20	±12	400				SSM3K05FU		
	30	±20	100	SSM3K15CT	SSM3K15FV	SSM3K15FS	SSM3K15FU		SSM3K15F
N-ch	30	±20	100		SSM3K44MFV # *	SSM3K44FS # *			
	30	±20	200						2SK2009
	30	±20	400				SSM3K09FU		
	50	±7	100				SSM3K17FU		
	50	10	50				2SK1827		2SK1826
	60	±20	200				SSM3K7002FU		SSM3K7002F
	60	±20	200				SSM3K7002AFU		SSM3K7002AF
	60	±20	200				SSM3K7002BFU *		SSM3K7002BF *
	60	±20	200						2SK1062
	-20	±8	-330		SSM3J36MFV	SSM3J36FS		SSM3J36TU	
	-20	±12	-200				SSM3J05FU		
	-20	±10	-100	SSM3J16CT	SSM3J16FV	SSM3J16FS	SSM3J16FU		
	-20	±10	-100	SSM3J35CT	SSM3J35MFV	SSM3J35FS			
P-ch	-30	±20	-100	SSM3J15CT	SSM3J15FV	SSM3J15FS	SSM3J15FU		SSM3J15F
1	-30	±20	-200						2SJ305
	-30	±20	-200				SSM3J09FU		
1	-50	-7	-50				2SJ344		2SJ343
	-60	±20	-200						2SJ168

^{★:} Internal 1-MΩ resistor (RGs)

^{#:} High ESD protection

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

		th		on			
TO-92	(\	V)	2)	2)	Į		
SI MAY AT MAN LZI MAY	Min	Max	Тур.	Max	@Vgs (V)	ton (ns) Typ.	toff (ns) Typ.
(mm)						
	0.7	1.3	4	12	2.5	160	190
	0.7	1.3	4	12	2.5	160	190
	0.6	1.1	5.2	15	1.5	70	125
	0.4	1.0	5	20	1.2	115	300
	0.35	1.0	0.95	1.52	1.5	30	75
	0.35	1.0	0.95	1.52	1.5	30	75
	0.6	1.1	0.85	1.2	2.5	60	70
	0.8	1.5	4	7	2.5	50	180
	0.8	1.5	4.0	7.0	2.5	50	200
	0.5	1.5	1.2	2.0	2.5	60	120
	1.1	1.8	0.8	1.2	4	72	68
	0.9	1.5	22	40	2.5	100	40
	0.8	2.5	20	50	4	110	150
	1.0	2.5	2.2	3.3	4.5	24	26
	1.0	2.5	1.8	3.3	4.5	3	7
	1.0	3.1	2.1	3.3	4.5	3	16
2SK982	2.0	3.5	0.6	1.0	10	14	75
	-0.3	-1.0	2.23	3.60	-1.5	90	200
	-0.6	-1.1	3.2	4.0	-2.5	70	70
	-0.6	-1.1	18	45	-1.5	130	190
	-0.4	-1.0	11	44	-1.2	175	251
	-1.1	-1.7	14	32	-2.5	65	175
	-0.5	-1.5	2.4	4.0	-2.5	60	150
	-1.1	-1.8	3.3	4.2	-4	85	85
	-0.8	-2.5	20	50	-4	150	130
2SJ148	-2.0	-3.5	1.3	2.0	-10	14	100

*: New product

Standard Family (Small-Signal MOSFETs) (Dual Type)

				oman orginar	VIOSEETS) (Duai Type)			ı					
		dsolute num Ra				Package				V			on 2)	
				ESV	ES6	USV	US6	UF6		()	")	(2	2)	
Polarity	VDS (V)	Vgss (V)	ID (mA)	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	91	2.0	20 7 8	2.0	Internal FETs	Min	Max	Тур.	Max	@Vgs (V)
				(mm)	(mm)	(mm)	(mm)	(mm)						
	20	10	100			HN4K03JU ▲1			2SK2034 x 2	0.5	1.5	8	12	2.5
	20	10	100				SSM6N04FU ★ ▲4		SSM3K04FU x 2	0.7	1.3	4	12	2.5
	20	10	100	SSM5N03FE ▲1	SSM6N03FE ▲1				SSM3K03FE x 2	0.7	1.3	4	12	2.5
	20	±10	100	SSM5N16FE ▲1	SSM6N16FE ▲1	SSM5N16FU ▲1	SSM6N16FU ▲1		SSM3K16FU x 2	0.6	1.1	5.2	15	1.5
	20	±10	180		SSM6N35FE ▲1		SSM6N35FU ▲1		SSM3K35MFV x 2	0.4	1.0	5	20	1.2
	20	±10	500		SSM6N36FE ▲1			SSM6N36TU ▲1	SSM3K36TU x 2	0.35	1.0	0.95	1.52	1.5
	20	±10	500				SSM6N43FU ▲1		SSM3K43FS x 2	0.35	1.0	0.95	1.52	1.5
N-ch	20	±12	400			SSM5N05FU ▲1	SSM6N05FU ▲1		SSM3K05FU x 2	0.6	1.1	0.85	1.2	2.5
x 2	30	±20	100	SSM5N15FE ▲1	SSM6N15FE ▲1	SSM5N15FU ▲1	SSM6N15FU ▲1		SSM3K15FU x 2	0.8	1.5	4	7	2.5
	30	±20	100		SSM6N44FE ▲1		SSM6N44FU ▲1		SSM3K44FS x 2	0.8	1.5	4.0	7.0	2.5
	30	±20	400				SSM6N09FU ▲1		SSM3K09FU x 2	1.1	1.8	0.8	1.2	4
	50	10	50				HN1K04FU ▲1		2SK1827 x 2	0.8	2.5	20	50	4
	50	±7	100				SSM6N17FU ▲1		SSM3K17FU x 2	0.9	1.5	22	40	2.5
	60	±20	200				SSM6N7002FU ▲1		SSM3K7002FU x 2	1.0	2.5	2.2	3.3	4.5
	60	±20	200				SSM6N7002AFU ▲1		SSM3K7002AFU x 2	1.0	2.5	1.8	3.3	4.5
	60	±20	200				SSM6N7002BFU ▲1		SSM3K7002BF x 2	1.0	3.1	2.1	3.3	4.5
	-20	±10	-100	SSM5P16FE ▲2	SSM6P16FE ▲2	SSM5P16FU ▲2	SSM6P16FU ▲2		SSM3J16FU x 2	-0.6	-1.1	18	45	-1.5
	-20	±10	-100		SSM6P35FE ▲2		SSM6P35FU ▲2		SSM3J35FU x 2	-0.4	-1.0	11	44	-1.2
P-ch	-20	±8	-330		SSM6P36FE ▲2 *			SSM6P36TU ▲2 *	SSM3J36TU x 2	-0.3	-1.0	2.23	3.6	-1.5
x 2	-20	±12	-200			SSM5P05FU ▲2	SSM6P05FU ▲2		SSM3J05FU x 2	-0.6	-1.1	3.2	4	-2.5
	-30	±20	-200				SSM6P09FU ▲2		SSM3J09FU x 2	-1.1	-1.8	3.3	4.2	-4
	-30	±20	-100	SSM5P15FE ▲2	SSM6P15FE ▲2	SSM5P15FU ▲2	SSM6P15FU ▲2		SSM3J15FU x 2	-1.1	-1.7	14	32	-2.5
	20	10	50				HN1L02FU ▲3		2SK1829	0.5	1.5	20	40	2.5
	-20	-7	-50						+ 2SJ346	-0.5	-1.5	20	40	-2.5
	50	10	50				HN1L03FU ▲3		2SK1827	0.8	2.5	20	50	4
	-20	-7	-50						+ 2SJ346	-0.5	-1.5	20	40	-2.5
	20	±10	100		SSM6L16FE ▲3				SSM3K16FS	0.6	1.1	5.2	15	1.5
	-20	±10	-100						SSM3J16FS	-0.6	-1.1	18	45	-1.5
N-ch	20	±10	180		SSM6L35FE ▲3		SSM6L35FU ▲3		SSM3K35FU	0.4	1.0	5	20	1.2
+ P-ch	-20	±10	-100						+ SSM3J35FU	-0.4	-1.0	11	4.4	-1.2
	20	±10	500		SSM6L36FE ▲3 *			SSM6L36TU ▲3 *	SSM3K36TU	0.35	1.0	0.95	1.52	1.5
	-20	±8	-330						+ SSM3J36TU	-0.3	-1.0	2.23	3.6	-1.5
	20	±12	400				SSM6L05FU ▲3		SSM3K05FU	0.6	1.1	0.85	1.2	2.5
	-20	±12	-200						SSM3J05FU	-0.6	-1.1	3.2	4	-2.5
	30	±20	400				SSM6L09FU ▲3		SSM3K09FU	1.1	1.8	8.0	1.2	4
	-30	±20	-200						SSM3J09FU	-1.1	-1.8	3.3	4.2	-4

^{★:} Internal 1-MΩ resistor (RGS)

♦Internal Connections

Number of Pins	▲ 1	▲2	▲3	4
5-pin ESV/USV	01 02	01 02		
6-pin ES6/US6/UF6	01 02	01 02	01 02	01 1 02

[◆]The internal connection diagrams only show the general configurations of the circuits.

*: New product

[•] The products shown in bold are also manufactured in offshore fabs.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

VDSS ≤ 60 V (Small-Signal MOSFETs/Power MOSFETs) (N-ch MOSFETs, Complementary N-ch/P-ch MOSFETs)

Package	Polarity	Part Number	VDSS	Vgs	lD		RDS(ON)	Max (mΩ)		Ciss	Internal	Internal
Package	Polatity	Part Number	(V)	(V)	(A)	VGS = 1.5 V	Vgs = 1.8 V	VGS = 2.5 V	VGS = 4.0 V	(pF)	FETs	Connections
CST4 Bottom View CST6 CST6 Bottom View CST6 CST7 CST7	N-ch	SSM4K27CT	20	±12	0.5		390	260	205 (@4 V)	174	_	-
		SSM6K211FE *	20	±10	3.2	118	82	59	47	510	_	_
		SSM6K203FE	20	±10	2.8	153	106	76	61	400	_	_
		SSM6K202FE	30	±12	2.3	_	145	101	85	270	_	_
ES6		SSM6K204FE	20	±10	2.0	307	214	164	126	195	_	_
₹ ₽₽₽ ₫		SSM6K208FE	30	±12	1.9	_	296	177	133	123	_	_
91	N-ch	SSM6K25FE	20	±12	0.5	_	395	190	145	268	_	_
	IN-CII	SSM6K24FE	30	±12	0.5	_	I	180	145	245	_	_
1.6 0.55		SSM6K22FE	20	±12	1.4	_		230	170	125	_	_
(mm)		SSM6K210FE	30	±20	1.4	_	ı	_	371	57	_	_
		SSM6K30FE	20	±20	1.2	_		_	420	60	_	_
		SSM6K31FE	20	±20	1.2	_		_	540	36	_	_
		SSM6N42FE	20	±10	1.5	630	455	337	252	95	_	_
		SSM3K123TU	20	±10	4.2	66	43	32	28	1010	_	_
		SSM3K121TU	20	±10	3.2	140	93	63	48	400	_	_
		SSM3K104TU	20	±12	3.0	_	110	74	56	320	_	_
		SSM3K119TU	30	±12	2.5	_	134	90	74	270	_	_
		SSM3K102TU	20	±12	2.6	_	154	99	71	268	_	_
UFM		SSM3K116TU	30	±12	2.2	_		135	100	245	_	_
		SSM3K122TU	20	±10	2.0	304	211	161	123	195	_	_
5.1	N-ch	SSM3K101TU	20	±12	2.2	_	230	138	103	125	_	_
<u> </u>	IN-CII	SSM3K127TU	30	±12	2.0	_	286	167	123	123	_	_
2.0 → 0.7		SSM3K36TU	20	±10	0.5	1.52Ω	1.14 Ω	0.85Ω	0.66Ω (@4.5 V)	46	_	_
(mm)		SSM3K131TU	30	±20	6.0	_		_	41.5 (@4.5 V)	450	_	_
	[SSM3K124TU	30	±20	2.4	_	-	_	120	180	_	_
	[SSM3K105TU	30	±20	2.1	_		_	200	102	_	_
		SSM3K107TU	20	±20	1.5	_	ı	_	410	60	_	_
		SSM3K128TU	30	±20	1.5	_	-	_	360	57	_	_
		SSM3K106TU	20	±20	1.2	_		_	530	36	_	_

Δ: Complementary N-ch/P-ch MOSFETs

*: New product

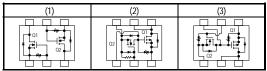
Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

VDSS ≤ 60 V (Small-Signal MOSFETs/Power MOSFETs) (N-ch MOSFETs, Complementary N-ch/P-ch MOSFETs) (Continued)

Package	Polarity	Part Number	VDSS	Vgs	ID		RDS(ON)	Max (mΩ)		Ciss	Internal FETs	Internal
Fackage	Folality	rait Number	(V)	(V)	(A)	VGS = 1.5 V	VGS = 1.8 V	Vgs = 2.5 V	VGS = 4.0 V	(pF)	IIILEIIIAIT LTS	Connections
		SSM6K403TU	20	±10	4.2	66	43	32	28	1050	_	_
		SSM6K18TU	20	±12	4.0	_		54	40	1100	_	_
		SSM6K404TU	20	±10	3.0	147	100	70	55	400	_	_
	N-ch	SSM6K405TU	20	±10	2.0	307	214	164	126	195	_	_
	IN-CII	SSM6K406TU	30	±20	4.4	_	_	_	38.5 (@4.5 V)	490	_	_
		SSM6K34TU	30	±20	3.0	_	-	_	77 (@4.5 V)	470	_	_
		SSM6K32TU	60	±20	2.0	_		_	440	140	_	_
		SSM6K407TU #	60	±20	2.0	_		_	440	150	_	_
		SSM6N39TU	20	±10	1.6	247	190	139	119	260	_	(1)
		SSM6N29TU	20	±12	0.8	_	235	178	143	268	SSM3K102TU x 2	(1)
	N-ch x 2	SSM6N25TU	20	±12	0.5	_	395	190	145	268	SSM6K25FE x 2	(1)
	IN-CII X Z	SSM6N24TU	30	±12	0.5	_	_	180	145	245	SSM6K24FE x 2	(1)
		SSM6N36TU	20	±10	0.5	1520	1140	850	660 (@4.5 V)	46	SSM3K36TU x 2	(1)
		SSM6N40TU	30	±20	1.6	_		_	182	180	_	(1)
UF6		SSM6L39TU △	20	±10	1.6	247	190	139	119	265	SSM6N39TU	(1)
₹₽₽₽ ₽		35IVI0E3710 Z	-20	±8	-1.5	_	430	294	213	250	+ SSM6P39TU	(1)
1.7		SSM6L13TU △	20	±12	0.8	_	235	178	143	268	SSM3K102TU	(1)
		33W0E1310 —	-20	±8	-0.8	_	460	306	234	250	+ SSM3J108TU	(1)
2.0 → 0.7 ←		SSM6L10TU △	20	±12	0.5	_	395	190	145	268	SSM6K25FE	(1)
(mm)		33W0E1010 A	-20	±8	-0.5	_	980	330	230	250	+ SSM6J26FE	(1)
,	N-ch + P-ch	SSM6L11TU Δ	20	±12	0.5	_	395	190	145	268	SSM6K25FE	(1)
	IN-CII + I -CII	35IVIOE1110 A	-20	±12	-0.5	_	_	430	260	218	+ SSM6J25FE	(1)
		SSM6L12TU △	30	±12	0.5	_		180	145	245	SSM6K24FE	(1)
		33W0L12T0 A	-20	±12	-0.5	_		430	260	218	+ SSM6J25FE	(1)
		SSM6L36TU △	20	±10	0.5	1520	1140	850	660 (@4.5 V)	46	SSM3K36TU	(1)
		33W0L3010 A	-20	±8	-0.33	3600	2700	1600 (@2.8 V)	1310 (@4.5 V)	43	+ SSM3J36TU	(1)
		SSM6L40TU \triangle	30	±20	1.6	_		_	182	180	SSM6N40TU	(1)
		33W0L4010 A	-30	±20	-1.4	ı	I	_	403	120	+ SSM6P40TU	(1)
		SSM6E03TU △	20	±10	0.1	15000	-	4000	3000	9.3	SSM3K16FU	(2)
		JOINIOLUSTO A	-20	±8	-1.8		320	186	130	335	SSM3J109TU	(2)
	N-ch + P-ch	SSM6E02TU △	20	±10	0.1	15 Ω	_	4.0 Ω	3.0 Ω	9.3	SSM3K16FU	(3)
	N-ch + P-ch	SSIVIOEUZIU A	-20	±8	-1.8	364	204	136	_	568	_	(3)
		CCM4F01TII ^	20	±10	0.05	_		10000	_	11	SSM3K04FE	(3)
		SSM6E01TU △	-12	±12	-1			240	160	310	_	(3)

 $[\]Delta \hbox{: Complementary N-ch/P-ch MOSFETs}$

♦Internal Connections



[◆]The internal connection diagrams only show the general configurations of the circuits.

^{#:} High ESD protection

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

VDSS ≤ 60 V (Small-Signal MOSFETs/Power MOSFETs) (N-ch MOSFETs, Complementary N-ch/P-ch MOSFETs) (Continued)

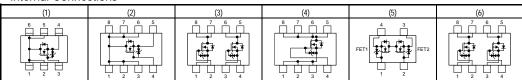
			V _{DSS}	V _{GSS}		PD				RDS(ON) Max (mΩ)			Ciss	Qg (nC)	Internal
Package	Polarity	Part Number	(V)	(V)	ID (A)	(W)	VGS = 1.5 V	VGS = 1.8 V	VGS = 2.0 V	VGS = 2.5 V	Vgs = 4 V	VGS = 4.5 V	Vgs = 10 V	(pF)	(typ.)	Connections
US6 ↑₽₽₽ ८४		SSM6K08FU	20	±12	1.6	0.3			210	140	105		_	306	_	_
¥888 5	N-ch	SSM6K06FU	20	±12	1.1	0.3	_	_	_	210	160	_	_	125	_	_
< 20 		SSM6K07FU	30	±20	1.5	0.3	-	_	_	_	220	_	120	102	_	_
		SSM3K310T	20	±10	5.0	0.7	66	43	_	32	28			1120	14.8	_
		SSM3K309T	20	±12	4.7	0.7	_	47	_	35	31	_	_	1020	_	_
TSM		SSM3K301T	20	±12	3.5	0.7	_	110	_	74	56	_	_	320	4.8	_
₹ □□		SSM3K01T	30	±10	3.2	1.25	_	_	_	150	120	_	_	152	_	_
788		SSM3K02T	30	±10	2.5	1.25	_	_	_	250	200	_	_	115		_
	N-ch	SSM3K316T	30	±12	4.0	1.25	_	131	_	87	_	65	53	270	4.3	
2.9 → 0.7		SSM3K315T SSM3K14T	30 30	±20	6.0	1.25		_	_	_		41.5	27.6 39	450	10.1	
(mm)		SSM3K141 SSM3K320T	30	±20 ±20	4.0	1.25	_				67	57 77	50	460 190	5 4.6	
()		SSM3K303T	30	±20	2.9	0.7	_			_	120		83	180	3.3	_
		SSM3K3031 *	60	±20	2.5	0.7	_	_			120	145	107	235	7	
VS-8	N-ch Single	TPCF8002	30	±20	6	2.5	_	_	_	_	_	31	23	_	12	(2)
61.0	N-ch Dual	TPCF8201	20	±12	3	1.35		_	100	66	_	49	ı		7.5	(3)
2.9 > 0.8 (mm)	N-ch + P-ch	TPCF8402 △	30/–30	±20/±20	4/-3.2	1.35	_	_	_	_	77/105	_	50/72	_	10/14	(6)
		TPC6004	20	±12	6	2.2	_	_	37	32	_	24		_	17	(1)
		TPC6007-H	30	±20	5	2.2				_	_	79	54	_	4.6	(1)
	N-ch Single	TPC6011	30	±20	6	2.2	_		_	_	_	32	21	_	14	(1)
		TPC6005	30	±12	6	2.2	_	_	41	35	_	28	_	_	19	(1)
		TPC6006-H	40	±20	3.9	2.2	_	_	_	_	_	100	75	_	4.4	(1)
		TPCP8006	20	±12	9.1	1.68	_	_	_	13.7	_	10	_	_	22	(4)
		TPCP8001-H	30	±20	7.2	1.68	_	_	_	_	_	25	16	_	11	(4)
VS-6	N-ch Single	TPCP8004	30	±20	8.3	1.68	_	_	_	_	_	14	8.5	_	26	(4)
		TPCP8005-H	30	±20	11	1.68	_	_	_	_	_	15.7	12.9	_	20	(4)
		TPCP8201	30	±20	4.2	1.48	_	_	_		_	77	50	_	10	(3)
₹ 2.9 → 0.75	N-ch Dual	TPCP8202	30	±12	5.5	1.48	_	_	_	39	_	23		_	28	(3)
(mm)		TPCP8203	40	±20	4.7	1.48	_	_		_	_	60	40	_	16	(3)
		TPCP8402 △	30/-30	±20/±20	4.2/-3.4	1.48	_	_	_	_	_	77/105	50/72	_	10/14	(6)
	N-ch + P-ch	TPCP8404 △	30/-30	±20/±20	4/-4	1.48			_	-	_	100/100	50/50	-	4.6/13	(6)
		TPCP8403 △	40/-40	±20/±20	4.7/-3.4	1.48	_	_	_	_	_	60/105	40/70	_	16/15	(6)
STP2	N-ch Dual	TPCT4203	20	±12	6	1.47		_		49	32	31	_	_	12	(5)
1.6 0.6 (mm)	. v on budi	TPCT4204	30	±12	6	1.47	_	_	_	52	39	38	_	_	12	(5)

△: Complementary N-ch/P-ch MOSFETs

• The products shown in bold are also manufactured in offshore fabs.

• Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

♦Internal Connections



Note: Some MOSFETs do not have a Zener diode between gate and source.

◆The internal connection diagrams only show the general configurations of the circuits.

*: New product

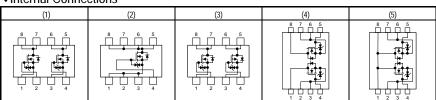
VDSS ≤ 60 V (Small-Signal MOSFETs/Power MOSFETs) (N-ch MOSFETs, Complementary N-ch/P-ch MOSFETs) (Continued)

Dookogo	Doloritu	Dort Number	V=== (\)	V 00	I= (A)	D- 040		Ri	os(on) Max (Ω)		Qg (nC)	Internal
Package	Polarity	Part Number	VDSS (V)	V _{GSS} (V)	I _D (A)	P _D (W)	Vgs = 2.0 V	VGS = 2.5 V	VGS = 4 V	Vgs = 4.5 V	Vgs = 10 V	(typ.)	Connections
		TPCS8209	20	±12	5	1.1	_	0.04	0.03	_	_	15	(4)
TSSOP-8		TPCS8210 ©	20	±12	5	1.1	_	0.04	0.03	_	_	15	(5)
19901		TPCS8204	20	±12	6	1.1		0.022	0.017		_	22	(4)
22		TPCS8208 ©	20	±12	6	1.1	_	0.022	0.017			22	(5)
	N-ch Dual	TPCS8211	20	±12	6	1.1		0.022	0.017			20	(4)
▼ 10 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0		TPCS8212 ©	20	±12	6	1.1		0.029	0.024			20	(5)
3.3 max 0.9 (mm)		TPCS8213		±12					U.U24 —	_		49	
(11111)		TPCS8214	20 30		6	1.1	0.018	0.013		0.012	_		(4)
				±12	6	1.1	_	0.0185	0.0135	0.013	_	42	(4)
TSSOP Advance		TPCM8001-H	30	±20	20	30	_	_	_	0.014	0.0095	19	(2)
3.65		TPCM8003-H	30	±20	21	30	_	_	_	0.0157	0.0129	21	(2)
V .	N-ch Single	TPCM8004-H	30	±20	24	30	_	_	_	0.0134	0.0110	21	(2)
3.5		TPCM8006	30	±20	25	30	_	_	_	0.0135	0.007	26	(2)
(mm)		TPCM8002-H	30	±20	30	30	_	_	_	0.0082	0.0062	34	(2)
		TPC8014	30	±20	11	1.9	_	_	0.022	_	0.014	39	(2)
		TPC8021-H	30	±20	11	1.9	_	_	_	0.025	0.017	11	(2)
		TPC8025	30	±20	11	1.9	_	_	_	0.0145	0.009	26	(2)
		TPC8030	30	±25	11	1.9	_	_	_	0.017	0.009	24	(2)
		TPC8031-H	30	±20	11	1.9	_	_	_	0.0161	0.0133	21	(2)
		TPC8037-H	30	±20	12	1.9	_	_	_	0.0139	0.0114	21	(2)
		TPC8038-H	30	±20	12	1.9	_	_	_	0.0139	0.0114	21	(2)
		TPC8020-H	30	±20	13	1.9	_	_	_	0.013	0.009	23	(2)
		TPC8024-H	30	±20	13	1.9	_	_	_	0.013	0.009	23	(2)
		TPC8026	30	±20	13	1.9	_	_	_	0.01	0.0066	42	(2)
		TPC8040-H	30	±20	13	1.9	_	_	_	0.0111	0.0097	24	(2)
		TPC8041	30	±20	13	1.9				0.0135	0.007	27	(2)
	N-ch Single	TPC8017-H	30	±20	15	1.9	_		_	0.0095	0.0066	25	(2)
000.0		TPC8032-H TPC8033-H	30	±20	15	1.9				0.0086	0.0065	33	(2)
SOP-8		TPC8039-H	30 30	±20 ±20	17 17	1.9 1.9				0.0072 0.0069	0.0053 0.0060	42 36	(2)
		TPC8018-H	30	±20	18	1.9				0.0069	0.0046	38	(2)
0.9		TPC8027	30	±20	18	1.9		_		0.0062	0.0046	113	(2)
**		TPC8028	30	±20	18	1.9				0.0033	0.0027	45	(2)
5.5 max > 1.6 (mm)		TPC8029	30	±20 ±20	18	1.9				0.008	0.0043	49	(2)
(mm)		TPC8035-H	30	±20	18	1.9				0.0036	0.0030	82	(2)
		TPC8036-H	30	±20	18	1.9	_	_	_	0.0050	0.0032	49	(2)
		TPC8042	30	±20	18	1.9	_	_	_	0.0065	0.0034	56	(2)
		TPC8034-H	30	±20	20	1.9	_	_	_	0.0045	0.0035	68	(2)
		TPC8022-H	40	±20	7.5	1.9	_	_	_	0.035	0.027	11	(2)
		TPC8208	20	±12	5	1.5	_	0.07	0.05	_	_	9.5	(1)
		TPC8207	20	±12	6	1.5	_	0.03	0.02	_	_	22	(1)
		TPC8211	30	±20	5.5	1.5	_	_	_	0.044	0.036	25	(1)
	N-ch Dual	TPC8212-H	30	±20	6	1.5	_	_	_	0.027	0.021	16	(1)
		TPC8216-H	30	±20	6.4	1.5	_	_	_	0.023	0.020	14	(1)
		TPC8210	30	±20	8	1.5	_	_	_	0.02	0.015	75	(1)
		TPC8213-H	60	±20	5	1.5	_	_	_	0.056	0.050	6	(1)
	N-ch + P-ch	TPC8405 △	30/-30	±20/±20	6/-4.5	1.5	_	_	_	0.033/0.042	0.026/0.033	27/40	(3)
	IN-CII T F *CII	TPC8406-H △	40/-40	±20/±20	6.5/-6.5	1.5	_	_	_	0.035/0.037	0.027/0.030	11/27	(3)
O: Common-drain type													

©: Common-drain type

- Δ: Complementary N-ch/P-ch MOSFETs
- The products shown in bold are also manufactured in offshore fabs.
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♦Internal Connections



Note: Some MOSFETs do not have a Zener diode between gate and source.

[◆]The internal connection diagrams only show the general configurations of the circuits.

Package	Polarity	Part Number	V _{DSS} (V)	V _{GSS} (V)	I _D (A)	P _D (W)		Ro	os(on) Max (Ω)		Qg (nC)	Internal
Package	Polatity	Part Number	VDSS (V)	VGSS (V)	ID (A)	PD (W)	Vgs = 2.0 V	Vgs = 2.5 V	VGS = 4 V	Vgs = 4.5 V	VGS = 10 V	(typ.)	Connections
		TPCA8011-H	20	±12	40	45	_	0.0075	_	0.0035	_	32	(1)
		TPCA8023-H	30	±20	21	30	_	_	_	0.0157	0.0129	21	(1)
		TPCA8040-H	30	±20	23	30	_	_	_	0.0108	0.0094	23	(1)
		TPCA8030-H	30	±20	24	30	_	_	_	0.0134	0.0110	21	(1)
		TPCA8031-H	30	±20	24	30	_	_	_	0.0134	0.0110	21	(1)
		TPCA8005-H	30	±20	27	45	_	_	_	0.013	0.009	24	(1)
		TPCA8021-H	30	±20	27	45	_	_		0.013	0.009	23	(1)
		TPCA8018-H	30	±20	30	45	_	_		0.0082	0.0062	34	(1)
		TPCA8039-H	30	±20	34	45	_	_		0.0066	0.0057	36	(1)
SOP Advance		TPCA8003-H	30	±20	35	45	_	_	_	0.0095	0.0066	25	(1)
1 1		TPCA8024	30	±20	35	45	_	_	_	0.0078	0.0043	45	(1)
6.0	N ch Cingle	TPCA8036-H	30	±20	38	45	_	_	_	0.0048	0.0042	50	(1)
\\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\	N-ch Single	TPCA8004-H	30	±20	40	45	_	_		0.0062	0.0046	37	(1)
5.0 5.3		TPCA8012-H	30	±20	40	45	_	_	_	0.0068	0.0049	42	(1)
(mm)	1	TPCA8025	30	±20	40	45	_	_	_	0.006	0.0035	49	(1)
(,	1	TPCA8019-H	30	±20	45	45	_	_	_	0.0041	0.0031	66	(1)
	1	TPCA8026	30	±20	45	45	_	_		0.0045	0.0022	113	(1)
	1	TPCA8042	30	±20	45	45	_	_	_	0.0057	0.0033	56	(1)
	1	TPCA8028-H	30	±20	50	45	_	_		0.0032	0.0028	88	(1)
	1	TPCA8020-H	40	±20	7.5	30	_	_	_	0.035	0.027	11	(1)
	1	TPCA8014-H	40	±20	30	45	_	_	_	0.014	0.009	22	(1)
	1	TPCA8027-H	40	±20	30	45	_	_	_	_	0.01	23	(1)
	1	TPCA8015-H	40	±20	35	45	_	_	_	0.0079	0.0054	37	(1)
	1	TPCA8016-H	60	±20	25	45	_	_	_	0.026	0.021	22	(1)
PW-Mini	N-ch Single	2SK2615	60	_	2	1.5	_	_	0.44	_	0.3	6	
4.6 > 1.6 (mm)	N-CII SIIIGIE	2SK3658	60	_	2	1.5	_	_	0.44	_	0.3	5.0	
LSTM 5.1	N. ale Circul	2SK2989	50	_	5	0.9	_	_	0.33	_	0.15	6.5	
(mm)	N-ch Single •	2SK2961	60	_	2	0.9	_	_	0.38	_	0.27	5.8	

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◆Internal Connections



Note: Some MOSFETs do not have a Zener diode between gate and source.

◆The internal connection diagrams only show the general configurations of the circuits.

VDSS ≤ 60 V (Small-Signal MOSFETs/Power MOSFETs) (N-ch MOSFETs, Complementary N-ch/P-ch MOSFETs) (Continued)

Package	Polarity	Part Number	V _{DSS} (V)	I _D (A)	P _D (W)		Rı	s(on) Max (9	Ω)		Qq (nC)	Internal
	Fulanty	Fait Number	VDSS (V)	ID (A)	FD (W)	VGS = 2.0 V	VGS = 2.5 V	VGS = 4 V	Vgs = 4.5 V	VGS = 10 V	(typ.)	Connections
TPS 80 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	N-ch Single	2SK2229	60	5	1.3	_	_	0.3	_	0.16	12	
PW-Mold	N-ch Single	2SK2493	16	5	20	_	0.12	0.1	_	_	23	
(mm)	iv-un single	2SK4033	60	5	20	_	_	0.15	_	0.1	15	
New PW-Mold2	N-ch Single	2SK4017	60	5	20	_	_	0.15	_	0.1	15	
DP DP 0.88	N ale Circula	2SK2614	50	20	40	_	_	0.08	_	0.046	25	
(mm)	N-ch Single	2SK2782	60	20	40	_	_	0.09	_	0.055	25	
D-PAK		TK40P03M1	30	40	40	_	_	_	0.0144	0.0108	9.4	
\$\begin{align*} \text{\$\frac{1}{2} \\ \text{\$\frac{1} \\ \$\f	N oh Cinal-	TK50P03M1	30	50	60	_	_		0.0098	0.0075	13.3	
↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓	N-ch Single	TK40P04M1	40	40	60	_	_		0.0134	0.0103	29	
(mm)		TK50P04M1	40	50	60	_	_	ı	0.0102	0.0087	38	
TFP		2SK3843	40	75	125	_	_		0.008	0.0035	210	
		TK80X04K3	40	80	125	_	_	_	_	0.0035	100	
107	N-ch Single	2SK3440	60	50	125	_	_	_	_	0.008	55	
9.2		2SK3842	60	75	125	_	_	_	_	0.0058	196	
(mm)		2SK4034	60	75	125	_	_	_	0.01	0.0058	196	
TO-220 SM(W)		TK100F04K3	40	100	200	_	_		_	0.003	102	
13.0	N ob C:l-	TK150F04K3	40	150	300	_	_		_	0.0021	166	
10.0	N-ch Single	TK100F06K3	60	100	200	_	_		_	0.005	98	
10.0 3.6 (mm)		TK130F06K3	60	130	300	_	_	_	_	0.0034	170	

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

							Ri	os(on) Max (Ω)		Qg (nC)	Internal
Package	Polarity	Part Number	V _{DSS} (V)	I _D (A)	P _D (W)	Vgs = 2.0 V			VGS = 4.5 V	Vgs = 10 V	(typ.)	Connections
TO-220FL		2SK3847	40	32	30	_	_	_	0.028	0.018	40	
12.6 10.6 10.6 10.6 10.6 10.6 10.6 10.6 10		2SK3051	50	45	40	_	_	_	_	0.03	36	
↓	N-ch Single	2SK2311	60	25	40	_	_	0.08	_	0.046	38	
13.6		2SK2266	60	45	65	_	_	0.055	_	0.03	60	
10.3 4.8 (mm)		2SK2376	60	45	100	_	_	0.025	_	0.017	110	
TO-220NIS		2SK3846	40	26	25	_	_	_	0.028	0.018	40	
10.0		2SK2507	50	25	30	_	_	0.08	_	0.046	25	
↑ .O.		2SK2886	50	45	40	_	_	0.036	_	0.02	66	
5.6	N-ch Single	2SK2232	60	25	35	_	_	0.08	_	0.046	38	
		2SK3662	60	35	35	_	_	0.019	_	0.0125	91	
*\ <u>^ </u>		2SK2385	60	36	40	_	_	0.055	_	0.03	60	
(mm)		2SK3844	60	45	45	_	_	_	_	0.0058	196	
TO-220SIS	N-ch Single	TK30A06J3A	60	30	25	_	_	_	0.035	0.026	36	
(mm)		TK70A06J1	60	70	45	_	_	_	0.0076	0.0064	87	
TO-220(W)	N-ch Single	TK70D06J1	60	70	140	_	_	_	0.0076	0.0064	87	
		2SK3506	30	45	100	_	_	_	_	0.02	39	
		TK70J04J3	40	70	150	_	_	_	0.0083	0.0038	210	
ĺ		2SK2550	50	45	100	_	_		_	0.03	36	
TO-3P(N)		2SK2744	50	45	125	_	_	_	_	0.02	68	
15.9		2SK2551	50	50	150	_	_	_	_	0.011	130	
008		2SK2745	50	50	150			0.016		0.0095	130	
X Y U U U	N-ch Single	2SK3129	50	60	150	_	_	_	_	0.007	135	
33		2SK2233	60	45	100			0.055		0.03	60	
↓ _		2SK2398	60	45	100	_	_	_	_	0.03	60	
(mm)		2SK2173	60	50	125			0.025	_	0.017	110	
		2SK2445	60	50	125	_				0.018	110	
		2SK2313 2SK3845	60 60	60 70	150 125			0.015	_	0.011 0.0058	170 196	
TO-3P(L)	N-ch Single	2SK2267	60	60	150	_	_	0.015	_	0.011	170	
The products shown in hold are												

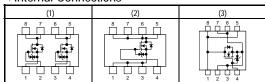
<sup>The products shown in bold are also manufactured in offshore fabs.
Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.</sup>

60 V < VDSS \le 250 V (Power MOSFETs) (N-ch MOSFETs)

	,	i wooi E13)	(031 L1	-,				RDS	(ON) Max	(Ω)			Qg (nC)	Internal
Package	Polarity	Part Number	VDSS (V)	VGSS (V)	ID (A)	Pp (W)	Vgs	Vgs	Vgs	Vgs	Vgs	Vgs	Vgs	(typ.)	Connections
DC 0							= 1.8 V	= 2.0 V	= 2.5 V	= 4 V	= 4.5 V	= 7 V	= 10 V	.51 /	
PS-8 (mm)	N-ch Single	TPCP8003-H	100	±20	2.2	1.68	_	_	_	_	0.19	_	0.18	7.5	(2)
TSSOP-8		TPCS8009-H	150	±20	2.1	1.5	_	_	_	_	_	_	0.35	10	(2)
		TPCS8004	200	±20	1.3	1.5	_	_	_	_	_	_	8.0	12	(3)
644	N-ch Single	TPCS8007-H	200	±20	1.9	1.5	_	_	_	_	_	_	0.45	10	(2)
3.3 max >0.9		TPCS8006	250	±20	1.1	1.5	_	_	_	_	_	_	1.0	11	(2)
(mm)		TPCS8008-H	250	±20	1.7	1.5		_	_	_	_	_	0.58	10	(2)
SOP-8	N-ch Single	TPC8012-H	200	±20	1.8	1.9		_	_	_	_	_	0.4	11	(2)
5.5 max 1.6 (mm)	N-ch Dual	TPC8214-H	100	±20	2.2	1.5	l	_	_	l	0.19	_	0.180	7.5	(1)
SOP Advance		TPCA8006-H	100	±20	18	45		_	_	_	_	_	0.067	12	(2)
5.0		TPCA8022-H	100	±20	22	45	_	_	_	_	_	_	0.026	38	(2)
	N-ch Single	TPCA8009-H	150	±20	7	45		_	_	_	_	_	0.35	10	(2)
5.0 0.95		TPCA8010-H	200	±20	5.5	45	_	_	_	_	_	_	0.45	10	(2)
(mm)		TPCA8008-H	250	±20	4	45	_	_	_	_	_	_	0.58	10	(2)
PW-Mini	N-ch Single	2SK2963	100	_	1	1.5	_	_	_	0.95	_	_	0.7	6.3	
4.6 > 1.6 (mm)	N-cii Singic	2SK2992	200	_	1	1.5	_	_	_	_	_	_	3.5	3	
LSTM 5.1	N-ch Single	2SK2962	100	_	1	0.9	_	_	_	0.95	_	_	0.7	6.3	
(mm)	N-ch Single	2SK3670	150	_	0.67	0.9	_	_	_	1.7	_	_	_	4.6	
TPS OU		2SK2200	100	_	3	1.3		_	_	0.45	_	_	0.35	13.5	
13.5	N-ch Single	2SK2400	100	_	5	1.3	_	_	_	0.3	_	_	0.23	22	
(mm)		2SK2835	200	_	5	1.3	_	_	_	_	_	_	0.8	10	

- The products shown in bold are also manufactured in offshore fabs.
- Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

♦Internal Connections



Note: Some MOSFETs do not have a Zener diode between gate and source.

 $[\]bullet$ The internal connection diagrams only show the general configurations of the circuits.

								RD	s(on) Max	(Ω)			0 (0)	
Package	Polarity	Part Number	VDSS (V)	ID (A)	Pp (W)	Vgs	Vgs	Vgs	VGS	VGS	Vgs	Vgs	Qg (nC) (typ.)	Internal Connections
						= 1.8 V	= 2.0 V	= 2.5 V	= 4 V	= 4.5 V	= 7 V	= 10 V	(typ.)	Connections
PW-Mold		2SK2201	100	3	20	_	_	_	0.45	_	_	0.35	13.5	
6.8 ➤		2SK2399	100	5	20	_			0.3	_		0.23	22	
272		2SK3669	100	10	20	_				_		0.125	8.0	
X *\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	N-ch Single	2SK3205	150	5	20				0.75			0.5	12	
02		2SK2162	180	1 -	20							5		
1		2SK2920 2SK3462	200	5	20	_				_		0.8	10	
(mm)	-	2SK3462 2SK3342	250	3 4.5	20 20	_	_	_		_		1.7	12 10	
New PW-Mold		23N3342	250	4.5	20	_		_		_		1	10	
New PW-100U	N-ch Single	TK05N10J1	100	5	20		l	l	l		l	0.225	6.6	
		2SK4018	100	3	20	_	_	_	0.45	_	_	0.35	13.5	
New PW-Mold2		2SK4019	100	5	20	_	_	_	0.3	_	_	0.23	22	
20 20 20 20 20 20 20 20 20 20 20 20 20 2	N-ch Single	2SK4020	200	5	20	_	_	_	_	_	_	0.8	10	
		2SK4022	250	3	20	_	_	_	_	_	_	1.7	12	
(mm)		2SK4021	250	4.5	20	_	_	_	_	_	_	1	10	
TFP		2SK3387	150	18	100	_	_	_	_	_	_	0.12	57	
TATE		2SK3443	150	30	125	_	_	_	_	_	_	0.055	45	
107	N -b Cil-	TK50X15J1	150	50	125	_	_	_	_	_	_	0.03	75	
	N-ch Single	2SK3444	200	25	125	_	_	_	_	_	_	0.082	44	
9.2 >> 3.0	i i	2SK3388	250	20	125	_	_	_	_	_	_	0.105	100	
(mm)	i i	2SK3445	250	20	125	_	_	_	_	_	_	0.105	45	
TO-220FL		2SK2789	100	27	60	_	_	_	0.13	_	_	0.085	50	
126 (106		2SK2401	200	15	75	_	_	_	_	_	_	0.18	40	
▼	N-ch Single	2SK3625	200	25	125	_	_	_	_	_	_	0.082	44	
13.6		2SK2598	250	13	60	_	_	_	_	_	_	0.25	40	
10.3 × 4.8 (mm)		2SK2993	250	20	100	_	_	_	_	_	_	0.105	100	
TO-220AB	N-ch Single	2SK2314	100	27	75	_	_	_	0.13	_	_	0.085	50	
(mm)		2SK2914	250	7.5	20	_	_	_	_	_	_	0.5	20	
		2SK2391	100	20	35	_	_	_	0.13	_	_	0.085	50	
TO-220NIS	[2SK2882	150	18	45	_	_	_	0.18	_	_	0.12	57	
10-220NIS		2SK2013	180	1	25	_				_		5	_	
1		2SK2381	200	5	25	_	_	_		_		0.8	10	
2.6	N-ch Single	2SK2350	200	8.5	30							0.4	17	
		2SK2965	200	11	35	_		_		_		0.26	30	
		2SK2382 2SK2417	200	15	45	_				_		0.18	40	
(mm)	 	2SK2417 2SK2508	250	7.5	30 45	_				_	_	0.5	20	
	 	2SK2506 2SK3994	250 250	13 20	45 45							0.25 0.105	40 45	
The products chown in hold are	<u>. </u>	2JNJ774	200	20	40		_			_		0.100	40	

- The products shown in bold are also manufactured in offshore fabs.
 Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

 $60 \text{ V} < \text{VDSS} \le 250 \text{ V} \text{ (Power MOSFETs)}$ (N-ch MOSFETs) (Continued)

00 V < VD33 \(\text{230}	(, , , ,		(6) (6	Untillidet	.,	Ro	s(on) Max (Ω)			0 (0)	
Package	Polarity	Part Number	Vdss (V)	Id (A)	PD (W)	VGS = 1.8 V	VGS = 2.0 V	VGS = 2.5 V	VGS = 4 V	VGS = 4.5 V	Vgs = 7 V	VGS = 10 V	Qg (nC) (typ.)	Internal Connections
		TK40A08K3	75	40	35	1		_	_	I	_	0.009	80	
TO-220SIS		TK60A08J1	75	60	45	1	-	_	_	0.0093	_	0.0078	86	
10.0		TK80A08K3	75	80	40		_	_	_	-	_	0.0045	175	
100	N-ch Single	TK25A10K3	100	25	25	_	_	_	_	_	_	40	34	
13.0		TK40A10J1	100	40	40	ı	ı	_	_	0.017	_	0.015	76	
(mm)		TK40A10K3	100	40	40	ı	l	_	_	l	_	0.015	85	
		TK55A10J1	100	55	45		_	_	_	0.012	_	0.0105	110	
TO-220(W)		TK60D08J1	75	60	140	_	_	_	_	0.0093	_	0.0078	86	
15.0	N-ch Single	TK80D08K3	75	80	100		_	_	_		_	0.0045	175	
12.8	N-cii Siligie	TK40D10J1	100	40	100		_	_	_	0.017	_	0.015	76	
<u>↓</u>		TK55D10J1	100	55	140		_	_	_	0.012	_	0.0105	110	
TO-3P(N)		2SK3940	75	70	150	_	_	_	_	_	_	0.007	200	
15.9		2SK1381	100	50	150		_	_	0.046		_	0.032	88	
000	N oh Cinalo	2SK1529	180	10	120		_	_	_		_	0.83	_	
* * * * * * * * * * * * * * * * * * * *	N-ch Single	2SK3497	180	10	130	_	_	_	_	_	0.15	_	36	
20.5	Ť	2SK3176	200	30	150	_	_	_	_	_	_	0.052	125	
(mm)		2SK2967	250	30	150	_	_	_	_	_	_	0.068	132	
TO-3P(N)IS	N-ch Single	2SK2467	180	9	80	_	_	_	_	_	_	0.83	_	
(ww)	N-GII SIIIIYIE	2SK2995	250	30	90	_	_	_	_	_	_	0.068	132	
TO-3P(L)	M ch Single	2SK1382	100	60	200	_	_	_	0.029	_	_	0.02	176	
(mm)	N-ch Single +	2SK1530	200	12	150	_	_	_	_	_	_	0.625	_	
(mm) The products shown in hold are		and in effet on felo												

The products shown in bold are also manufactured in offshore fabs.

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

250 V < VDSS \le 700 V (Power MOSFETs) (N-ch MOSFETs)

Package	Polarity	Part Number	VDSS (V)	ID (A)	Pp (W)	Rds(on) Max (Ω)	Qg (nC)	Internal
PW-Mini	,					V _{GS} = 10 V	(typ.)	Connections
7 9 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	N-ch Single	2SK3471	500	0.5	1.5	18	3.8	
LSTM 5.1	N-ch Single	2SK2998	500	0.5	0.9	18	3.8	
TPS		2SK3374	450	1	1.3	4.6	5	
₽	N 1 6' 1	2SK3302	500	0.5	1.3	18	3.8	
13.5	N-ch Single	2SK2599	500	2	1.3	3.2	9	
<u>↓</u>		2SK2846	600	2	1.3	5.0	9	
PW-Mold		2SK3498	400	1	20	5.5	5.7	
22.2		2SK3472	450	1	20	4.6	5	
** **********************************	N-ch Single	2SK3373	500	2	20	3.2	9	
120		2SK3371	600	1	20	9.0	9	
(mm)		2SK2865	600	2	20	5.0	9	
New PW-Mold	N-ch Single	2SK4103	500	5	40	1.5	16	
New DW Meld		2SK4023	450	1	20	4.6	5	
New PW-Mold2		2SK4026	600	1	20	9.0	9	
0.7 8.8 0.0 0.0 0.0 0.0 0.0 0.0 0.0 0.0 0.0	N-ch Single	2SK4002	600	2	20	5.0	9	
(mm)		TK2Q60D	600	2	60	4.3	7	
(IIIII)		2SK4003	600	3	20	2.2	15	

[•] The products shown in bold are also manufactured in offshore fabs.

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

 $250 \text{ V} < \text{VDSS} \le 700 \text{ V}$ (Power MOSFETs) (N-ch MOSFETs) (Continued)

Package	Polarity	Part Number	VDSS (V)	ID (A)	Pp (W)	Rds(on) Max (Ω)	Qg (nC)	Internal
						V _{GS} = 10 V	(typ.)	Connections
DP 6.8 72 75 75 75 75 75 75 75 75 75 75 75 75 75	N-ch Single	2SK3863	500	5	35	1.5	16	
TFP	N-ch Single	2SK3499	400	10	80	0.55	34	
		2SK3544	450	13	100	0.4	34	
		2SK3466	500	5	50	1.5	17	
		2SK3538	500	8	65	0.85	30	
		2SK3398	500	12	100	0.52	45	
		TK12X53D 2SK3438	525 600	12 10	150 80	0.58 1.0	25 28	-
9.2 3.0 (mm)		TK12X60U	600	10	100	0.4	14	
()		TK15X60U	600	15	125	0.3	17	
	-	TK20X60U	600	20	150	0.19	27	
		2SK2838	400	5.5	40	1.2	17	
TO-220FL	-	2SK2949	400	10	80	0.55	34	
10.3	N-ch Single	2SK3309	450	10	65	0.65	23	
9.1 10.6		2SK3403	450	13	100	0.4	34	
(mm)		2SK2991	500	5	50	1.5	17	
		2SK3417 #	500	5	50	1.8	17	
		2SK2776	500	8	65	0.85	30	
TO-220SM		2SK3068	500	12	100	0.52	45	
		2SK2777	600	6	65	1.25	30	
9.1		2SK3312	600	6	65	1.25	22	
10.3 × 4.8 (mm)		2SK2889	600	10	100	0.75	45	
		2SK3399	600	10	100	0.75	35	
		2SK3437	600	10	80	1.0	28	
TO-220AB	N-ch Single	2SK2841	400	10	80	0.55	34	
157		2SK2542	500	8	80	0.85	30	
92, 92, (mm)		2SK3085	600	3.5	75	2.2	20	
		2SK2866	600	10	125	0.75	45	
TO-220NIS	N-ch Single	2SK2679	400	5.5	35	1.2	17	
(mm)		2SK2952	400	8.5	40	0.55	34	
		2SK3310	450	10	40	0.65	23	
		2SK3743	450	13	40	0.4	34	
		2SK3313 #	500	12	40	0.62	45	
		2SK3265	700	10	45	1.0	53	

^{#:} HSD type

[•] The products shown in bold are also manufactured in offshore fabs.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Package	Polarity	Part Number	V _{DSS} (V)	I _D (A)	P _D (W)	Rds(on) Max (Ω)	Qg (nC)	Internal
гаскауе	Puldfilly	r art indilibei	VDSS (V)	ID (A)	PD (VV)	VGS = 10 V	(typ.)	Connections
		2SK3757	450	2	30	2.45	9	
		2SK3766	450	2	30	2.45	8	
		2SK3869	450	10	40	0.68	28	
		TK13A45D	450	13	45	0.46	25	
		2SK3935	450	17	50	0.25	62	
		TK4A50D	500	4	30	2.0	9	
		2SK3563	500	5	35	1.5	16	-
		2SK3868 #	500	5	35	1.7	16	
		TK5A50D TK6A50D	500 500	5 6	35 35	1.5 1.4	11	-
		TK7A50D	500	7	35	1.4	12	
		2SK3561	500	8	40	0.85	28	
		2SK4042 #	500	8	40	0.97	28	
		TK8A50D	500	8	40	0.85	16	
		TK10A50D	500	10	45	0.72	20	
		TK11A50D	500	11	45	0.6	38	
		2SK3568	500	12	40	0.52	42	
		TK12A50D	500	12	45	0.52	25	
	ſ	TK13A50DA	500	12.5	45	0.47	28	
		2SK4012	500	13	45	0.4	50	
		TK13A50D	500	13	45	0.4	32	ļ
		2SK3934	500	15	50	0.3	62	
		TK15A50D	500	15	50	0.3	40	ļ
		TK18A50D TK6A53D	500	18	50	0.27	45	
		TK12A53D	525	6	35	1.3	12	-
		TK4A55DA	525 550	12 3.5	45 30	0.58 2.45	25 9	<u> </u>
TO 220010		TK4A55D	550	4	35	1.88	11	
TO-220SIS	N-ch Single	TK5A55D	550	5	35	1.7	11	
10		TK6A55DA	550	5.5	35	1.48	12	
0.51		TK8A55DA	550	7.5	40	1.07	16	
* † [1 17 17 1		TK11A55D	550	11	45	0.63	25	
2.8		TK12A55D	550	12	45	0.57	28	
<u>↓_</u> ∥∥∥		TK14A55D	550	14	50	0.37	40	
(mm)		2SK3767	600	2	25	4.5	9	
		TK3A60DA	600	2.5	30	2.8	9	
		2SK3567	600	3.5	35	2.2	16	
		TK4A60DA TK4A60DB	600	3.5	35	2.2	11	
		TK4A60DB TK4A60D	600	3.7	35	2	11	-
		2SK3562	600	6	35 40	1.7 1.25	12 28	
	ŀ	2SK3947 #	600	6	40	1.25	28	
	ŀ	TK6A60D	600	6	40	1.25	16	
	ŀ	2SK3667	600	7.5	45	1.0	33	
	ļ	TK8A60DA	600	7.5	45	1.0	20	
		2SK3569	600	10	45	0.75	42	
	Ī	2SK4015 #	600	10	45	0.86	42	
		TK10A60D	600	10	45	0.75	25	
		TK11A60D	600	11	45	0.65	28	ļ
		TK12A60D	600	12	45	0.55	38	<u> </u>
		TK12A60U	600	12	35	0.4	14	<u> </u>
		2SK3797 2SK4016 #	600	13	50	0.43	62	-
		ZSK4016 # TK13A60D	600	13 13	50 40	0.5 0.43	62 40	-
		TK15A60D TK15A60D	600	15	50	0.43	45	
		TK15A60U	600	15	40	0.37	17	
		TK20A60T	600	20	45	0.19	30	
		TK20A60U	600	20	45	0.19	27	†
		TK5A65D	650	5	40	1.43	16	
		TK6A65D	650	6	45	1.11	20	
		TK8A65D	650	8	45	0.84	25	
		TK13A65U	650	13	40	0.38	17	

#: HSD type

[•] The products shown in bold are also manufactured in offshore fabs.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

 $250 \text{ V} < \text{VDSS} \le 700 \text{ V}$ (Power MOSFETs) (N-ch MOSFETs) (Continued)

Package	Polarity	Part Number	VDSS (V)	Id (A)	Pp (W)	RDS(ON) Max (Ω)	Qg (nC)	Internal
						V _G S = 10 V	(typ.)	Connections
TO-220(W)		TK12D60U	600	12	144	0.4	14	
930	N-ch Single	TK15D60U	600	15	170	0.3	17	
2.8	N-cri Single	TK20D60T	600	20	190	0.19	30	
↓		TK20D60U	600	20	190	0.19	27	
		2SK3904	450	19	150	0.26	62	
		2SK2601	500	10	125	1.0	30	
		2SK3314 #	500	15	150	0.49	58	
		2SK4107	500	15	150	0.4	48	
		TK15J50D	500	15	210	0.4	32	
		2SK3905	500	17	150	0.31	62	
		2SK4108	500	20	150	0.27	62	
		TK20J50D	500	20	280	0.27	45	
TO-3P(N)		2SK3907	500	23	150	0.24	60	
15.9		2SK3936 #	500	23	150	0.25	60	
[(J)		TK12J55D	550	12	190	0.57	28	
~ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	N-ch Single	TK16J55D	550	16	250	0.37	40	
		2SK2602	600	6	125	1.25	30	
		2SK2699	600	12	150	0.65	58	
(mm)		TK12J60U	600	12	144	0.4	14	
		2SK3903	600	14	150	0.44	62	
		TK15J60T	600	15	170	0.30	21	
		TK15J60U	600	15	170	0.3	17	
		2SK3906 #	600	20	150	0.33	60	
		2SK3911	600	20	150	0.30	60	
		TK20J60T	600	20	190	0.19	30	
		TK20J60U	600	20	190	0.19	27	
		TK40J60T	600	40	400	0.08	67	
TO-3P(N)IS		2SK2916	500	14	80	0.4	58	
370	N-ch Single	2SK2917	500	18	90	0.27	80	
3.6	single	2SK2953	600	15	90	0.4	80	
₩U U U (mm)		2SK3453	700	10	80	1.0	53	
TO-3P(L) ✓ ^{20.5} ➤		2SK1486	300	32	200	0.095	140	
0.000	N 1 6: 1	2SK1544	500	25	200	0.2	150	
\$22 \$200	N-ch Single	2SK3131 #	500	50	250	0.11	280	
(mm)		2SK3132	500	50	250	0.095	280	
#· HSD type	l l			<u>I</u>	L	<u> </u>	1	1

^{#:} HSD type
• The products shown in bold are also manufactured in offshore fabs.

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

700 V < VDSS (Power MOSFETs) (N-ch MOSFETs)

Package	Polarity	Part Number	V _{DSS} (V)	I _D (A)	P _D (W)	Rds(on) Max (Ω)	Qg (nC)	Internal
	1 olding	i dit i di i di	*D33 (*/	יי אַ טוי	10(**)	VGS = 10 V	(typ.)	Connections
PW-Mold 888 72 25	N-ch Single	2SK3301	900	1	20	20	6	
DP 68 8 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7 7	N-ch Single	2SK2845	900	1	40	9.0	15	
TO-220FL		2SK2883	800	3	75	3.6	25	
TO-220SM	N-ch Single	2SK2884	800	5	100	2.2	34	
© 103 → 4.8 (mm)		2SK1930	1000	4	80	3.8	60	
TO-220SM	N-ch Single	2SK3879	800	6.5	80	1.7	35	
TO-220AB		2SK2603	800	3	100	3.6	25	
7.51		2SK2733	900	1	60	9.0	15	
2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5 2.5.5	N-ch Single	2SK2608	900	3	100	4.3	25	
(mm)		2SK1119	1000	4	100	3.8	60	

The products shown in bold are also manufactured in offshore fabs.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

700~V < VDSS~(Power~MOSFETs)~~(N-ch~MOSFETs)~(Continued)

Package	Polarity	Part Number	V _{DSS} (V)	I _D (A)	P _D (W)	Rds(on) Max (Ω)	Qg (nC)	Internal
Fackage	Fulatily	rait Nullibei	VDS5 (V)	ID (A)	FD (VV)	Vgs = 10 V	(typ.)	Connections
TO-220SIS		2SK4013	800	6	45	1.7	45	
→ 10.0		2SK3566	900	2.5	40	6.4	12	
1 10		2SK3564	900	3	40	4.3	17	
0.50	N-ch Single	2SK3798	900	4	40	3.5	26	
X Y	N-CII SIIIGIE	2SK3565	900	5	45	2.5	28	
13.0 2.8 2.8		2SK3742	900	5	45	2.5	25	
↓		2SK4014	900	6	45	2.0	45	
(mm)		2SK3799	900	8	50	1.3	62	
		2SK3633	800	7	150	1.7	35	
		2SK2607	800	9	150	1.2	68	
TO-3P(N)		2SK2719	900	3	125	4.3	25	
15.9		2SK3700	900	5	150	2.5	28	
		2SK4115	900	7	150	2.0	45	
~ + -	N-ch Single	2SK3473	900	9	150	1.6	38	
		2SK3878	900	9	150	1.3	62	
		2SK2968	900	10	150	1.25	70	
(mm)		2SK4207	900	13	150	0.95	45	
		2SK1359	1000	5	125	3.8	60	
		2SK2613	1000	8	150	1.7	65	
TO-3P(N)IS		2SK3880	800	6.5	80	1.7	35	
		2SK2606	800	8	85	1.2	68	
¥ 7 7 7 7 7 10	N-ch Single	2SK2847	900	8	85	1.4	58	
194		2SK3017	900	8.5	90	1.25	70	
(mm)		2SK1365	1000	7	90	1.8	120	
TO-3P(L)	N-ch Single	2SK1489	1000	12	200	1.0	110	

[•] The products shown in bold are also manufactured in offshore fabs.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

 $VDSS \leq 250 \ V \ (Small-Signal \ MOSFETs/Power \ MOSFETs) \qquad (P-ch \ MOSFETs)$

			VDSS	Vgs	lD			RDS(O	N) Max (mΩ)			Ciss		Internal
Package	Polarity	Part Number	(V)	(V)	(A)	Vgs =	Vgs =	Vgs = 1.8 V	Vgs = 2.5 V	Vgs =	Vgs =	(pF)	Internal FETs	Connections
			(-)	(-)	()	1.2 V	1.5 V	V03 = 1.0 V	V03 = 2.5 V	4.0 V	4.5 V	(6.)		00111100110110
		SSM6J212FE **	-20	±8	-3.3	_	108	73.7	45.6		43.4	834	_	_
ES6		SSM6J53FE	-20	±8	-1.8	_	364	204	136	_	_	568	_	—
**************************************		SSM6J206FE	-20	±8	-2.0	_	_	320	186	130	_	335	_	_
1.6	P-ch	SSM6J205FE	-20	±8	-0.8		_	460	306	234	_	250	_	_
	r -cii	SSM6J26FE	-20	±8	-0.5	l	_	980	330	230	_	250	_	_
1.6		SSM6J23FE	-12	±8	-1.2		_	_	210	160	_	420	_	_
		SSM6J25FE	-20	±12	-0.5	_	_	_	430	260	_	218	_	_
(mm)		SSM6J207FE	-30	±20	-1.4	_	_	_	_	491	_	137	_	_
	P-ch + P-ch	SSM6P41FE *	-20	±8	-0.72	_	1040	670	440	_	300	110	_	(1)
		SSM3J132TU **	-12	±5	-5	100	40.4	28.3	21.4	_	17.8	2700	_	_
		SSM3J130TU *	-20	±8	-4.4		63.2	41.1	31.0	_	25.8	1800	_	_
		SSM3J120TU	-20	±8	-4.0		140	78	49	38	_	1484	_	_
		SSM3J129TU *	-20	±8	-4.6		137	88	62	_	46	640	_	_
HEM	F	SSM3J115TU	-20	±8	-2.2	_	353	193	125	98	_	568	_	_
UFM		SSM3J110TU	-12	±8	-2.3	_	_	240	145	94	_	550	_	_
	-	SSM3J109TU	-20	±8	-2.0		_	300	172	130	_	335	_	_
2.1	P-ch	SSM3J114TU *	-20	±8	-1.8	_	526	321	199	149	_	331	_	
		SSM3J108TU	-20	±8	-1.8		_	363	230	158	_	250	_	_
2.0	-	SSM3J113TU	-20	±12	-1.7			449 (@2.0 V)	249	169	-	370		
(mm)	-	SSM3J111TU	-20	±12	-1.0		_	— (@2.0 V)	680	480		160		
, ,	-	SSM3J36TU *		±12						400	1			
	-	SSM3J117TU	-20		-0.33		3600	2700	1600 (@2.8 V)		1310	43		_
	-	SSM3J118TU	-30	±20	-2.0					225		280		
	-		-30	±20	-1.4		_		_	480	_	137	_	_
		SSM3J112TU SSM6 I409TII **	-30	±20	-1.1					790	_	86		_
	-	0011103 1071 0	-20	±8	-9.5	_	72.3	46.2	30.2		22.1	1100	_	
	-	SSM6J51TU	-12	±8	-4.0		150	85	54		_	1700	_	_
	P-ch	SSM6J21TU	-12	±12	-3.0	_	_	_	88	50	_	1300		_
UF6	-	SSM6J50TU	-20	±10	-2.5	_	_	205 (@2.0 V)	100		64	800		_
	-	SSM6J401TU	-30	±20	-2.5			_		145	_	730	_	_
5.1		SSM6J402TU	-30	±20	-2.0		_	_	_	225	_	280	_	_
		SSM6P54TU	-20	±8	-1.2	_	555	350	228		_	331	_	
20 > 0.7		SSM6P39TU	-20	±8	-1.5	_	_	430	294	213	_	250	_	
		SSM6P28TU	-20	±8	-0.8	_	_	460	306	234	_	250	SSM6J205FE x 2	
(mm)	P-ch x 2	SSM6P26TU	-20	±8	-0.5	_	_	980	330	230	_	250	SSM6J26FE x 2	(1)
		SSM6P25TU	-20	±12	-0.5	_	_	_	430	260	_	218	SSM6J25FE x 2	
		SSM6P36TU	-20	±8	-0.33	_	3600	2700	1600 (@2.8 V)	_	1310	43	SSM3J36TU x 2	
		SSM6P40TU	-30	±20	-1.4	_	_	_	_	403	_	120	_	
US6		SSM6J08FU	-20	±12	-1.3			460 (@2.0 V)	260	180	_	370	_	_
₹₽₽₽					1.0			100 (02.01)	200			0,0		
2.1	P-ch	SSM6J06FU	-20	±12	-0.65	_	_	_	700	500	_	160	_	_
	1 GII	331103001 0	-20	±12	-0.03				700	300		100		
2.0 → 0.9		CCM4 IO7FII	20	. 20	0.0					000		120		
(mm)		SSM6J07FU	-30	±20	-0.8	_	_	_	_	800	_	130	_	_
		SSM3J307T *	-20	±8	-5	_	83	56	40	_	31	1170	_	_
	Ī	SSM3J321T *	-20	±8	-5.2	_	137	88	62	_	46	640	_	_
		SSM3J326T **	-30	±12	-3	_	_	_	80	_	TBD	TBD	_	_
		SSM3J13T	-12	±8	-3	_	_	180 (@2.0 V)	95	70	_	890	_	
TSM		SSM3J312T	-12	±8	-2.7	_	_	237	142	91	_	550	_	_
↑ □□ ∠1		SSM3J304T	-20	±8	-2.3			297	169	127		335		
5.8		SSM3J317T *	-20	±8	-3.6			306	144	—	107	390		
	P-ch	SSM3J313T	-20	±8	-1.6			640	396	268		170		
7 70 70 70 70 70 70 70 70 70 70 70 70 70		SSM3J01T	-20 -30	±0 ±10	-1.7	_			600	400		240	_	
2.9 U.1		SSM3J02T	_								+			_
(mm)		SSM3J314T	-30	±10	-1.5	_	_		700	500	_	150		_
			-30	±20	-3.5	_		_		100	_	505		
	-	SSM3J14T	-30	±20	-2.7		_	_	_	170	_	413	_	_
		SSM3J306T	-30	±20	-2.4		_		_	225	_	280	_	_
		SSM3J305T	-30	±20	-1.7	_	_	_	_	477	_	137	_	_
 Contact the Toshiba sales r 	epresentative f	for information about RoHS com	pliance b	efore vo	u purcha	se anv co	mponents	i.					*: New produ	ıct

39

♦Internal Connections



Note: Some MOSFETs do not have a Zener diode between gate and source.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

^{*:} New product

^{**:} Under development

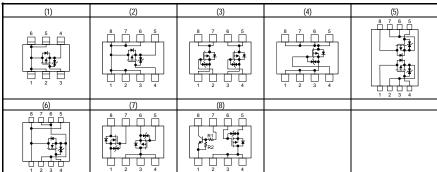
[◆]The internal connection diagrams only show the general configurations of the circuits.

 $VDSS \leq 250 \ V \ (Small-Signal \ MOSFETs/Power \ MOSFETs) \qquad (P-ch \ MOSFETs) \ (Continued)$

		ar WOJI E 13/1								RDS(ON) N)					
Package	Polarity	Part Number	VDSS	VGSS	ID (A)	Pp (W)	Vgs	Vgs	Vgs	VGS	VGS	VGS	Vgs	Vgs	Ciss	Qg (nC)	Internal
r uckage	1 oldiny	T dit (Vallibo)	(V)	(V)	10 (11)	. 5 (11)	= 1.5 V			= 2.5 V	= 4 V	= 4.5 V	= 7 V	= 10 V	(pF)	(typ.)	Connections
S-MINI							- 1.5 V	- 1.0 V	- 2.0 V	- 2.5 V	- T V	- 4.5 V	- / V	- 10 V			
S-WIINI 29		SSM3J327F **	20		2		250	178		133		103			290		
★ ★ ☆ →		3318133327F	-20	±8	-2	_	250	1/8	_	133	_	103	_	_	290	_	_
g c	P-ch																
↓		SSM3J325F **	-20	±8	-3.6	_	TBD	300	_	200	_	TBD	_	_	TBD	_	_
(mm)																	
CST3B																	
0.8																	
Bottom View																	
12	P-ch	SSM3J46CTB **	-20	±8	-2	_	250	178	_	133	_	103	_	_	290	_	_
→ 0.45 ← → 0.48 ←																	
(mm)																	
		TPCF8101	-12	±8	-6	2.5	_	85	_	40	_	28	_	_	_	18	(2)
VC 0	P-ch Single	TPCF8103	-20	±8	-2.7	2.5	_	300	_	160	_	110	_	_	_	6	(2)
VS-8	r-ui single	TPCF8102	-20	±8	-6	2.5	_	90	_	41	_	30	_	_	_	19	(2)
2 S		TPCF8104	-30	±20	-6	2.5	_	_	_	_	_	38	_	28	_	34	(2)
₹ 2.9 → 0.8 ₹		TPCF8301	-20	±8	-2.7	1.35	_	300	_	160	_	110	_	_	_	6	(3)
2.9 (mm)	P-ch Dual	TPCF8302	-20	±10	-3	1.35	_	200	_	95	_	59	_	_	_	11	(3)
(,	r-cii Duai	TPCF8303	-20	±8	-3	1.35	_	250	_	87	_	58	_	_	_	11	(3)
		TPCF8304	-30	±20	-3.2	1.35	_	_	_	_	_	105	_	72	_	14	(3)
VS-6		TPC6103	-12	±8	-5.5	2.2	_	90	_	55	_	35	_	_	_	20	(1)
		TPC6105	-20	±8	-2.7	2.2	_	300	_	160	_	110	_	_	_	6	(1)
2 1 2 1 2 1 2 1 2 1 2 1 2 1 2 1 2 1 2 1	P-ch Single	TPC6107	-20	±12	-4.5	2.2	_	_	180	100	_	55	_	_	_	9.8	(1)
<u> </u>	P-cn Single	TPC6111	-20	±8	-5.5	2.2	_	80	_	57	_	40	_	_	_	10	(1)
2.9		TPC6108	-30	±20	-4.5	2.2	_	_	_	_	_	100	_	60	_	13	(1)
(mm)		TPC6109-H	-30	±20	-5	2.2	_	_	_	_	_	83	_	59	_	12.6	(1)
		TPCP8101	-20	±8	-5.6	1.68	_	90	_	41	_	30	_	_	_	19	(4)
PS-8	P-ch Single	TPCP8102	-20	±12	-7.2	1.68	ı	I	80	30	I	18	I	ı	_	33	(4)
		TPCP8103-H	-40	±20	-4.8	1.68			_			54		40		19	(4)
2.8	D ob Deal	TPCP8301	-20	±12	-5	1.48			_	60		31				20	(3)
2.9	P-ch Dual	TPCP8302	-20	±12	-5	1.48		95	_	45	33	_				20	(3)
(mm)	Load SW	TPCP8401	-12	±8	-5.5	1.96	_	103	_	58	_	38	_	_	_	20	(7)
(*****)	P-ch + BipTr	TPCP8J01	-32	±20	-5.5	2.14			_		49	_		35		34	(8)
TSSOP-8	<u>-</u>	TPCS8105	-30	±20	-10	1.1	_	_	_	_	19.5	_	_	13.5	_	107	(4)
^ <u> </u>	P-ch Single																
4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4		TPCS8104	-30	±20	-11	1.1					18	_		12	_	107	(6)
		TPCS8302	-20	±12	-5	1.1		_	95	60	35	_	_	_	_	28.5	(5)
3.3 max > 0.9	P-ch Dual										- 55				-		
(mm)		TPCS8303	-20	±12	-5	1.1	_	_	80	30	_	21	_	_	—	33	(5)
TSSOP Advance																	
^ <u> </u>																	
3.65																	
¥ 0 0 0 0 0	P-ch Single	TPCM8102	-30	±20	-25	30	_	_	-	_	16	_	_	7.7	_	60	(4)
← > > ←																	
3.9																	
(mm)																	

The products shown in bold are also manufactured in offshore fabs.

♦Internal Connections



Note: Some MOSFETs do not have a Zener diode between gate and source.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

 $[\]bullet$ The internal connection diagrams only show the general configurations of the circuits.

			V===	Vene					RD:	S(ON) Max	(Ω)			0~ (~0)	Internal
Package	Polarity	Part Number	V _{DSS} (V)	V _{GSS} (V)	ID (A)	Pp (W)	Vgs	Vgs	Vgs	Vgs	Vgs	Vgs	Vgs	Qg (nC) (typ.)	Internal Connections
			(V)	(V)			= 1.8 V	= 2.0 V	= 2.5 V	= 4 V	= 4.5 V	= 7 V	= 10 V	(typ.)	Connections
		TPC8115	-20	±8	-10	1.9	0.03	_	0.014	_	0.01	_	_	115	(1)
		TPC8109	-30	±20	-10	1.9	_		_	0.03	_		0.02	45	(1)
		TPC8119	-30	±20	-10	1.9	_		_	0.028	_		0.013	40	(1)
		TPC8111	-30	±20	-11	1.9	_	_	_	0.018	_	_	0.012	107	(1)
		TPC8113	-30	±20	-11	1.9	_			0.018	_		0.01	107	(1)
SOP-8		TPC8121	-30	±20	-11	1.9	_	_	_	0.024	_	_	0.012	42	(1)
		TPC8123	-30	-25/+20	-11	1.9	_	_	_	_	0.0125	_	0.009	68	(1)
6.0		TPC8122	-30	±20	-12	1.9	_	_	_	0.0165	_	_	0.008	62	(1)
	P-ch Single	TPC8107	-30	±20	-13	1.9	_	_	_	0.015	_	_	0.007	130	(1)
5.5 max > 1.6		TPC8112	-30	±20	-13	1.9	_	_	_	0.014	_	_	0.006	130	(1)
(mm)		TPC8118	-30	±20	-13	1.9	_		_	0.015	_	_	0.007	65	(1)
		TPC8114	-30	±20	-18	1.9	_	_	_	0.0068	_	_	0.0045	180	(1)
		TPC8117	-30	±20	-18	1.9	_	_	_	0.0079	_	_	0.0039	130	(1)
		TPC8120	-30	-25/+20	-18	1.9	_	_	_	_	0.042	_	0.0032	180	(1)
		TPC8116-H	-40	±20	-7.5	1.9	_	_	_	_	0.037	_	0.030	27	(1)
		TPC8110	-40	±20	-8	1.9	_	_	_	0.035	-	_	0.025	48	(1)
SOP Advance		TPCA8105	-12	±8	-6	20	0.092	_	0.051		0.033	_	-	18	(1)
SUP Advance		TPCA8102	-30	±20	-40	45	-	_	-	0.014	—	_	0.006	109	(1)
0.00		TPCA8103	-30	±20	-40	45	_		_	0.0068	_	_	0.0042	184	(1)
	P-ch Single	TPCA8106	-30	±20	-40	45			_	0.0078		_	0.0037	130	(1)
* '	. on onigio	TPCA8107-H	-40	±20	-7.5	30	_	_	_		0.037	_	0.030	27	(1)
5.0 0.95		TPCA8108	-40	±20	-40	45	_	_	_	_		_	0.0095	100	(1)
(mm)		TPCA8104	-60	±20	-40	45	_	_	_	0.024	_	_	0.016	90	(1)
		11 0/10101	00		10	-10				0.024			0.010	70	(1)
PW-Mini		2SJ360	-60	_	-1	1.5	_	_	_	1.2	_	_	0.73	6.5	
525	P-ch Single														
4.6	Jg.o	2SJ508	100		1	1 5				2 5			1.0	4.2	
4.0 (mm)		23J0U8	-100	_	-1	1.5	_	_	_	2.5	_	_	1.9	6.3	
		2SJ537	-50	_	-5	0.9		_	_	0.34		_	0.19	18	
LSTM		20001	-50		-5	0.7				0.34		_	0.19	10	

82															
**************************************	P-ch Single	2SJ507	-60	_	-1	0.9	_	_	_	1.0	_	_	0.7	5.6	
10.5															
[
▼U_U (mm)		00 1500													
(11111)		2SJ509	-100	_	-1	0.9	_	_	_	2.5	_	_	1.9	6.3	
TPS															
₹ 8.0		2SJ378	-60		-5	1.3				0.28		_	0.19	22	
07		200010	-30		-5	1.3				0.20			0.17		
१ १ त ए छ	P-ch Single														
1.5	Jg.o														
5		2SJ669	-60	_	-5	1.2	_	_	_	0.25	_	_	0.17	15	
↓															
(mm)															

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♦Internal Connections



Note: Some MOSFETs do not have a Zener diode between gate and source.

 $\bullet \mbox{The internal connection diagrams only show the general configurations of the circuits.}$

 $VDSS \leq 250 \ V \ (Small-Signal \ MOSFETs/Power \ MOSFETs) \qquad \text{(P-ch MOSFETs) (Continued)}$

				L 13)		WOSIE			O)				
Polarity	Part Number	V _{DSS} (V)	ID (A)	P _D (W)	VGS = 1.8 V	VGS = 2.0 V	VGS = 2.5 V	VGS = 4 V	VGS = 4.5 V	VGS = 7 V	VGS = 10 V	Qg (nC) (typ.)	Internal Connections
	2SJ439	-16	-5	20	1		0.28	0.2		-		24	
1	2SJ668	-60	-5	20	_	_	_	0.25	_	_	0.17	15	
P-ch Single	2SJ338	-180	-1	20	_		_	_	_	_	5	_	
Ţ	2SJ567	-200	-2.5	20							2	10	
, [2SJ610	-250	-2	20	_	_	_	_	_	_	2.55	24	
P-ch Single	2SJ680	-200	-2.5	20		_	_		_		2	10	
P-ch Single	2SJ619	-100	-16	75	_	_	_	0.32	_	_	0.21	48	
ı	2SJ620	-100	-18	125	_	_	_	0.12	_	_	0.09	140	
	2SJ312	-60	-14	40	_	_	_	0.19	_	_	0.12	45	
D ch Singlo	2SJ401	-60	-20	100	_	_	_	0.09	_	_	0.045	90	
r-cii Siiigie	2SJ402	-60	-30	100	_	_	_	0.06	_	_	0.038	110	
	2SJ412	-100	-16	60	_	_	_	0.32	_	_	0.21	48	
		-60	-5	25	_	_	_	0.28	_	_	0.19	22	
, .					_	_	_		_	_	0.12	_	
, ,					_					_			
,													
P-ch Single										_			
,													
, 												_	
, †						_	_						
, †													
P-ch Sinale	TJ70A06J3	-60	-70	54	_	_	_	_	10	_	8.0	246	
. S.i Siligio	TJ20A10M3	-100	-20	35	_	_	_	_	_	_	90	120	
	P-ch Single P-ch Single P-ch Single P-ch Single	P-ch Single	P-ch Single 2SJ439 -16 2SJ668 -60 2SJ338 -180 2SJ610 -250	P-ch Single	P-ch Single Part Number (V) ID (A) (W)	P-ch Single	P-ch Single	Polarity Part Number (VS) (N) (N) (N) (N) (N) (N) (N) (N) (N) (N	Polarity Part Number Vis	Politify Part Number (V) Ib (A) (W) Vos 21.8 V Vos 22.5 V Vos 24.5 V Vos	Polarity	Polarity Part Number (70 to (7	Politify Part Number Or Or Or Or Or Or Or

[•] The products shown in bold are also manufactured in offshore fabs.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

								Ro	s(on) Max (Ω)			Qg (nC)	Internal
Package	Polarity	Part Number	VDSS (V)	Id (A)	PD (W)	VGS = 1.8 V	VGS = 2.0 V	VGS = 2.5 V	VGS = 4 V	VGS = 4.5 V	Vgs = 7 V	VGS = 10 V	(typ.)	Connections
TO-220SM(W)	P-ch Single	TJ120F06J3	-60	-120	300	l	_	l		l	_	0.008	258	
TO-3P(N)	P-ch Single	2SJ200	-180	-10	120		_		_		_	0.83	_	
(mm)	-	2SJ618	-180	-10	130		_				_	0.37 (7 V)	35	
TO-3P(N)IS 15.8 15.8 15.8 (mm)	P-ch Single	2SJ440	-180	-9	80	-	_	_	_	_	_	0.83	_	
TO-3P(L)	P-ch Single	2SJ201	-200	-12	150	l	_	_	_	_	_	0.625	_	

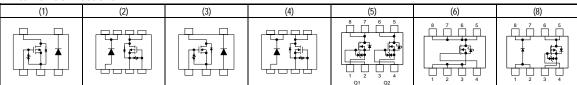
Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(MOSFET + SBD)

(MOSFET F SBB)								M	OSFET							S	BD				Internal
Package	Polarity	Part Number	Vnss	Vgss	lD	PD			RDS(C	N) Max	$(m\Omega)$		Ciss	VR	lo		V _F M	ax (V)		Qg (nC)	Connec-
, donago	· olanty	r dit ramboi	(V)	(V)	(A)	(W)	VGS =	VGS =	Vgs =	Vgs =	Vgs =	Vgs =	(pF)	(V)	(A)	IF =	IF =	IF =		(typ.)	tions
		COMPONENTIA					1.8 V	2.0 V	2.5 V	4.0 V	4.5 V	10 V				1.0 A	0.5 A	0.3 A	0.1 A		4.1
UFV		SSM5G10TU	-20	±8	-1.5		430	_	294	213	_		250	20	0.7	_	0.39	_	_		(1)
		SSM5G09TU	-12	±8	-1.5	_		_	200	130			550	12	0.5	_	0.43	0.39	_	_	(1)
12		SSM5G02TU	-12	±12	-1	_	_	_	240	160			310	12	0.5	_	0.43	0.39	_	_	(1)
2.0		SSM5G04TU	-12	±12	-1	_		_	420	240			170	12	0.5	_	0.43	0.39	_	_	(1)
		SSM5G11TU	-30	±20	-1.4	_	_	_	_	403		226	120	30	0.7	_	0.41	_	_	_	(1)
(mm)		SSM5G01TU	-30	±20	-1	_	_		_	800	_	400	86	20	0.5	_	_	0.45	_		(1)
VS-8 2.9 (mm)	P-ch + SBD	TPCF8B01	-20	±8	-2.7	1.35	0.3		0.16		0.11	l	_	20	1	0.49	_	_	_	6	(8)
PS8 29 (mm)		TPCP8BA1	-20	±12	-1.3	_			260	180			370	25	0.7	_	0.41	_	_		(2)
		SSM5H10TU	20	±10	1.6		190	_	139	119	_		260	20	0.7	_	0.39	_	_		(3)
UFV		SSM5H05TU	20	±12	1.5				220	160	_	_	125	12	0.5		0.43	0.39	_		(3)
		SSM5H08TU	20	±12	1.5	_		_	220	160	_	_	125	20	0.5	_	_	0.45	_		(3)
		SSM5H03TU SSM5H11TU	12 30	±12	1.4	_	_	_		300 182		150 122	125 180	12 30	0.5	_	0.43	0.39	_		(3)
2.0		SSM5H11TU	30	±20	1.6	=	296		177	133		12Z —	123	30	0.7		0.41				(3)
(mm)		SSM5H01TU	30	±20	1.4		_		_	450	_	200	106	20	0.5	_	-	0.45	_		(3)
(IIIII)		SSM5H07TU	20	±20	1.2	_	_	_	_	540	_	300	36	12	0.5	_	0.43	0.39	_	_	(3)
SMV 29 (mm)		SSM5H14F	30	±12	3	-	138		94	78	_	_	270	45	0.1	_	_	_	0.6	-	(3)
PS8 29 (mm)	N-ch + SBD	TPCP8AA1	20	±12	1.6	_			140	105			306	25	0.7	_	0.41	_	_		(4)
TSSOP Advance		TPCM8A05-H ♦	30	±20	20	30	_	_	_	_	17.2	12.9	_	_	_	_	_	_	_	15	(6)
	1	TPC8A01 ♦	30	±20	6/8.5	1.5	_	_	_	_	30/21	25/18	_	_	_	_	_	_	_	17/49	(5)
SOP-8		TPC8A05-H ♦	30	±20	10	1.9	_	_	_	_	17.6	13.3		_	_	_	_	_	_	15	(6)
6.0		TPC8A02-H ♦	30	±20	16	1.9	_	_	_	_	8.5	5.6	_	_	_	_	_	_	_	34	(6)
5.5 max 1.6		TPC8A03-H ♦	30	±20	17	1.9	_	_	_	_	7	5.6	_	_	_	_	_	_	_	36	(6)
(mm)		TPC8A04-H ♦	30	±20	18	1.9	_	_	_	_	4.5	3.6	_	_	_	_	_	_	_	56	(6)
<u></u>													<u> </u>	Ь	<u> </u>		<u> </u>				

- : Monolithic
- $\bullet\,\,$ The products shown in bold are also manufactured in offshore fabs.
- Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

♦Internal Connections



44

Note: Some MOSFETs do not have a Zener diode between gate and source.

[◆]The internal connection diagrams only show the general configurations of the circuits.

(MOSFET + SBD) (Continued)

										M	OSFET							S	BD				Internal
	Package	Polarity	Part Number		Vdss	Vecc	lD	PD			R _{DS} (c	on) Max	(mΩ)		Ciss	VR	lo		V _F M	ax (V)		Qg (nC)	Connec-
	i dekage	lolarity	T dit Number		(V)	(V)	(A)	(W)	Vgs = 1.8 V	VGS = 2.0 V	Vgs = 2.5 V	VGS = 4.0 V	VGS = 4.5 V	VGS = 10 V	(pF)			IF = 1.0 A	IF = 0.5 A	IF = 0.3 A	11-	(typ.)	tions
	SOP Advance		TPCA8A05-H	\\	30	±20	20	30	_	-	_	_	17.2	12.9	_	_	_	_	_	_	_	15	(1)
6.0	2.0	N-ch +	TPCA8A02-H	\\	30	±20	34	45	-	-	-	_	6.7	5.3	_	ı	_		_			36	(1)
,	5.0	SBD	TPCA8A01-H	\rightarrow	30	±20	36	45		-		_	8.5	5.6	_	ı	_		_	_		19	(1)
	5.3 (mm)		TPCA8A04-H	\\	30	±20	44	45	_	_	_	_	4.1	3.2	_		_	_	_	_	_	59	(1)

♦: Monolithic

- The products shown in bold are also manufactured in offshore fabs.
- Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(MOSFET + Switching Diodes)

								M	OSFET								Di				Internal
Package	Polarity	Part Number	Vncc	Vgss	lD	PD			RDS(C	N) Max	(mΩ)		Ciss	Vn	lo	trr	VF	Max ((V)	Qg (nC)	Internal Connec-
1 dekage	lolanty	r art rumber	(V)	(V)	(A)	(W)	$V_{GS} =$	$V \hspace{-1pt} \text{GS} =$	$V_{GS} =$	$V_{GS} =$	Vgs =	Vgs =				(ns)	IF =	IF =	IF =	(typ.)	tions
			()	(0)	(/-)	(**)	1.5 V	1.8 V	2.5 V	4.0 V	4.5 V	10 V	(pi)	()	(/1)	(113)	1 mA	10	0.1 A		
oil I	diodoc	SSM5H90TU	20	±10	2.4		157	110	80	65	_	_	400	80	0.1	1.6		mA	1.2	_	(2)

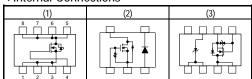
[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(MOSFET + Zener Diodes)

								MOSF	ET								Ze-Di					Internal
Package	Polarity	Part Number	Vdss	Vecc	ΙD	PD		R	DS(ON) N	lax (mΩ	2)		Ciss	Vz	(V)	IR (μΑ)	VF	Max	(V)	Qg (nC)	Internal Connec-
1 dekage	lolanty	T dit Number	(V)	(V)	(A)	(W)	Vgs =	$V_{GS} =$	V GS =	$V \hspace{05cm} \text{GS} =$	$V \hspace{05cm} \text{Gs} =$	$V_{GS} =$	(pF)		@lz		@VR	IF =	IF =	IF =	(typ.)	tions
			()	()	(/-)	(**)	1.8 V	2.0 V	2.5 V	4.0 V	4.5 V	10 V	(pi)		(mA)		(V)	1.0 A	0.5 A	0.3 A		tions
PS8 29 08 (mm)	N-ch + Zener diodes	TPCP8R01	60	±20	2.0		_			440		300	140	43	2	0.5	33	_	_		_	(3)

- The products shown in bold are also manufactured in offshore fabs.
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♦Internal Connections



Note: Some MOSFETs do not have a Zener diode between gate and source.

 $\bullet \text{The internal connection diagrams only show the general configurations of the circuits}. \\$

Bipolar Power Transistors

Radio-Frequency Switching Power Transistors (2SA/2SC/TTA/TTC Series)

\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	•					`	1			1						
VCEO		10//15)			(10)/20			(25)/20			40//45\			F0///0\		
c(A)		10/(15)			(18)/20			(25)/30			40/(45)			50/(60)		
										2SA1483	2SC3803	(©)				
0.2										(45 V)	(45 V)	(಄)				
0.8							2SA1426		(8)	2SA1356	2SC3419	(@)				
0.8							2SA1420 2SA1204	2SC2884	(S) (©)	23A1330	2303419	(@)				
1	TPC6D02		(&)(△)				23A1204	2SC2703	(*)				2SA2070			(©)
	(15 V)		(d)(Δ)					2SC3666	(\$)				23A2010	TPC6701	((⋑) (A)(W <u>)</u>
	(10 1)						HN4B101J	2000000	(M)(V)					2SC5810	,	(©)
							(NPN: 1.2 A)		(141)(4)				TPC6901A	2000010	((△) (M)(△)
							(141 14. 1.271)						(PNP: 0.7 A)		,	()(—)
													TPCP8901			(M)(P)
													(PNP: 0.8 A)			(/(-/
													S3C83 +	+		(^)
														S3C82	++	(^
													TPC6604 *			(A)
														TPC6504	*	(A)
1.2				TPC6D03		(&)(△)	2SA1734		(©)							
							TPCP8801		(W)(P)							
1.5	2SA2058		(*)	2SA2065		(4)	2SA966	2SC2236	(*)							
					2SC5784	(4)	2SA1203	2SC2883	(©)							
				2SA2069		(©)										
					2SC5819	(©)										
					TPC6503	(△)										
				S3F56	++	(△)										
	2SA1160	2SC2500	(*)								2SC3225		2SA1020	2SC2655		(*)
	2SA1430	2SC3670	(§)				TPCP8902		(M)(P)		2SC3673		2SA1241	2SC3076		(♦)
	2SA2066		(©)				(NPN+PNP)				2SC3964	(@)	2SA1382			(♣)
		2SC5755	(^)				TPC6902		$(M)(\Delta)$				2SA2056			(♠)
		2SC5785	(©)				(NPN+PNP)						TPC6601			(\triangle)
		TPC6501	(A)				HN4B102J		(M)(V)					TPCP8701		(W)(P)
	TPC6602		(A)				(NPN+PNP)						2SA2060			(©)
		TPCP8504	(P)										2SA1428	2SC3668		(§)
													2SA1680	2SC4408		(*)
													2SA1891	2SC5028		(□)
2.5				2SA2061		(♠)								2SC5692		(*)
														2SC6033		(^)
													TPCP8602			(P)
3				2SA2059		(©)		2SC5976		2SA1359	2SC3422	(@)	2SA1761	2SC4604		(*)
				TPCP8F01		(\$)(P)		TPCP8H02	(\$)(P)	1			2SA1869	2SC4935		(A)
		2SC4682	(♣)	TPC6603		(A)							2SA1892	2SC5029		(D)
		(15 V)	(0)	TPCP8G01	*	(\$)(P)								2SC5712		(©)
		2SC4683	(§)											TPC6502		(A)
		(15 V)												TPCP8505)	(P)
						, ,				-				2SC6126		(©)
3.5					2SC5738	(*)										

The products shown in bold are also manufactured in offshore fabs.

	Package			
Through-Hole Package		Surface-Mount Package	Other Remarks	
Tillough-Hole Fackage	Ammo Packaging	Surface-iviourit Fackage		
(*) LSTM	O Available	(A) TSM	(%) Darlington	
(§) MSTM	O Available	(©) PW-Mini	(#) Built-in zener diode	
(□) TPS	Available only in tape packaging	(♦) PW-Mold	Part number in italic signifies built in Freewheel diode	
(@) TO-126	× Not available	(‡) DP	2SA****/2SC****: Complementary	
(■) TPL	Available only in tape packaging	(●) TO-220SM	(&) 2-in-1 (transistor + diode)	
(▲) TO-220NIS	× Not available	(△) VS-6	(\$) 2-in-1 (transistor + S-MOS)	
(O) TO-220FL	× Not available	(P) PS-8	(W) 2-in-1 (NPN (or PNP) × 2)	
(♦) PW-Mold	× Not available	(V) SMV	(M) 2-in-1 (NPN + PNP)	
(‡) DP	× Not available	(♥)TFP		
(▽) TO-3P(N)	× Not available			
(▼) TO-3P(N)IS	× Not available			
(※) TO-3P(L)	× Not available			
(〒) TO-220SIS	× Not available			
(◆) TO-92	Available only in tape packaging			

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

^{*:} New product

^{++:} Being planned

VCEO (V) Ic(A)	10/(15)			(18)/20		(25)/30		40/(45)		50/(60)	
4	2SC4781	(*)		2SC5714	(©)	2SC5906	(*)			2SC5703	(*)
	2SC5713	(©)		2SC6125	(©)						
	S3F61	++ (\(\Delta\)		S3F62 ++	(Δ)						
			TPCP8601		(P)						
5			2SA1242		(♦)	2SC6062	(♠)		2SA1244	2SC3074	(♦)
			2SA1357		(@)				2SA1905	2SC5076	(□)
			2SA1431		(§)				2SA1931	2SC4881	(▲)
									2SA1933	2SC5175	(■)
				2SC3072	(♦)				2SA2097		(♦)
				2SC3420	(@)					2SC5886	(♦)
				2SC3671	(§)					2SC5886A	(♦)
				2SC4684	(♦)					TPCP8H01	(\$)(P)
				2SC4685	(@)						
				2SC5030	(\Box)					S3H32 ++	(♦)
				2SC6052	(♦)				2SA2183		(₸)
									(60 V)		
7										2SC6000	(♦)
10			2SA1327A		(▲)				2SA1887	2SC5000	(▲)
12	•								2SA1451A	2SC3709A	(▲)

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Legena	Package		
	<u> </u>		Other Remarks
Through-Hole Package	Anna Dankanian	Surface-Mount Package	Other Remarks
	Ammo Packaging		
(♣) LSTM	O Available	(♠) TSM	(%) Darlington
(§) MSTM	O Available	(©) PW-Mini	(#) Built-in zener diode
(□) TPS	Available only in tape packaging	(♦) PW-Mold	Part number in italic signifies built in Freewheel diode.
(@) TO-126	 Not available 	([‡]) DP	2SA****/2SC****: Complementary
(■) TPL	Available only in tape packaging	(●) TO-220SM	(&) 2-in-1 (transistor + diode)
(▲) TO-220NIS	× Not available	(△) VS-6	(\$) 2-in-1 (transistor + S-MOS)
(O) TO-220FL	× Not available	(P) PS-8	(W) 2-in-1 (NPN (or PNP) × 2)
(♦) PW-Mold	 Not available 	(V) SMV	(M) 2-in-1 (NPN + PNP)
([‡]) DP	 Not available 	(♥) TFP	
(▽) TO-3P(N)	 Not available 		
(▼) TO-3P(N)IS	 Not available 		
(※) TO-3P(L)	× Not available		
(〒) TO-220SIS	× Not available		
(◆) TO-92	Available only in tape packaging		

^{++:} Being planned

Radio-Frequency Switching Power Transistors (2SA/2SC/TTA/TTC Series) (Continued)

VCEO (V)		80		100		120			(140)/150			160	
0.05								2SA1145 2SA1360 2SA949	2SC2705 2SC3423 2SC2229	(*) (@) (*))		
0.1												2SC2230	(*)
0.2												2SC3963	(@)
0.4	2SA817A	2SC1627A	(*)										
	2SA1202	2SC2882	(©)										
8.0					2SA965	2SC2235	(*)						
					2SA1425	2SC3665	(§)						
1					TPCP8603	TPCP8507	(P)						
						TPCP8510 *	(P)						
						2SC6061	(^)						, .
			-		2SA1358	2SC3421	(@)				2SA1013	2SC2383	(*)
1.5								0044400	2SC2073A		2SA1225	2SC2983	(\$)
								2SA1408	2SC3621	(@)		2SC5154	(□) (§)
												2SC6139 * 2SC6140 *	(S) (■)
												ZSC6140 * TTC004 *	
2	2SA1315	2SC3328	(•)								11A004 *	11C004 *	(@)
	2SA1315 2SA1429	2SC3669	(*) (§)	TPCP8501 (F	Λ.								
	25A1429	2SC3009 2SC3474	(\$)	TPCP8501 (F	7								
		2SC6079	(§)										
	2SA2206	2SC6124	(©)										
2.5	23A2200	2SC6075	(□)										
2.5		2SC6087	(□)										
3		2SC6076	(♦)										
3		2SC6077	(■)										
		2SC6078	(■)										
5	2SA1934	2SC5176	(■)										
Ü	20/11/01	2SC3303	(\langle)										
6		2SC4688	(▼)										
	2SA1939	2SC5196	(∇)										
8			` '			2SC4689	(▼)						
					2SA1940	2SC5197	· (▽)						
10							. ,		2SC4690	(▼))		
									(140 V)	. ,			
								2SA1941	2SC5198	(▽))		
									(140 V)				
12	2SA1452A	2SC3710A	(▲)								2SA1942	2SC5199	(×)
	2SA1771		(\(\)										
18											TTA0001 *	TTC0001 *	(▽)
											TTA0002 *	TTC0002 *	(*

The products shown in bold are also manufactured in offshore fabs.

Legend

	Package			
Through-Hole Package	Ammo Packaging	Surface-Mount Package	Other Remarks	
(★) LSTM (§) MSTM (□) TPS (@) TO-126 (■) TPL (♠) TO-220NIS (○) TO-220FL (◇) PW-Mold (‡) DP (▽) TO-3P(N) (▼) TO-3P(N)IS	Available Available only in tape packaging Not available Available only in tape packaging Not available Not available	(♠) TSM (◎) PW-Mini (◇) PW-Mold (♣) DP (♠) TO-220SM (△) VS-6 (P) PS-8 (V) SMV (♠) TFP	(%) Darlington (#) Built-in zener diode Part number in italic signifies built in Freewheel diode. 2SA****/2SC****: Complementary (&) 2-in-1 (transistor + diode) (\$) 2-in-1 (transistor + S-MOS) (W) 2-in-1 (NPN (or PNP) × 2) (M) 2-in-1 (NPN + PNP)	
(※) TO-3P(L) (〒) TO-220SIS (♠) TO-92	Not available Not available Not available Not available			

*: New product

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

VCEO (V) Ic(A)	(180)/200	230	300	(370)/400	450
0.05				2SC5122 (*) 2SC5307 (©)	
0.1	2SC2230A (• (180 V)	·)	2SA1432 2SC3672 (\$) 2SC3619 (@) 2SC3620 (@) 2SC4544 (A) 2SC5027 (□)		
0.3			2SA1384 2SC3515 (©)	TPCP8604 (P)	
0.5				15 16 16 16 16 16 16 16	
0.8			2SC6136 * (◆) (285V/0.7A)	2SC3075 (♦) 2SC3425 (@) 2SC5208 (□) 2SC5458 (♦)	
1		2SA1837 2SC4793 (▲) 2SA1932 2SC5174 (■) 2SA2182 2SC6060 (〒)	2SC5930 (\$) (285 V) 2SC6010 (\$) (285 V) 2SC6034 (\$) (285 V)	2SC5550 (@) 2SC6042 (\$) (375 V)	
1.5				2SC6142 * (\$) (375 V 1.5 A) TTC003 * (\$)	
	2SA1930 2SC5171 (A (180 V) (180 V) 2SA2190 2SC6072 (= (180 V) (180 V)			2SC5075 (□) 2SC5548 (♦) (370 V) 2SC5548A (♦) 2SA2034 (♦)	2SC5351 (□) 2SC5368 (@)
3				2SC5459 (△)	
5				2SC5172 (▲) 2SC5266A (■) 2SC5355 (‡) 2SC6138 ++ (♦) (375 V)	
8					2SC5439 (▲)
10 12	2SA2120 * 2SC5948 * (\(\bar{\} \)	7)		2SC5352 (▽)	
15		2SA1943			

The products shown in bold are also manufactured in offshore fabs.

	Package				
Through-Hole Package		Surface-Mount Package	Other Remarks		
Through-Hole Fackage	Ammo Packaging	Surface-iviourit Fackage			
(*) LSTM	O Available	(♠) TSM	(%) Darlington		
(§) MSTM	O Available	(©) PW-Mini	(#) Built-in zener diode		
(□) TPS	Available only in tape packaging	(♦) PW-Mold	Part number in italic signifies built in Freewheel diode		
(@) TO-126	× Not available	(‡) DP	2SA****/2SC****: Complementary		
(■) TPL	Available only in tape packaging	(●) TO-220SM	(&) 2-in-1 (transistor + diode)		
(▲) TO-220NIS	× Not available	(△) VS-6	(\$) 2-in-1 (transistor + S-MOS)		
(O) TO-220FL	× Not available	(P) PS-8	(W) 2-in-1 (NPN (or PNP) × 2)		
(♦) PW-Mold	× Not available	(V) SMV	(M) 2-in-1 (NPN + PNP)		
(‡) DP	× Not available	(♥) TFP			
(▽) TO-3P(N)	× Not available				
(▼) TO-3P(N)IS	× Not available				
(※) TO-3P(L)	× Not available				
(〒) TO-220SIS	× Not available				
(◆) TO-92	Available only in tape packaging				

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

^{*:} New product

^{++:} Being planned

Radio-Frequency Switching Power Transistors (2SA/2SC/TTA/TTC Series) (Continued)

		<u> </u>	J	· · · · · · · · · · · · · · · · · · ·	, ,	<u> </u>
VCEO (V) Ic(A)		(550)/600		800	1000/(1200)	1500
0.02						2SC5563 (▲)
0.05		2SC5201	(*)	2SC5460 (@) 2SC5466 (▲) 2SC6127 * (♦)	2SC4686A (▲)	
0.5	2SA1937 2SA2142		(�) (�)			
0.8				2SC3405 (♦) 2SC5465 (♦) 2SC5562 (□) 2SC5684 (■)		
1	2SA2184 (550 V)		(♦)			
3				2SC5353 (▲) 2SC5361 (O) 2SC5356 (‡)		
5 10				2SC5354 (▽) 2SC3307 (※)		

The products shown in bold are also manufactured in offshore fabs.

Legenu	5 1				
	Package	ı			
Through-Hole Package		Surface-Mount Package	Other Remarks		
Through-Hole Fackage	Ammo Packaging	Surface-would rackage			
(*) LSTM	O Available	(A) TSM	(%) Darlington		
(§) MSTM	O Available	(◎) PW-Mini	(#) Built-in zener diode		
(□) TPS	Available only in tape packaging	(♦) PW-Mold	Part number in italic signifies built in Freewheel diode.		
(@) TO-126	 Not available 	(‡) DP	2SA****/2SC****: Complementary		
(■) TPL	Available only in tape packaging	(●) TO-220SM	(&) 2-in-1 (transistor + diode)		
(▲) TO-220NIS	 Not available 	(△) VS-6	(\$) 2-in-1 (transistor + S-MOS)		
(O) TO-220FL	 Not available 	(P) PS-8	(W) 2-in-1 (NPN (or PNP) × 2)		
(♦) PW-Mold	 Not available 	(V) SMV	(M) 2-in-1 (NPN + PNP)		
(‡) DP	× Not available	(♥) TFP			
(▽) TO-3P(N)	 Not available 				
(▼) TO-3P(N)IS	 Not available 				
(※) TO-3P(L)	 Not available 				
(〒) TO-220SIS	 Not available 				
(◆) TO-92	Available only in tape packaging				

^{*:} New product

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Low-Frequency Power Transistors (2SB/2SD/TTB/TTD Series)

	1 7	•				
VCEO (V) Ic(A)	20	30	40	50	60/(65)	
8.0					2SD2719	(#)(%)(♠)
1					2SD2686	(#)(%)(©)
1.5		2SD1140 (%)(♣) 2SD1224 (%)(♦) 2SD1508 (%)(@) 2SD1631 (%)(§) 2SD1784 (%)(⊚) 2SD2481 (%)(□)				
2	2SD1160 (♦)				2SD1658 2SD2088 2SD2695 2SD2352	(#)(%)(@) (#)(%)(♣) (#)(%)(♣)
3			2SB907 2SD1222 (%)(◇)		2SD2461 2SB906 2SD1221 2SD2462 2SD2462 2SD2525 2SD2353 TTB001 * TTB002 * 2SD2462	
4					2SD2130 2SD2204 (65 V)	(#)(%)(@) (#)(%)(▲)
5					2SD2131	(#)(%)(▲)
7				2SD1412A (▲)		

The products shown in bold are also manufactured in offshore fabs.

	Package				
Through-Hole Package		Surface-Mount Package	Other Remarks		
Through-Hole Fackage	Ammo Packaging	Surface-iviount Fackage			
(*) LSTM	O Available	(♠) TSM	(%) Darlington		
(§) MSTM	O Available	(©) PW-Mini	(#) Built-in zener diode		
(□) TPS	Available only in tape packaging	(♦) PW-Mold	Part number in italic signifies built in Freewheel diode.		
(@) TO-126	 Not available 	(‡) DP	2SA****/2SC****: Complementary		
(■) TPL	Available only in tape packaging	(●) TO-220SM	(&) 2-in-1 (transistor + diode)		
(▲) TO-220NIS	 Not available 	(△) VS-6	(\$) 2-in-1 (transistor + S-MOS)		
(O) TO-220FL	 Not available 	(P) PS-8	(W) 2-in-1 (NPN (or PNP) × 2)		
(♦) PW-Mold	 Not available 	(V) SMV	(M) 2-in-1 (NPN + PNP)		
([‡]) DP	 Not available 	(♥) TFP			
(▽) TO-3P(N)	 Not available 				
(▼) TO-3P(N)IS	 Not available 				
(※) TO-3P(L)	× Not available				
(〒) TO-220SIS	 Not available 				
(◆) TO-92	O Available only in tape packaging				

^{*:} New product

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Low-Frequency Power Transistors (2SB/2SD/TTB/TTD Series) (Continued)

VCEO (V) Ic(A)		80			100		120	150/(160)		200
0.9							TPCP8L01(1) (&)(P)			
1.5								2SB905 2SD1220	(♦)	
2	2SB1067	2SD1509	(%)(@)	2SB1411		(%)(▲)				
				2SB1457	2SD2206	(%)(*)				
				2SB1617	2SD2480	(%)(□)				
					2SD2536	(#)(%)(*)				
3				2SB1495	2SD2257	(%)(▲)				
					2SD2092	(▲)				
					2SD2129	(%)(▲)				
4	2SB908	2SD1223		2SB1481	2SD2241	(%)(▲)				
		2SD2406	(▲)			(2.) (1.)				
5					2SD2079	(%)(▲)				
				2SB1016A	2SD2526 2SD1407A	(%)(■)				
				23B1010A	2SD1407A 2SD2604	(▲) (#)(%)(▲)				
7		2SD2414(<i>SM</i>)	(●)	2SB1020	2SD1415A	(%)(▲)				
	2SB1018 A	2SD1411A	(▲)	7	2SD2584	(%)(‡)				
8								2SD2636 (160 V)	(%)(▽)	
10					2SD1947A	(▲)				
12			•			•				
15		-			2SD1662	(%)(▽)				
30					2SD1525	(%)(※)				

(1) NPN + HED (200 V/1 A)

- The products shown in bold are also manufactured in offshore fabs.
- Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

VCEO (V) Ic(A)		400	450
6	2SD1410A (%)(▲)	2SD1409A (%)(▲)	
15			2SD1314 (%)(※)

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

	Package		
Through-Hole Package		Surface-Mount Package	Other Remarks
Through-Hole Fackage	Ammo Packaging	Surface-would rackage	
(*) LSTM	O Available	(♠) TSM	(%) Darlington
(§) MSTM	O Available	(©) PW-Mini	(#) Built-in zener diode
(□) TPS	Available only in tape packaging	(♦) PW-Mold	Part number in italic signifies built in Freewheel diode.
(@) TO-126	× Not available	(‡) DP	2SA****/2SC****: Complementary
(■) TPL	Available only in tape packaging	(●) TO-220SM	(&) 2-in-1 (transistor + diode)
(▲) TO-220NIS	× Not available	(△) VS-6	(\$) 2-in-1 (transistor + S-MOS)
(O) TO-220FL	 Not available 	(P) PS-8	(W) 2-in-1 (NPN (or PNP) × 2)
(♦) PW-Mold	× Not available	(V) SMV	(M) 2-in-1 (NPN + PNP)
(‡) DP	× Not available	(♥) TFP	
(▽) TO-3P(N)	× Not available		
(▼) TO-3P(N)IS	× Not available		
(※) TO-3P(L)	× Not available		
(〒) TO-220SIS	× Not available		
(◆) TO-92	Available only in tape packaging		

Transistors for Power Amps (Drive Stage)

Part N	umber	Ic	VCEO	Pc	fτ			
NPN	PNP	(A)	(V)	(W)	(MHz) Typ. (NPN/PNP)	VCE (V)	Ic (A)	Package
				Tc = 25°C (♣Ta = 25°C)	<i>31</i> · · · · ·			
2SC1627A	2SA817A	0.4	80	. 0.8	100	10	0.01	LSTM
2SC2235	2SA965	0.8	120	4 0.9	120	5	0.1	ESTIM
2SC3665	2SA1425	0.8	120	4 1	120	5	0.1	MSTM
2SC6139 *	2SA2219 *	1.5	160	1	100	10	0.1	INISTINI
2SC5174	2SA1932	1	230	4 1.8	100/70	10	0.1	TPL
2SC6140 *	2SA2220 *	1.5	160	1	100	10	0.1	IPL
2SC3423	2SA1360	0.05	150	5	200	5	0.01	TO-126
2SC3421	2SA1358	1	120	10	120	5	0.1	10-120
TTC004 *	TTA004 *	1.5	160	10	100	10	0.1	TO-126
2SC2983	2SA1225	1.5	160	15	100	10	0.1	PW-Mold
2SC4793	2SA1837	1	230	20	100/70	10	0.1	TO-220NIS
2SC6060	2SA2182	1	230	20	100/80	10	0.1	TO-220SIS
2SC5171	2SA1930	2	180	20	200	5/10	0.3	TO-220NIS
2SC6072	2SA2190	2	180	20	200	5	0.3	TO-220SIS

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(Output Stage)

Part N	umber	Ic	VCEO	Pc	fτ			
NPN	PNP	(A)	(V)	(W) Tc = 25°C	(MHz) Typ. (NPN/PNP)	VCE (V)	Ic (A)	Package
2SC5196	2SA1939	6	80	(♣ Ta = 25°C) 60	30	5	1	
2SC5197	2SA1940	8	120	80	30	5	1	
2SC5198	2SA1941	10	140	100	30	5	1	
TTC0001 *	TTA0001 *	18	160	150	30	10	1	TO-3P(N)
2SC5242	2SA1962	15	230	130	30	5	1	
2SC5358	2SA1986	15	230	150	30	5	1	
2SC5948	2SA2120	12	200	200	30/25	5	1	
2SC5199	2SA1942	12	160	120	30	5	1	
TTC0002 *	TTA0002 *	18	160	180	30	10	1	
2SC5200	2SA1943	15	230	150	30	5	1	TO-3P(L)
2SC5359	2SA1987	15	230	180	30	5	1	
2SC5949	2SA2121	15	200	220	30/25	5	1	

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

^{*:} New product

^{*:} New product

Transistors for MOS Gate Drivers/Compact Motor Drivers (2-in-1 Transistors)

		Abs	solute Max	imum Rat	ings	h	FE			VCE(sat)				Circuit Configuration
Part Number	Polarity	VCEO	Ic	ICP	Pc (Note 1)	111	rt	Vce	Ic	(V)	lc	IΒ	Package	(Top View)
		(V)	(A)	(A)	(mW)	Min	Max	(V)	(A)	Max	(A)	(mA)		(100 11011)
HN4B101J	PNP	-30	-1.0	-5	550	200	500	-2	-0.12	-0.2	-0.4	-13		5 4
1114451015	NPN	30	1.2	5	550	200	500	2	0.12	0.17	0.4	13	SMV	PNP
HN4B102J	PNP	-30	-1.8	-8	750	200	500	-2	-0.2	-0.2	-0.6	-20	SIVIV	
11114151025	NPN	30	2	8	750	200	500	2	0.2	0.14	0.6	20		1 2 3
TPC6901A	PNP	-50	-0.7	-5	400	200	500	-2	-0.1	-0.23	-0.3	-10		6 5 4
1FC0901A	NPN	50	1	5	400	400	1000	2	0.1	0.17	0.3	6	VS-6	PNP
TPC6902	PNP	-30	-2	-8	400	200	500	-2	-0.2	-0.2	-0.6	-20	V3-0	
11 00702	NPN	30	2	8	400	200	500	2	0.2	0.14	0.6	20		1 2 3
TPCP8901	PNP	-50	-0.8	-5	830	200	500	-2	-0.1	-0.21	-0.3	-10		8 7 6 5
11 01 0701	NPN	50	1	5	830	400	1000	2	0.1	0.17	0.3	6	PS-8	NPN PNP
TDCD8002	PNP	-30	-2	-8	890	200	500	-2	-0.2	-0.2	-0.6	-20		
TPCP8902	NPN	30	2	8	890	200	500	2	0.2	0.14	0.6	20		1 2 3 4

Note 1: The rating applies when the transistor is mounted on an FR4 board (Cu area = 645 mm 2 , glass-epoxy, t = 1.6 mm) and is in single-device operation. Thickness of cu: 70 μ m for SMV/PS-8, 35 μ m for VS-6

(1-in-1 Transistors)

1-III-1 Hallsiste	,,	Absolute	e Maximur	n Ratings					VCE(sat)			1		
Part Number	Polarity	VCEO		PC (Note 1)	hi	E	VCE	Ic	(V)	Ic	lв	Complementary	Package	Remark
	,	(V)	(A)	(mW)	Min	Max	(V)	(A)	Max	(A)	(mA)	,	, . .	
2SA2058		-10	-1.5	500	200	500	-2	-0.2	-0.19	-0.6	-20	2SC5755		
2SA2065		-20	-1.5	500	200	500	-2	-0.15	-0.14	-0.5	-17	2SC5784		
2SA2061	PNP	-20	-2.5	625	200	500	-2	-0.5	-0.19	-1.6	-53	2SC5735	TSM	
S3C83 ++		-50	-1	500	200	500	-2	-0.1	-0.18	-0.3	-10	S3C82 ++	2.9	
2SA2056		-50	-2	625	200	500	-2	-0.3	-0.20	-1.0	-33	2SC5692	\uparrow	
2SC5755		10	2	500	400	1000	2	0.2	0.12	0.6	12	2SA2058	1.6	
2SC5784		20	1.5	500	400	1000	2	0.15	0.12	0.5	10	2SA2065	·	
2SC5738	NPN	20	3.5	625	400	1000	2	0.5	0.15	1.6	32	2SA2061	↓ □	
2SC6062	INPIN	30	5	800	250	400	2	0.5	0.12	1.6	53	S3P84	(mm)	(Note 2
S3C82 ++		50	1	500	400	1000	2	0.1	0.17	0.3	6	S3C83 ++	` ′	
2SC5692		50	2.5	625	400	1000	2	0.3	0.14	1.0	20	2SA2056		
2SA2066		-10	-2	1000	200	500	-2	-0.2	-0.19	-0.6	-20	2SC5785		
2SA2069		-20	-1.5	1000	200	500	-2	-0.15	-0.14	-0.5	-17	2SC5819		
2SA2059	PNP	-20	-3	1000	200	500	-2	-0.5	-0.19	-1.6	-53	2SC5714	PW-Mini	
2SA2070		-50	-1	1000	200	500	-2	-0.1	-0.18	-0.3	-10	2SC5810	4.6	
2SA2060		-50	-2	1000	200	500	-2	-0.3	-0.20	-1.0	-33	2SC5712	↑ <u></u>	
2SC5785		10	2	1000	400	1000	2	0.2	0.12	0.6	12	2SA2066	2.5	
2SC5819		20	1.5	1000	400	1000	2	0.15	0.12	0.5	10	2SC2069	→	
2SC5714	NIDAL	20	4	1000	400	1000	2	0.5	0.15	1.6	32	2SA2059	↓	
2SC5810	NPN	50	1	1000	400	1000	2	0.1	0.17	0.3	6	2SA2070	(mm)	
2SC5712		50	3	1000	400	1000	2	0.3	0.14	1	20	2SA2060		
2SC6126		50	3	1000	250	400	2	0.3	0.2	1	33	2SA2217 **		(Note :

Note 1: The rating applies when the transistor is mounted on an FR4 board (Cu area = 645 mm^2 , t = 1.6 mm).

*: New product

++: Being planned

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Note 2: Ultra-high-speed using by the Super Hi-Met process and Low VcE(sat) products.

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Transistors for Switching Power Supplies (For AC/DC Converters)

			Absolute Maximum	Ratings (Ta = 25°C)		
Part Number	Applications	VcBo (V)	VCEO (V)	Ic (A)	Pc (W) Tc = 25°C (* Ta = 25°C)	Package
2SC3425		500	400	0.8	10	TO-126
2SC5075		500	400	2	1.3♣	TPS
2SC5930				1	1*	MSTM
2SC6010			285	1	1*	MSTM
2SC6034				1	1*	MSTM
2SC5548			370	2	15	PW-Mold
2SC5548A				2	15	PW-Mold
2SC5208				0.8	1.3♣	TPS
2SC5458				0.8	10	PW-Mold
2SC4917		400		2	10	TO-126
TTC003 *		600	400	1.5	1.1♣	PW-Mold
2SC5459			400	3	25	TO-220NIS
2SC5266A				5	1.8♣	TPL
2SC5355				5	25	DP
2SC5172	Switching regulator			5	25	TO-220NIS
2SC5352				10	80	TO-3P(N)
2SC5351			450	2	1.3♣	TPS
2SC5368			450	2	10	TO-126
2SC6042			375	1	1*	MSTM
2SC6040		800	410	1	1.	MSTM
2SC6142 *			375	1.5	1.1♣	PW-Mold
2SC5465				0.8	20	PW-Mold
2SC5562				0.8	1.3♣	TPS
2SC5353				3	25	TO-220NIS
2SC5356		900	800	3	25	DP
2SC5361				3	40	TO-220FL
2SC5354				5	100	TO-3P(N)
2SC3307			 	10	150	TO-3P(L)
2SC5439		1000	450	8	30	TO-220NIS

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

^{*:} New product

Transistors for High-Voltage Power Supplies (For DC/DC Converters)

		Absolute Ma	aximum Rating	gs		hl	E		VCE (sat) (V)				
Part Number	Vory (\A)	VCEO (V)	Ic (A)	Pc (W)			VCE (V)	Io (A)		Ic (A)	IB (mA)	Package	
	VCEX (V)	VCEO (V)	IC (A)	PC (VV)	Min	Max	VCE (V)	Ic (A)	Max	IC (A)	IB (IIIA)		
2SC6061	150	120	1	0.625 (Note 1)	120	300	2	0.1	0.14	0.3	10	TSM	
TPCP8510 *	150	120	1	1.1 (Note 1)	120	300	2	0.1	0.14	0.3	10	PS-8	
TPCP8507	150	120	1	1.25 (Note 1)	120	300	2	0.1	0.14	0.3	10	PS-8	
2SC6076	160	80	3	10 (Note 2)	180	450	2	0.5	0.5	1	100	PW-Mold	
2SC6124	160	80	2	1 (Note 1)	100	200	2	0.5	0.5	1	100	PW-Mini	
2SC6079	160	80	2	1 (Note 3)	180	450	2	0.5	0.5	1	100	MSTM	
2SC6075	160	80	2.5	1.3 (Note 3)	180	450	2	0.5	0.5	1	100	TPS	
2SC6087	160	80	2.5	1.3 (Note 3)	100	200	2	0.5	0.5	1	100	TPS	
2SC6077	160	80	3	1.8 (Note 3)	180	450	2	0.5	0.5	1	100	TPL	
2SC6078	160	80	3	1.8 (Note 3)	100	200	2	0.5	0.5	1	100	TPL	

Note 1: The rating applies when the transistor is mounted on an FR4 board (Cu area = 645 mm², glass-epoxy, t = 1.6 mm).

*: New product

Note 2: Tc = 25°C Note 3: Ta = 25°C

• Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(Transistors for Droppers)

	Abso	lute Maximum Ra	atings		hF	E			VCE (sat) (V)			
Part Number	VCEO (V)	Ic (A)	Pc (W) Tc = 25°C	Min	Max	VCE (V)	Ic (A)	Max	Ic (A)	IB (mA)	Package	
2SB906	-60	-3	20	60	200	-5	-0.5	-1.7	-3	-300	PW-Mold	
2SB1667	-60	-3	25	60	300	-5	-0.5	-1.7	-3	-300	TO-220SM	
2SA2183	-60	-5	20	200	500	-2	-0.5	-1	-1.6	-53	TO-220SIS	
TTB001 *	-60	-3	30	100	250	-5	-0.5	-1.7	-3	-300	TFP	
TTB002 *	-60	-3	25	100	250	-5	-0.5	-1.7	-3	-300	PW-Mold	

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(High-Voltage Transistors)

	Abso	olute Maximum Ra	atings		Circuit Configuration	
Part Number	VCEO (V)	Ic (A)	Pc (W)	Package	(Top View)	Remarks
2SA1972	-400	-0.5	0.9	LSTM		
2SA1971	-400	-0.5	1	PW-Mini		
TPCP8604	-400	-0.3	1	PS-8		SMD
2SA1925	-400	-0.5	1.2	TPS		
2SA1923	-400	-0.5	10	PW-Mold	TPCP8604	
2SA2184	-550	-1	1	PW-Mold	8 7 6 5	SMD only
2SA1937	-600	-0.5	1	PW-Mold		Through-hole only
2SA2142	-600	-0.5	10	PW-Mold	PNP	SMD only
2SC5122	400	0.05	0.9	LSTM	1	
2SC5307	400	0.05	1	PW-Mini	1 2 3 4	
2SC5201	600	0.05	0.9	LSTM	1 2 3 4	SMD
2SC6127 *	800	0.05	10	PW-Mold		
2SC5465	800	0.8	20	PW-Mold		SMD only
2SC4686A	1200	0.05	10	TO-220NIS		
2SC5563	1500	0.02	10	TO-220NIS		

The circuit configuration diagrams only show the general configurations of the circuits.

*: New product

^{*:} New product

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Low Saturation Voltage Transistors (Small Surface-Mount Packages for Personal Equipments)

	lonago		Abso		num Ratings	iount i dont	J	hF				CE (sat) (V))		
Part Number	Configuration				Pc (mW)	Pc (mW)		•••			•	, , , ,		Marking	Package
	g	VCEO (V)	Ic (A)	ICP (A)	(Note 1)	(Note 1) t = 10 s	Min	Max	VCE (V)	Ic (A)	Max	Ic (A)	IB (mA)		
2SA2058		-10	-1.5	-2.5	500	750	200	500	-2	-0.2	-0.19	-0.6	-20	WM	
2SA2065	1	-20	-1.5	-2.5	500	750	200	500	-2	-0.15	-0.14	-0.5	-17	WK	
2SA2061	PNP single	-20	-2.5	-4	625	1000	200	500	-2	-0.5	-0.19	-1.6	-53	WE	
S3C83 ++	- v	-50	-1	-2	500	750	200	500	-2	-0.1	-0.18	-0.3	-10	WH	
2SA2056		-50	-2	-3.5	625	1000	200	500	-2	-0.3	-0.20	-1.0	-33	WF	
2SC5755		10	2	3.5	500	750	400	1000	2	0.2	0.12	0.6	12	WL	TSM
2SC5784		20	1.5	2.5	500	750	400	1000	2	0.15	0.12	0.5	10	WJ	<i>c</i>
2SC5738		20	3.5	6	625	1000	400	1000	2	0.5	0.15	1.6	32	WD	equivalent to
2SC5976		30	3	5	625	1000	250	400	2	0.3	0.14	1.0	33	WW	SC-59 SOT-23
2SC5906		30	4	7	800	1250	200	500	2	0.5	0.2	1.6	53	WP	(301-23)
2SC6062	NPN single	30	5	10	800	1250	250	400	2	0.5	0.12	1.6	53	WR	
S3C82 ++		50	1	2	500	750	400	1000	2	0.1	0.17	0.3	6	WG	
2SC5692		50	2.5	4	625	1000	400	1000	2	0.3	0.14	1.0	20	WB	
2SC6033		50	2.5	5	625	1000	250	400	2	0.3	0.18	1.0	33	WX	
2SC5703		50	4	7	800	1250	400	1000	2	0.5	0.12	1.6	32	WA	
2SC6061	1	120	1	2	625	1000	120	300	2	0.1	0.14	0.3	10	WN	
HN4B101J	DND - NDN	±30	-1/1.2	±5	550	850	200	500	±2	±0.12	-0.2/0.17	±0.4	13	5K	CAR!
HN4B102J	PNP + NPN	±30	-1.8/2	±8	750	750	200	500	±2	±0.2	-0.2/0.14	±0.6	±20	5L	SMV
2SA2066		-10	-2	-3.5	1000	2000	200	500	-2	-0.2	-0.19	-0.6	-20	4E	
2SA2069		-20	-1.5	-2.5	1000	2000	200	500	-2	-0.15	-0.14	-0.5	-17	4D	
2SA2059		-20	-3	-5	1000	2500	200	500	-2	-0.5	-0.19	-1.6	-53	4F	
2SA2070	PNP single	-50	-1	-2	1000	2000	200	500	-2	-0.1	-0.18	-0.3	-10	4C	
2SA2060		-50	-2	-3.5	1000	2500	200	500	-2	-0.3	-0.20	-1.0	-33	4G	
2SA2206		-80	-2	-4	1000	2500	100	200	-2	-0.5	-0.5	-1.0	-100	4K	PW-Mini
2SC5785		10	2	3.5	1000	2000	400	1000	2	0.2	0.12	0.6	12	3E	C
2SC5713		10	4	7	1000	2500	400	1000	2	0.5	0.15	1.6	32	2C	equivalent to SC-62
2SC5819		20	1.5	2.5	1000	2000	400	1000	2	0.15	0.12	0.5	10	3D	SOP-89
2SC6125		20	4	8	1000	2500	180	390	2	0.5	0.2	1.6	53	4L	C 301-07 J
2SC5714	NPN single	20	4	7	1000	2500	400	1000	2	0.5	0.15	1.6	32	2E	
2SC5810		50	1	2	1000	2000	400	1000	2	0.1	0.17	0.3	6	3C	
2SC6126		50	3	6	1000	2500	250	400	2	0.3	0.2	1.0	33	4M	
2SC5712		50	3	5	1000	2500	400	1000	2	0.3	0.14	1	20	2A	
2SC6124		80	2	4	1000	2500	100	200	2	0.5	0.5	1.0	100	4J	
TPC6501		10	2	3.5	800	1600	400	1000	2	0.2	0.12	0.6	12	H2A	
TPC6502		50	3	5	800	1600	400	1000	2	0.3	0.14	1	20	H2B	
TPC6503	NPN single	20	1.5	2.5	800	1600	400	1000	2	0.15	0.12	0.5	10	H2C	
S3F61 ++	. wi is single	10	4	6	800	1600	400	1000	2	0.5	0.15	1.6	32	_	
S3F62 ++	1	20	4	6	800	1600	400	1000	2	0.5	0.15	1.6	32	_	
TPC6504 *		50	1	2	800	1600	400	1000	2	0.1	0.17	0.3	6	H2D	VS-6
TPC6601]	-50	-2	-3.5	800	1600	200	500	-2	-0.3	-0.20	-1.0	-33	H3A	(equivalent to
TPC6602]	-10	-2	-3.5	800	1600	200	500	-2	-0.2	-0.19	-0.6	-20	H3B	TSOP-6)
TPC6603	PNP single	-20	-3	-5	800	1600	200	500	-2	-0.5	-0.19	-1.6	-53	H3C	0,
S3F56 ++	4	-20	-1.5	-2.5	800	1600	200	500	-2	-0.15	-0.14	-0.5	-17	_	
TPC6604 *		-50	-1	-2	800	1600	200	500	-2	-0.1	-0.18	-0.3	-10	H3D	
TPC6701	NPN/dual	50	1	2	660 (Note 2)	_	400	1000	2	0.1	0.17	0.3	6	H4A	
TPC6901A	PNP + NPN	±50	-0.7/1.0	±5	400	500	200/400	500/1000	±2	±0.1	-0.23/0.17	±0.3	-10/6	H6B	
TPC6902	. 741 1 141 14	±30	±2	±8	400	TBD	200	500	2	0.2	-0.2/0.14	±0.6	±20	H6C	

Note 1: The rating applies when the transistor is mounted on an FR4 board (Cu area = 645 mm², glass-epoxy, t = 1.6 mm). Note 2: Total loss of dual-device operation

*: New product

++: Being planned

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Low Saturation Voltage Transistors (Small Surface-Mount Packages for Personal Equipments) (Continued)

			Abso	lute Maxin	num Ratings			hF	E		V	CE (sat) (V))		
Part Number	Configuration	VCEO (V)	Ic (A)	ICP (A)	Pc (mW)	Pc (mW)			VCE (V)	Ic (A)		Ic (A)	IB (mA)	Marking	Package
		VCEO (V)	IC (A)	ICP (A)	(Note 1)	(Note 1) $t = 10 \text{ S}$	Min	Max	VCE (V)	IC (A)	Max	IC (A)	ів (ПІА)		
2SA2097		-50	-5	-10	20 (Note 3)	_	200	500	-2	-0.5	-0.27	-1.6	-53	A2097	
2SA1241	PNP single	-50	-2	-3	10 (Note 3)	_	70	240	-2	-0.5	-0.5	-1	-50	A1241	
2SA1244		-50	-5	-8	20 (Note 3)		70	240	-1	-1	-0.4	-3	-150	A1244	
2SC6076		80	3	5	10 (Note 3)		180	450	2	0.5	0.5	1	100	C6076	
2SC5886		50	5	10	20 (Note 3)		400	1000	2	0.5	0.22	1.6	32	C5886	
2SC5886A		50	5	10	20 (Note 3)		400	1000	2	0.5	0.22	1.6	32	C5886A	PW-Mold
2SC3076		50	2	3	10 (Note 3)		70	240	2	0.5	0.5	1	50	C3076	SC-63
2SC3474	NPN single	80	2	3	20 (Note 3)		500	_	1	0.4	0.5	0.3	1	C3474	30-03
2SC6052	INPIN SITIGIE	20	5	7	10 (Note 3)		180	390	2	0.5	0.2	1.6	53	C6052	
2SC3074		50	5	8	20 (Note 3)	_	70	240	1	1	0.4	3	150	C3074	
S3H32 ++		50	5	7	20 (Note 3)	_	200	500	2	0.5	0.2	1.6	53		
2SC3303		80	5	8	20 (Note 3)	_	70	240	1	1	0.4	3	150	C3303	
2SC6000		50	7	10	20 (Note 3)	_	250	400	2	2.5	0.18	2.5	83	C6000	
TPCP8501		100	2	4	1300	3300	100	300	2	0.3	0.2	1	33	8501	
TPCP8507	NPN single	120	1	2	1250	3000	120	300	2	0.1	0.14	0.3	10	8507	
TPCP8505	INPIN SITIGIE	50	3	5	1250	3000	400	1000	2	0.3	0.14	1	20	8505	
TPCP8504		10	2	3.5	1200	2800	400	1000	2	0.2	0.12	0.6	12	8504	
TPCP8601		-20	-4	-7	1300	3300	200	500	-2	-0.6	-0.19	-2	-67	8601	
TPCP8603	PNP single	-120	-1	-2	1250	3000	120	300	-2	-0.1	-0.2	-0.3	-10	8603	
TPCP8602		-50	-2.5	-4	1250	3000	200	500	-2	-0.3	-0.2	-1	-33	8602	
TPCP8701	NPN/dual	50	2	3	940	1770	400	1000	2	0.3	0.14	1	20	8701	
TPCP8801 ++	PNP/dual	-30	-1.2	-2	830	1480	200	500	-2	-0.12	-0.30	-0.4	-13	8801	
TPCP8H01 (Note 2)	NPN+	50	5	7	1000	2000	250	400	2	0.5	0.13	1.6	53	8H01	PS-8
TPCP8H02 (Note 2)	S-MOS	30	3	5	1000	2000	250	400	2	0.3	0.14	1	33	8H02	
TPCP8F01	PNP + S-MOS	-20	-3	-5	1000	_	200	500	-2	-0.5	-0.19	-1.6	-53	8F01	
TPCP8901		±50	-0.8/1.0	±5	830	1480	200/400	500/1000	±2	±0.1	-0.2/0.17	±0.3	-10/6	8901	1
TPCP8902 *	PNP + NPN	±30	±2	±8	890	1670	200	500	2	0.2	-0.2/0.14	±0.6	±20	8902	1
TPCP8L01 (Note 4)	NPN Darlington + HED	120	0.9	2	900	_	2000	9000	2	1	1.5	1	1	8L01	
TPCP8G01 (Note 5) *	PNP + Pch	-20	-3	-5	940	1770	200	500	-2	-0.5	-0.19	-1.6	-53	8G01	

Note 1: The rating applies when the transistor is mounted on an FR4 board (Cu area = 645 mm², glass-epoxy, t = 1.6 mm).

Note 2: Built-in SBD, VRRM = 30 V, Io = 0.7 A, VF = 0.4 V (max)@IF = 0.5 A, IR = 100 μ A (max)@VR = 10 V

^{++:} Being planned

Note 3: Tc = 25°C

Note 4: Built-in HED, VRRM = 200 V, IF(AV) = 1 A

Note 5: Pch MOS VDSS = -20 V, ID = -2 A, RoN = 130 m Ω Max

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(Power-Mold Transistors (SC-63/64))

		Ab	solute Maximum	Ratings ($Ta = 25^\circ$	°C)			
Part Number	Applications	V _{CEO}	Ic (A)	Pc (W)	⋆Pc (W)	Complementary	Equivalent Product	Remarks
2SA1225		-160	-1.5	1.0	15	2SC2983	_	
2SC2983	Power amplification for driver	160	1.5	1.0	15	2SA1225	_	
2SA1241		-50	-2.0	1.0	10	2SC3076	2SA1892	
2SC3076	Power amplification	50	2.0	1.0	10	2SA1241	2SC5029	
2SA1242		-20	-5.0	1.0	10	2SC3072 (* *)	2SA1893	
2SC3072	Strobe flash, power amplification	20	5.0	1.0	10	2SA1242 (★★)	2SC3420	
2SC4684		20	5.0	1.0	10		2SC5030	High β
2SA1244		-50	-5.0	1.0	20	2SC3074	2SA1905	
2SC3074		50	5.0	1.0	20	2SA1244	2SC5076	
2SA2097	High-current switching	-50	-5.0	1.0	20	_	_	High β
2SC5886		50	5.0	1.0	20	_	_	High β
2SC5886A		50	5	1.0	20	_	_	High β, Vcво = 120
2SB905		-150	-1.5	1.0	10	2SD1220	2SA1408	
2SD1220	TV vertical output, TV audio output (B) class	150	1.5	1.0	10	2SB905	2SC3621	
2SB906		-60	-3.0	1.0	20	2SD1221	2SB834	
2SD1221	Low-frequency power amplification	60	3.0	1.0	20	2SB906	2SD880	
TTB002 *	Switching, power amplification	-60	-3.0	1.0	25	_	_	
2SB907		-40	-3.0	1.0	15	2SD1222	_	Darlington type
2SD1222		40	3.0	1.0	15	2SB907	_	Darlington type
2SC6076	Switching, power amplification	80	3	_	10	_	_	
2SB908		-80	-4.0	1.0	15	2SD1223	_	Darlington type
2SD1223		80	4.0	1.0	15	2SB908	_	Darlington type
2SD1224	Power amplification	30	1.5	1.0	10	_	2SD2481	Darlington type
2SD1160	Motor control	50 (Усво)	2.0	1.0	10	_	_	
2SC3474	Switching, solenoid drive	80	2.0	1.0	20	_	_	
2SC3303	Switching	80	5.0	1.0	20	_	2SC3258	
2SA1923		-400	-0.5	1.0	10	_	2SA1925	
2SA2034		-400	-2	1.0	15	_	_	
2SA2184		-550	-1		10	_	_	
2SA2142		-600	-0.5	_	15	_	_	
2SC3075		400	0.8	1.0	10	_	2SC5208	
2SC5458		400	0.8	1.0	10	_	_	
2SC5548	High-voltage switching	370	2	1.0	15	_		
2SC5548A		400	2	1.0	15	_	_	
2SC6127		800	0.05	1.0	10	_	_	
2SC3405		800	0.8	1.0	20	_	_	
2SC5465		800	0.8	1.0	20	_		
2SC6142 *		375	1.5	1.1	_	_	_	
TTC003 *		400	3	1.1	_		_	

★: Tc = 25°C

*: New product

^{★ ★:} hFE classification varies

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

(PW-Mini Transistors (SC-62))

		Ab	solute I	Maximu	ım Ratir	ngs													Equiva	alent to	
Part N	lumber	Pc	Pc	Pc	VCEO	lc		hFE				Vce	(sat)		fт		Mar	king	TO-92	2MOD	Remarks/
		(W)	(W)	(W)	(V)	(A)			VCE	Ic	(V)	Ic	lв	(MHz)	VCE	Ic			(TO	-92)	Applications
NPN	PNP		(Note 1)	(Note 2)			Min	Max	(V)	(mA)	Max	(mA)	(mA)	Тур.	(V)	(mA)	NPN	PNP	NPN	PNP	
2SC2881	2SA1201	0.5	1.0	_	120	0.8	80	240	5	100	1.0	500	50	120	5	100	СП	D□	2SC2235	2SA965	Audio driver
2SC2882	2SA1202	0.5	1.0	_	80	0.4	70	240	2	50	0.4	200	20	120/100	10	10	E□	F□	(2SC1627)	(2SA817)	Low saturation
2SC2883	2SA1203	0.5	1.0	_	30	1.5	100	320	2	500	2.0	1500	30	120	2	500	G□	Η□	2SC2236	2SA966	Audio driver
2SC2884	2SA1204	0.5	1.0	_	30	0.8	100	320	1	100	0.5/0.7	500	20	120	5	10	P□	R□	(2SC2120)	(2SA950)	Low saturation
2SC3515	2SA1384	0.5	1.0	_	300	0.1	30	150	10	20	0.5	20	2	60	10	20	□	J	(2SC2551)	(2SA1091)	Low saturation
2SC3803	2SA1483	0.5	1.0	_	45	0.2	40	240	1	10	0.3	100	10	200	10	10	۷□	w□		_	Low saturation
_	2SA1734	0.5	1.0	_	30	1.2	120	400	2	100	0.5	700	35	100	2	100	I	LB			Low saturation
2SD1784		0.5	1.0	_	30	1.5	4000	ı	2	150	1.5	1000	1	_	I	_	XN		2SD1140		Driver (Darlington)
2SC5785		-	_	1	10	2	400	1000	2	200	0.12	600	12	_	-	_	3E	-			Low saturation
_	2SA2066	-	_	1	-10	-2	200	500	-2	-200	-0.19	-600	-20	_	-	_	ı	4E			Low saturation
2SC5713	_		_	1	10	4	400	1000	2	500	0.15	1600	32	_		_	2C	_	_		Low saturation
2SC5819	_	_	_	1	20	1.5	400	1000	2	150	0.12	500	10	_	_	_	3D	_	_	_	Low saturation
_	2SA2069	ı	_	1	-20	-1.5	200	500	-2	-150	-0.14	-500	-17	_	ı	_	ı	4D		_	Low saturation
2SC6125	_	I	_	1	20	4	180	390	2	500	0.20	1800	53	_	I	_	4L				High-speed switching
2SC5714	_	I	_	1	20	4	400	1000	2	500	0.15	1600	32	_	I	_	2E				Low saturation
_	2SA2059	I	_	1	-20	-3	200	500	-2	-500	-0.19	-1600	-53	_	I	_	I	4F			Low saturation
2SC6126	_	I	_	1	50	3	250	400	2	300	0.18	1000	33	_	I	_	4M				High-speed switching
2SC5712		I	_	1	50	3	400	1000	2	300	0.14	1000	20	_	I	_	2A				Low saturation
_	2SA2060	I	_	1	-50	-2	200	500	-2	-300	-0.20	-1000	-33	_	I	_	ı	4G			Low saturation
2SC5810	_	_	_	1	50	1	400	1000	2	100	0.17	300	6	_	_	_	3C	_	_	_	Low saturation
_	2SA2070			1	-50	-1	200	500	-2	-100	-0.18	-300	-10	_		_		4C		_	Low saturation
2SD2686	_	-		1	60±10	1	2000	_	2	1000	1.5	1000	1	_	_	_	3H	_	_	_	Darlington
2SC6124	_	_	_	1	80	2	100	200	2	500	0.5	1000	100	_	_	_	4J	_	_	_	Low saturation
_	2SA2206	_	_	1	-80	-2	100	200	-2	-500	-0.5	-1000	-100	_	_	_	_	4K			Low saturation

Note: The hrɛ classification that appears instead of the 🚨 shown in the Marking column will be one of the following: A, B, C, D, O, R or Y, according to the rank.

(TSM Transistors)

Part Number		Absolu	te Maximum R	atings			hl	E			VCE (sat) (V))		Remarks/
NPN	VCEO (V)	Ic (A)	ICP (A)	Pc (mW) (Note 1)	Pc (mW) (Note 1) t = 10s	Min	Max	VCE (V)	Ic (A)	Max	Ic (A)	IB (mA)	Marking	Applications
2SA2058	-10	-1.5	-2.5	500	750	200	500	-2	-0.2	-0.19	-0.6	-20	WM	Low saturation
2SA2065	-20	-1.5	-2.5	500	750	200	500	-2	-0.15	-0.14	-0.5	-17	WK	Low saturation
2SA2061	-20	-2.5	-4	625	1000	200	500	-2	-0.5	-0.19	-1.6	-53	WE	Low saturation
S3C83 ++	-50	-1	-2	500	750	200	500	-2	-0.1	-0.18	-0.3	-10	WH	Low saturation
2SA2056	-50	-2	-3.5	625	1000	200	500	-2	-0.3	-0.20	-1.0	-33	WF	Low saturation
2SC5755	10	2	3.5	500	750	400	1000	2	0.2	0.12	0.6	12	WL	Low saturation
2SC5784	20	1.5	2.5	500	750	400	1000	2	0.15	0.12	0.5	10	WJ	Low saturation
2SC5738	20	3.5	6	625	1000	400	1000	2	0.5	0.15	1.6	32	WD	Low saturation
2SC5976	30	3	5	625	1000	250	400	2	0.3	0.14	1.0	33	ww	Ultra-high-speed switching Low saturation voltage
2SC5906	30	4	7	800	1250	200	500	2	0.5	0.2	1.6	53	WP	Ultra-high-speed switching Low saturation voltage
2SC6062 *	30	5	10	800	1250	250	400	2	0.5	0.12	1.6	53	WR	Ultra-high-speed switching Ultra-low saturation voltage
S3C82 ++	50	1	2	500	750	400	1000	2	0.1	0.17	0.3	6	WG	Low saturation
2SC5692	50	2.5	4	625	1000	400	1000	2	0.3	0.14	1.0	20	WB	Low saturation
2SC6033	50	2.5	5	625	1000	250	400	2	0.3	0.18	1.0	33	WX	Ultra-high-speed switching Low saturation voltage
2SC5703	50	4	7	800	1250	400	1000	2	0.5	0.12	1.6	32	WA	Low saturation
2SD2719	60 ± 10	0.8	3	800	1250	2000		2	1.0	1.5	1	1	WV	Darlington
2SC6061	120	1	2	625	1000	120	300	2	0.1	0.14	0.3	10	WN	Low saturation

Note 1: The rating applies when the transistor is mounted on an FR4 board (Cu area = 645 mm^2 , glass-epoxy, t = 1.6 mm).

*: New product

Note 1: The rating applies when the transistor is mounted on a ceramic board (250 mm² x 0.8 mm).

Note 2: The rating applies when the transistor is mounted on a glass-epoxy board (645 mm² x 1.6 mm).

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Radio-Frequency Bipolar Small-Signal Transistors

Radio-Frequency Bipolar Transistors

			Absolut	e Maximum	Ratings (Ta =	= 25°C)		TO-92	Remarks
Part Number	Package	Applications	Vceo	Ic	Pc	Tj	Marking	Equivalent	(Mini Transistors)
			(V)	(mA)	(mW)	(°C)		Product	(WIIII TTATISISIOTS)
2SC2714		FM-band radio-frequency amps	30	20	100	125	Q□	2SC1923	
2SC2715		AM frequency converter, FM IF amps	30	50	150	125	R□	2SC380TM	
2SC2716		AM radio-frequency amps	30	100	150	125	F□	2SC941TM	
2SC3123		VHF TV frequency converters	20	50	150	125	HE	2SC3136	ft = 1.4 GHz
2SC5064	S-MINI	VHF/UHF-band low-noise amps	12	30	150	125	MA□	_	ft = 7 GHz
2SC5084	2.9	VHF/UHF-band low-noise amps	12	80	150	125	MC□	_	ft = 7 GHz
2SC5089	7	VHF/UHF-band low-noise amps	10	40	150	125	MD□	_	ft = 10 GHz
2SC5094	15 25	VHF/UHF-band low-noise amps	10	15	150	125	ME□	_	ft = 10 GHz
2SC5106	↓ <u>**</u> ∃ ∃	VHF/UHF oscillators	10	30	150	125	MF□	_	ft = 6 GHz
2SC5109		VHF/UHF oscillators	10	60	150	125	MG□	_	ft = 5 GHz
MT3S03A		VHF/UHF band, low voltage operation, low phase noise	5	40	150	125	MR	_	fT = 10 GHz
MT3S04A		VHF/UHF band, low voltage operation, low phase noise	5	40	150	125	AE	_	ft = 7 GHz
MT3S106		VHF/UHF band low noise, low distortion amps	6	80	700 (Note 1)	150	R2	_	ft = 13 GHz
2SC5087	SMQ	VHF/UHF-band low-noise amps	12	80	150	125	СП	_	ft = 7 GHz
2SC5087R	2.9	VHF/UHF-band low-noise amps	12	80	150	125	ZP	_	ft = 7 GHz
2SC5092		VHF/UHF-band low-noise amps	10	40	150	125	D□	_	ft = 10 GHz
MT4S03A	2.9	VHF/UHF band, low voltage operation, low phase noise	5	40	150	125	MR	_	ft = 10 GHz
MT4S04A	¥ □ □	VHF/UHF band, low voltage operation, low phase noise	5	40	150	125	AE	_	fT = 7 GHz
2SC4215		FM-band radio-frequency amps	30	20	100	125	Q□	2SC1923	$f\tau = 550 \text{ MHz}$
2SC4250		VHF TV frequency converters	20	50	100	125	HE	2SC3136	ft = 1.4 GHz
2SC5065		VHF/UHF-band low-noise amps	12	30	100	125	MA□	_	fT = 7 GHz
2SC5085	LICM	VHF/UHF-band low-noise amps	12	80	100	125	MC□	_	ft = 7 GHz
2SC5090	USM	VHF/UHF-band low-noise amps	10	40	100	125	MD□	_	fT = 10 GHz
2SC5095		VHF/UHF-band low-noise amps	10	15	100	125	ME□	_	ft = 10 GHz
2SC5107	5 8	VHF/UHF oscillators	10	30	100	125	MF□	_	fT = 6 GHz
2SC5110		VHF/UHF oscillators	10	60	100	125	MG□	_	ft = 5 GHz
2SC5463		VHF/UHF-band low-noise amps	12	60	100	125	MX/MY	_	ft = 7 GHz
MT3S03AU		VHF/UHF band, low voltage operation, low phase noise	5	40	100	125	MR	_	ft = 10 GHz
MT3S04AU		VHF/UHF band, low voltage operation, low phase noise	5	40	100	125	AE	_	ft = 7 GHz
MT3S16U		UHF-band, low-voltage oscillators and amplifiers	5	60	100	125	T4	_	ft = 4 GHz

 \square : Denotes a hFE class.

Note 1: Mounted on a ceramic board

 $[\]bullet\;$ The products shown in bold are also manufactured in offshore fabs.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Radio-Frequency Bipolar Transistors (Continued)

	, ,		Absolu	te Maximum	Ratings (Ta =	= 25°C)		TO-92	
Part Number	Package	Applications	V _{CEO} (V)	Ic (mA)	P _C (mW)	T _j (°C)	Marking	Equivalent Product	Remarks
2SC5088	USQ	VHF/UHF-band low-noise amps	12	80	100	125	MC□	_	ft = 7 GHz
2SC5319	2.0 →	VHF/UHF-band low-noise amps	5	20	100	125	MT	_	ft = 16 GHz
MT4S03AU		VHF/UHF band, low voltage operation, low phase noise	5	40	100	125	MR		ft = 10 GHz
MT4S06U	1.25	VHF/UHF band, low voltage operation, low noise	5	15	60	125	AC	_	ft = 10 GHz
MT4S32U	↓ ▼ □□□	VHF/UHF band, low voltage operation, low noise	4.5	15	67.5	125	U4		ft = 16 GHz
2SC4915		FM-band radio-frequency amps	30	20	100	125	Q 🗆	2SC1923	ft = 550 MHz
2SC5066		VHF/UHF-band low-noise amps	12	30	100	125	M1/M2	2301723	ft = 7 GHz
2SC5086		VHF/UHF-band low-noise amps	12	80	100	125	M5/M6	_	ft = 7 GHz
2SC5091		VHF/UHF-band low-noise amps	10	40	100	125	M7/M8	_	ft = 10 GHz
2SC5096	SSM	VHF/UHF-band low-noise amps	10	15	100	125	M9/MA	_	ft = 10 GHz
2SC5108	1.6	VHF/UHF oscillators	10	30	100	125	MB/MC	_	fT = 6 GHz
2SC5111	, j _® † ====================================	VHF/UHF oscillators	10	60	100	125	MD/ME		ft = 5 GHz
2SC5322		VHF/UHF-band low-noise amps	5	10	100	125	MU	_	fT = 15.5 GHz
2SC5464	· · ·	VHF/UHF-band low-noise amps	12	60	100	125	MX/MY		ft = 7 GHz
MT3S03AS		VHF/UHF band, low voltage operation, low phase noise	5	40	100	125	MR		ft = 10 GHz
MT3S04AS		VHF/UHF band, low voltage operation, low phase noise	5	40	100	125	AE	_	ft = 7 GHz
MT3S06S		VHF/UHF band, low voltage operation, low noise	5	15	60	125	AC	_	ft = 10 GHz
2SC4250FV	VESM	VHF TV frequency converters	20	50	150	125	HE	2SC3136	fr = 1.4 GHz
MT3S03AFS		VHF/UHF band, low voltage operation, low phase noise	5	40	85 (Note 1)	125	00	_	ft = 10 GHz
MT3S04AFS		VHF/UHF band, low voltage operation, low phase noise	5	40	85 (Note 1)	125	01	_	ft = 7 GHz
MT3S05FS		VHF/UHF band, low voltage operation, low phase noise	5	40	85 (Note 1)	125	02	_	ft = 4.5 GHz
MT3S06FS		VHF/UHF band, low voltage operation, low noise	5	15	85 (Note 1)	125	03	_	ft = 10 GHz
MT3S07FS	fSM	VHF/UHF band, low voltage operation, low noise	5	25	85 (Note 1)	125	04	_	fT = 12 GHz
MT3S11FS	 <0.6	VHF/UHF band, low voltage operation, low phase noise	6	40	85 (Note 1)	125	08	_	ft = 6 GHz
MT3S12FS	_ ↑ <u>_</u> ★	VHF/UHF band, low voltage operation, low phase noise	6	40	85 (Note 1)	125	09	_	ft = 7 GHz
MT3S14FS	0.1 0.8	VHF/UHF band, low voltage operation, low noise	2.5	30	85 (Note 1)	125	0H	_	fτ = 11 GHz
MT3S16FS	¥	UHF-band, low-voltage oscillators and amplifiers	5	60	85 (Note 1)	125	0K	_	ft = 4 GHz
MT3S35FS		VHF/UHF band, low voltage operation, low noise	4.5	24	100 (Note 1)	150	20	_	ft = 20 GHz
MT3S36FS		VHF/UHF band, low voltage operation, low noise	4.5	36	100 (Note 1)	150	21		ft = 19 GHz
MT3S37FS MT3S41FS		VHF/UHF band, low voltage operation, low noise VHF/UHF band, low voltage operation, low noise	4.5 4.5	50 80	100 (Note 1) 100 (Note 1)	150 150	22 26		fτ = 19 GHz fτ = 15 GHz
MT3S11CT	CST3	VHF/UHF band, low voltage operation, low phase noise	6	40	105 (Note 1)	125	08	_	ft = 6 GHz
MT3S15TU *	UFM	VHF/UHF-band low-noise amps	6	80	900 (Note 2)	150	Т3	_	fτ = 11.5 GHz
MT3S19TU *	12 12 12 12 12 12 12 12 12 12 12 12 12 1	VHF/UHF-band low-noise amps	6	80	900 (Note 2)	150	T6	_	fτ = 11 GHz
MT3S20TU *	↓	VHF/UHF-band low-noise amps	12	80	900 (Note 2)	150	MU	_	fT = 7 GHz
MT3S19 *	S-MINI S-MINI	VHF/UHF-band low-noise amps	6	80	800 (Note 2)	150	Т6	_	fτ = 12 GHz
MT3S20P *	Pw-Mini	VHF/UHF-band low-noise amps	12	80	1800 (Note 2)	150	MU		ft = 7 GHz
MT3S21P *	4.2	VHF/UHF-band low-noise amps	6	80	1800 (Note 2)	150	T2	_	ft = 9 GHz
MT3S22P *		VHF/UHF-band low-noise amps	6	80	1800 (Note 2)	150	T5	_	fT = 8.5 GHz
☐: Denotes a hfe class.								*: Nev	product

^{☐:} Denotes a hfe class.

Note 1: When mounted on a glass-epoxy PCB board

Note 2: Mounted on a ceramic board

^{*:} New product

[•] The products shown in **bold** are also manufactured in offshore fabs.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Dual Radio-Frequency Bipolar Transistor

		Absolute M	laximum Ratings (Ta = 25°C)	Structure	fr			
Part Number	Package	VCEO (Q1/Q2) (V)	Ic (Q1/Q2) (mA)	Pc★ (mW)	(Q1/Q2)	(Q1/Q2) (GHz)	◆ Internal Connections	Marking	
MT6L63FS		5/6	25/40	110 (Note 1)	MT3S07FS/MT3S11FS	12/4.5		18	
MT6L64FS		4.5/6	24/40	110 (Note 1)	MT3S35FS/MT3S11FS	19.5/6		19	
MT6L65FS		4.5/6	36/40	110 (Note 1)	MT3S36FS/MT3S11FS	20/6		1F	
MT6L67FS	fS6	4.5/6	36/80	110 (Note 1)	MT3S36FS/MT3S106FS	20/8.5		1J	
MT6L68FS	1.0	5/6	15/40	110 (Note 1)	MT3S06FS/MT3S11FS	10/4.5		1K	
MT6L70FS	├	4.5/6	20/80	110 (Note 1)	MT3S107FS/MT3S106FS	16.5/8.5		1U	
MT6L71FS	0 8	5/6	25/40	105 (Note 1)	MT3S07FS/MT3S11AFS	12/4.5		1W	
MT6L72FS	★ <u>₩</u>	4.5/6	36/40	105 (Note 1)	MT3S36FS/MT3S11AFS	19/4.5		1X	
MT6L75FS		5/6	25/80	110 (Note 1)	MT3S07FS/MT3S106FS	12/8.5		52	
MT6L76FS		5/6	15/80	110 (Note 1)	MT3S06FS/MT3S106FS	10/8.5		53	
MT6L77FS			6/6	40/80	110 (Note 1)	MT3S11FS/MT3S106FS	6/8.5		54
MT6L78FS		6/6	40/40	105 (Note 1)	MT3S11FS/MT3S11AFS	6/6		55	
MT6L77FST	fS6T	6/6	40/80	140	MT3S11FS/MT3S106FS	6/8.5		54	

[★]Pc: Total power dissipation

Note 1: When mounted on a glass-epoxy PCB board

SiGe HBTs

			Absolu	te Maximum	Ratings (Ta =	= 25°C)		
Part Number	Package	Applications	VCEO	Ic	Pc	Tj	Marking	Remarks
			(V)	(mA)	(mW)	(°C)		
MT4S100U	USQ	VHF/UHF band, low voltage operation, low noise	3	15	100	150	P6	ft = 22 GHz
MT4S101U	2.0 →	VHF/UHF band, low voltage operation, low noise	3	10	100	150	P7	ft = 21 GHz
MT4S102U	↑ □ □ □	UHF/SHF band, low voltage operation, low noise	3	20	100	150	P8	ft = 24 GHz
MT4S104U	1.2 2.1	UHF/SHF band, low voltage operation, low noise	3	10	100	150	P1	ft = 23 GHz
MT4S200U	↓	UHF/SHF band, low voltage operation, low noise	4	35	140 (Note 1)	150	P2	ft = 30 GHz
MT4S100T	TESQ	VHF/UHF band, low voltage operation, low noise	3	15	100	150	P6	ft = 23 GHz
MT4S101T	1.2	VHF/UHF band, low voltage operation, low noise	3	10	100	150	P7	ft = 23 GHz
MT4S102T		UHF/SHF band, low voltage operation, low noise	3	20	100	150	P8	ft = 25 GHz
MT4S104T	0.9	UHF/SHF band, low voltage operation, low noise	3	10	100	150	P1	fT = 25 GHz
MT4S200T	¥ * ' '	UHF/SHF band, low voltage operation, low noise	4	35	100	150	P2	fT = 30 GHz
MT3S106FS	fSM	UHF/SHF band, low voltage operation, low noise	6	80	100 (Note 1)	150	41	ft = 8.5 GHz
MT3S107FS	S-MINI	UHF/SHF band, low voltage operation, low noise	4.5	20	100 (Note 1)	150	42	ft = 16.5 GHz
MT3S111 *	S-MINI	VHF/UHF band, low noise, low distortion	6	100	700 (Note 1)	150	R5	fτ = 11.5 GHz
MT3S113 *	15 28	VHF/UHF band, low noise, low distortion	5.3	100	800 (Note 1)	150	R7	fτ = 12.5 GHz
MT3S111TU *	UFM	WITH III bond low poice low distortion	6	100	800 (Note 1)	150	R5	fτ = 10 GHz
MT3S113TU *	12 L2	VHF/UHF band, low noise, low distortion		100	900 (Note 1)	150	R7	ft = 11 GHz
MT3S111P *	Pw-Mini		6	100	1000 (Note 1)	150	R5	ft = 8 GHz
MT3S113P *	45 25 25 25 25	VHF/UHF band, low noise, low distortion	5.3	100	1600 (Note 1)	150	R7	fr = 8.5 GHz

63

Note 1: When mounted on a glass-epoxy PCB board

*: New product

[◆]The internal connection diagrams only show the general configurations of the circuits.

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

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Radio-Frequency Small-Signal FETs

Radio-Frequency MOSFETs

Part Number	Package	Applications	VDS	Electrical ID	Characteristics (T	a = 25°C)	Yfs	Marking	Equivalent Product
i ait number	1 ackage	Аррисацонз	(V)	(mA)	(mW)	(mA)	(mS) Typ.	Warking	(Leaded Type)
3SK232	SMQ ✓ 2.9	TV UHF radio-frequency amps	12.5	30	150	0 to 0.1	21	UO	_
3SK291	112	TV UHF radio-frequency amps	12.5	30	150	0 to 0.1	26	UF	_
3SK292		TV VHF/UHF radio-frequency amps	12.5	30	150	0 to 0.1	23.5	UV	_
3SK249	USQ 2.0	TV UHF radio-frequency amps	12.5	30	100	0 to 0.1	21	UO	
3SK293	12 12 13 14 14 14 14 14 14 14 14 14 14 14 14 14	TV UHF radio-frequency amps	12.5	30	100	0 to 0.1	26	UF	
3SK294		TV VHF/UHF radio-frequency amps	12.5	30	100	0 to 0.1	23.5	UV	

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Radio-Frequency Junction FETs

				Electrical	Characteristics (T	a = 25°C)			Equivalent
Part Number	Package	Applications	VGDO	lg ,	PD	IDSS	Yfs	Marking	Product
			Vgds ◊ (V)	(mA)	(mW)	(mA)	(mS) Typ.		(Leaded Type)
2SK210	S-MINI	FM radio-frequency amps	-18	10	100	3.0 to 24	7	Y□	
2SK211	112	FM radio-frequency amps	-18	10	150	1.0 to 10	9	К□	
2SK711	↓	AM radio-frequency amps	-20♦	10	150	6 to 32	25	RB□	2SK709
2SK1875	USM 20 TI	AM radio-frequency amps	-20 ◊	10	100	6 to 32	25	RB□	2SK709

^{□:} Denotes a loss class.

- The products shown in bold are also manufactured in offshore fabs.
 Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Radio-Frequency Power MOSFETs

Radio-Frequency Power MOSFETs

			Absolute N	aximum Ratings	(Tc = 25°C)		Po	(W)	
Part Number	Package	Applications	Voce	Pp	lo.			Test Conditions	
Part Number	Раскауе	Аррисация	Vdss (V)	(W)	ID (A)	Min	VDD	f	Pi
			(*)	(**)	()		(V)	(MHz)	(W)
RFM08U9X *	PW-X		36	20	5	7.5	9.6	520	0.5
2SK3075	PW-X	UHF/VHF Professional radios	30	20	5	7.5	9.6	520	0.5
2SK3074	PW-MINI		30	3	1	0.63	9.6	520	0.02
2SK3476	PW-X		20	20	3	7.0	7.2	520	0.5
2SK3475	PW-MINI		20	3	1	0.63	7.2	520	0.02
2SK4037	PW-X	GMRS	12	20	3	3.55	6.0	470	0.3
2SK2855	PW-MINI	UHF/VHF	10	0.5	1.0	1.26	6.0	849	0.2
2SK2854	PW-MINI	Professional radios	10	0.5	0.5	0.2	6.0	849	0.02
2SK3079A	PW-X		10	20	3	2.24	4.5	470	0.1
2SK3756	PW-MINI	FRS/GMRS	7.5	3	1	1.26	4.5	470	0.1
2SK3078A	PW-MINI		10	3	0.5	0.63	4.5	470	0.1
2SK3077	USQ	Driver	10	0.25	0.1	0.032	4.8	915	0.001
2SK3656	PW-MINI	FRS/GMRS	5	3	0.5	0.50	3.6	470	0.02

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Radio-Frequency Bipolar Power Transistors

			Absolute N	aximum Ratings ((Tc = 25°C)		Po	(W)	
Part Number	Package	Applications	Vcво	Pc	lo.			Test Conditions	
i ait ivambei	1 ackage	Аррисацопз	(V)	(W)	Ic (A)	Min	Vcc	f	Pi
			(V)	(00)	(A)		(V)	(MHz)	(W)
2SC2782A	2-13C1A	175 MHz Marine radios Professional radios Amateur radios	36	220	20	80	12.5	175	18

Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

	Package	Applications	Absolute N	laximum Ratings	Tc = 25°C)	Pi (WPEP)				
Part Number			VcBo	Pc (W)	Ic (A)	Max	Test Conditions			
			(V)				Vcc (V)	f (MHz)	Po (WPEP)	
							(V)	(IVIHZ)	(WPEP)	
2SC2510A	2-13B1A	27 to 50 MHz	60	250	20	9	28	28	150	
2SC2879A	2-13B1A	CB radios	45	250	25	10	12.5	28	100	
2SC2290A	2-13B1A	Amateur radios	45	175	20	4	12.5	28	60	

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

^{*:} New product

IGBTs

IGBTs (Discrete IGBTs)

Part Number	Application:	S	Features	Vces	Absolute Maximum Ratings		(Ta = 25°C)		
Part Number		AC Voltage	realules	(V)	DC (A) Pulse (A)		Ta = 25°C (W)	Tc = 25°C (W)	
GT10J321		AC VUIIAYE		(V)	10	20	1a - 25 C (W)	29 29	
GT15J321					15	30	_	30	
GT15J331	1				15	30	_	70	
GT20J321	1				20	40	_	45	
GT30J121	Power supplies (and UPS	S/PFC/Motor)	High-speed switching	600	30	60	_	170	
GT30J126 *					30	60	_	90	
GT30J324					30	60	_	170	
GT50J121					50	100	_	240	
GT50J325					50	100	_	240	
GT10Q101					10	20	_	140	
GT10Q301					10	20	_	140	
GT15Q102			High ruggedness	1200	15	30	_	170	
GT15Q301			3 . 33		15	30	_	170	
GT25Q102					25	50	_	200	
GT25Q301					25	50	_	200	
GT5J301					5	10	_	28	
GT5J311					5	10	_	45	
GT10J301	Motor drives (and III	DC/DEC)			10	20	_	90	
GT10J303 GT10J312	Motor drives (and UI	PS/PFC)			10	20	_	30	
GT15J301					10	20	_	60	
GT15J301	1		High ruggedness		15 15	30 30	_	35 70	
GT20J101	1				20	40	_	130	
GT20J301	1				20	40		130	
GT30J101					30	60		155	
GT30J301					30	60		155	
GT50J102	1				50	100	_	200	
GT50J301	1				50	100		200	
GT30J122	Power factor corre	ection	Low VcE(sat)	600	30	100	_	75	
GT30J322	Power factor con	0011011	Current resonance		30	60	_	75	
GT35J321		AC200 V			37	100	_	75	
GT40J321					40	100	_	110	
GT40J322					40	100	_	110	
GT40J323 *					40	100	_	120	
GT50J322					50	100	_	130	
GT50J322H	-				50	100	_	130	
GT50J327					50	100	_	140	
GT50J328					50	120	_	140	
GT60J321					60	120	_	200	
GT60J323	IH rice cookers,				60	120	_	170	
GT60J323H	IH cooktops,				60	120	_	170	
GT15M321	Microwave ovens,				15	30	_	55	
GT50M322	Induction heating equipment			900	50	120	_	150	
GT60M323					60	120	_	200	
GT60M303					60	120	_	170	
GT60M324 *		AC100 V			60	120	_	120	
GT50N321			Voltage resonance	1000	50	120	_	156	
GT50N322A			g.		50	120	_	156	
GT50N324 *					50	120		150	
GT60N321					60	120		170	
GT60N322 GT40Q321			4	1200	57	120	_	200	
GT40U321 GT40T302 *		AC200 V		1200 1500	40 40	80 80	_	170 200	
GT5G133 *	Digital still same	coll phono		1000					
GT8G132 *	Digital still cameras, o	eii pnone	4			130	0.83	_	
GT8G133	1		Strobe flash			150 150	1.1 0.6	_	
GT8G134	Digital still came		(dimming control)	400		150	0.6		
GT8G136	single lens reflex ca	ameras	(diffining control)			150	0.6	_	
GT10G131						200	1.1	_	
GT30F122						120	2.0	25	
GT30F123 *						200	2.0	25	
GT45F122	1			300		200	2.0	25	
GT45F123	1					200	2.0	26	
GT45F124	1				_	200	2.0	29	
GT45F125	1					200	2.0	29	
GT45F127 *	1			300	_	200	2.0	26	
GT45F131 *	1		DDDt-'	300	_	200	2.0	160	
GT30G122	PDP-TV		PDP sustain, energy recovery	400	_	120	2.0	25	
GT30G123 *	1		and separation circuits	430	_	200	2.0	25	
	1				_	200	2.0	25	
	1			400	_	200	2.0	26	
GT45G122	İ			400			2.0	29	
GT45G122 GT45G123					_	200	2.0		
GT45G122 GT45G123 GT45G124						200			
GT45G122 GT45G123 GT45G124 GT45G125				430		200	2.0	29 26	
GT45G122 GT45G123 GT45G124 GT45G125					_	200	2.0	29	

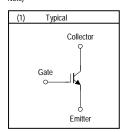
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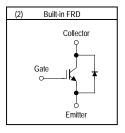
^{★:} IEGT: Injection Enhanced Gate Transistor

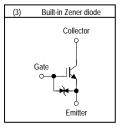
• Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

Package		Circuit	VCE(sat)	Typ. @Ta		tf Typ.	@Ta = 25°C	Remarks	
Г	Туре	Configuration (Note)	(V)	@lc (A)	@V _{GE} (V)	(µS)	Test Conditions	Remarks	
TO-220NIS	Isolation, Through-hole	(2)	2.0	(A) 10	(V) 15	(μs) 0.05		NPT design	
	Isolation, Through-hole	(2)	1.9	15	15	0.03		NPT design	
TO-220NIS	SMD	(2)	1.75	15	15	0.10	1	Low Vce (sat), NPT design	
	Isolation, Through-hole	(2)	2.0	20	15	0.04		NPT design	
TO-3P(N)	Through-hole	(1)	2.0	30	15	0.05	1	NPT design	
TO-3P(N)IS	Isolation, Through-hole	(1)	1.95	30	15	0.05		NPT design	
TO-3P(N)	Through-hole	(2)	2.0	30	15	0.05		NPT design	
TO-3P(LH)	Through-hole	(1)	2.0	50	15	0.05		NPT design	
TO-3P(LH)	Through-hole	(2)	2.0	50	15	0.05		NPT design	
TO-3P(N)	Through-hole	(1)	2.1	10	15	0.16		NPT design	
TO-3P(N)	Through-hole	(2)	2.1	10	15	0.16		NPT design	
TO-3P(N)	Through-hole	(1)	2.1	15	15	0.16		NPT design	
TO-3P(N)	Through-hole	(2)	2.1	15	15	0.16		NPT design	
TO-3P(LH) TO-3P(LH)	Through-hole Through-hole	(1)	2.1	25 25	15 15	0.16 0.16	Inductive load	NPT design NPT design	
	·		2.1	5	15	0.16		NPT design	
TO-220NIS	Isolation, Through-hole SMD	(2)	2.1	5	15	0.15			
TO-220SIVI TO-3P(N)	Through-hole	(2)	2.1	10	15	0.15	1		
	Isolation, Through-hole	(2)	2.1	10	15	0.15	1		
TO-220NI3	SMD	(2)	2.1	10	15	0.15	1		
	Isolation, Through-hole	(2)	2.1	15	15	0.15	1		
TO-220NIS	SMD	(2)	2.1	15	15	0.15	1		
TO-3P(N)	Through-hole	(1)	2.1	20	15	0.15	1		
TO-3P(N)	Through-hole	(2)	2.1	20	15	0.15	1		
TO-3P(N)	Through-hole	(1)	2.1	30	15	0.15]		
TO-3P(N)	Through-hole	(2)	2.1	30	15	0.15			
TO-3P(LH)	Through-hole	(1)	2.1	50	15	0.15			
TO-3P(LH)	Through-hole	(2)	2.1	50	15	0.15			
	Isolation, Through-hole	(1)	2.1	50	15	0.25			
	Isolation, Through-hole	(2)	2.1	50	15	0.25]		
	Isolation, Through-hole	(2)	1.9	50	15	0.19]		
TO-3P(N)	Through-hole	(2)	2.1	40	15	0.15		High speed, Mount the GT50J322H	
TO-3P(N)	Through-hole	(2)	1.7	40	15	0.20		Mount the GT50J322 chip	
TO-3P(N)	Through-hole	(2)	2.0	40	15	0.06		5th generation	
TO-3P(LH)	Through-hole	(2)	2.1	50	15	0.25	-	I link and and	
TO-3P(N)	Through-hole	(2)	2.2	50	15	0.16	-	High speed	
TO-3P(N)	Through-hole	(2)	1.9	50	15	0.19	-	High anged Mayet the CT/0/00011	
TO-3P(N)	Through-hole	(2)	2.0 1.55	50 60	15 15	0.11	1	High speed, Mount the GT60J323H	
TO-3P(LH) TO-3P(LH)	Through-hole Through-hole	(2)	1.55	60	15	0.30	1	LOW VCE (sat)	
TO-3P(LH)	Through-hole	(2)	2.1	60	15	0.16	1	High speed	
	Isolation, Through-hole	(2)	1.8	15	15	0.12	1	For small power	
TO-3P(N)	Through-hole	(2)	2.1	60	15	0.25	1	Mount the GT60M303 chip	
TO-3P(LH)	Through-hole	(2)	2.3	60	15	0.23	1	High speed	
TO-3P(LH)	Through-hole	(2)	2.1	60	15	0.25	1	J -1	
TO-3P(N)	Through-hole	(2)	1.65	60	15	0.11	1	6th generation	
TO-3P(N)	Through-hole	(2)	2.5	60	15	0.25]		
TO-3P(N)	Through-hole	(2)	2.2	60	15	0.1		High speed	
TO-3P(N)	Through-hole	(2)	1.9	60	15	0.12		6th generation	
TO-3P(LH)	Through-hole	(2)	2.3	60	15	0.25			
TO-3P(LH)	Through-hole	(2)	2.4	60	15	0.11]	High speed	
TO-3P(N)	Through-hole	(2)	2.8	40	15	0.41	Resistive load	IEGT ★	
TO-3P(LH)	Through-hole	(2)	3.7	40	15	0.23		High Vces	
TSON-8	SMD	(1)	3.0	130	2.5	1.5		Icp = 130 A@VgE = 2.5-V gate drive	
SOP-8	SMD	(3)	2.3	150	4.0	1.6	1	ICP = 150 A@VGE = 4.0-V gate drive	
TSSOP-8	SMD	(3)	2.9	150	4.0	1.7	-	Icp = 150 A@VgE = 4.0-V gate drive	
TSSOP-8	SMD	(3)	3.4	150	2.5	1.2	-	ICP = 150 A@VGE = 2.5-V gate drive	
TSSOP-8	SMD	(3)	3.5	150	3.0	1.6	1	ICP = 150 A@VGE = 3.0-V gate drive	
SOP-8	SMD	(3)	2.3	200	4.0	1.8	1	ICP = 200 A@VGE = 4.0-V gate drive	
	Isolation, Through-hole Isolation, Through-hole	(1) (1)	2.9	120 120	15 15	0.15 0.15	1	Sustain circuit	
	Isolation, Inrough-hole		2.1	120	15	0.15	1	Sustain circuit	
	Isolation, Inrough-hole	(1) (1)	1.95	120	15	0.2	1	Sustain circuit Energy recovery circuit	
	Isolation, Through-hole	(1)	1.75	120	15	0.22	1	Energy recovery circuit	
	Isolation, Through-hole	(1)	1.5	120	15	0.22	1	Energy recovery circuit	
	Isolation, Through-hole	(1)	1.6	120	15	0.4	1	Energy recovery circuit	
TO-220SM	SMD	(1)	2.1	120	15	0.22	1	Energy recovery circuit	
	Isolation, Through-hole	(1)	2.6	120	15	0.27	1	Sustain circuit	
	Isolation, Through-hole	(1)	2.2	120	15	0.26	1	Sustain circuit	
	Isolation, Through-hole	(1)	2.4	120	15	0.28	1	Sustain circuit	
	Isolation, Through-hole	(1)	2.1	120	15	0.23	1	Energy recovery circuit	
	Isolation, Through-hole	(1)	1.9	120	15	0.27]	Energy recovery circuit	
	Isolation, Through-hole	(1)	1.6	120	15	0.5]	Energy recovery circuit	
	Isolation, Through-hole	(1)	1.7	120	15	0.37		Energy recovery circuit	
TO-220SM	SMD	(1)	2.3	120	15	0.27		Energy recovery circuit	
	Isolation, Through-hole	(1)	2.4	120	15	0.25	1	Sustain/energy recovery circuits	

Note)







67

Phototransistors (for Optical Sensors)

Part Number	Part Number with Rank	Package	Electrical/Optical Characteristics (Ta = 25°C)								
			Light Current			Dark Current		Peak Sensitive	Half-Value	Impermeable	Applications
			Min (μA)	Max (μA)	E (mW/cm²)	Max (μA)	VCE (V)	Wavelength (nm)	Angle (°)	to Visible Light	
	_	TO-18CAN with lens	100	_		0.2	30				
TPS601A(F)	TPS601A(A,F)		100	300	0.1			800	±10		
11 300 1/1(1)	TPS601A(B,F)	TO-TOCAN WILLTICIS	200	600	0.1			800	±10		
	TPS601A(C,F)		400	1200							
TPS610(F)	_	ф5	100	_	0.1	0.1	24	800	±8	_	
TPS611(F)	_	φ5	30	_	0.1	0.1	24	900	±8	•	
	_	- ¢3	20	150	0.1	0.1	24	800	±30	_	Optoelectronic switches
	TPS615(A,F)		20	50							
TPS615(F)	TPS615(B,F)		34	85							
11 0010(1)	TPS615(C,F)		60	150							
	TPS615(AB,F)		20	85							
	TPS615(BC,F)		34	150							
	_		10	75		0.1	24	900	±30	•	
	TPS616(A,F)		10	25							
TPS616(F)	TPS616(B,F)	ф3	17	42.5	0.1						
11 3010(1)	TPS616(C,F)	Ψ3	30	75	0.1						
	TPS616(AB,F)		10	42.5							
	TPS616(BC,F)		17	75							
TPS622(F)	_		27								
	TPS622(A,F)	Small side-view package	27	80	0.1	0.1	24	870	±15	•	
	TPS622(B,F)		55	165							

Note: E = radiant incidence; VcE = collector-emitter voltage

[•] Contact the Toshiba sales representative for information about RoHS compliance before you purchase any components.

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电话: 0755-82884100 83397033 83396822 83398585

传真: 0755-83376182 (0) 13823648918 MSN: SUNS8888@hotmail.com

邮编: 518033 E-mail:szss20@163.com QQ: 195847376

深圳赛格展销部: 深圳华强北路赛格电子市场2583 号 电话: 0755-83665529

技术支持: 0755-83394033 13501568376